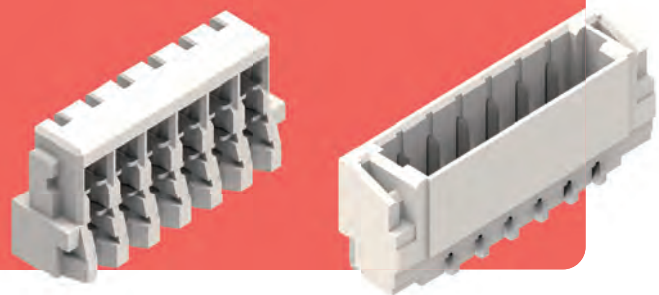
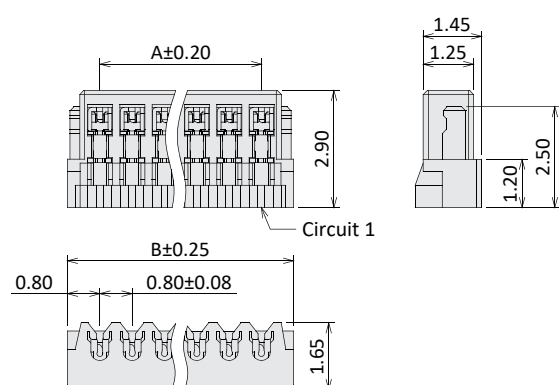


# Wafer Housing Terminal

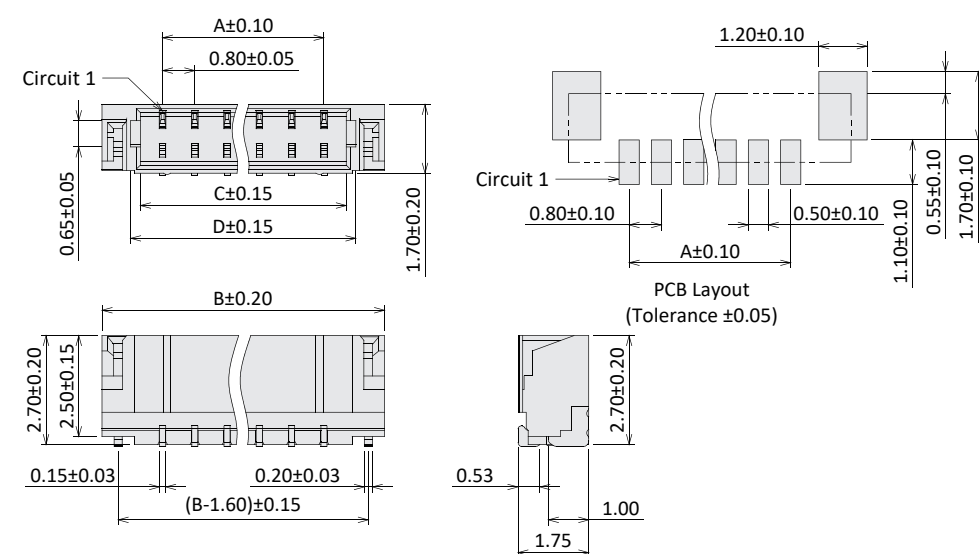
Current Rate: 0.5A / 30V AC,DC  
 Dielectric Voltage: 200V AC for one minute  
 Insulation Resistance: 100MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Gold or Tin  
 Solder Tabs: Copper Alloy, Tin Plated  
 Material Insulator: NY 66 or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



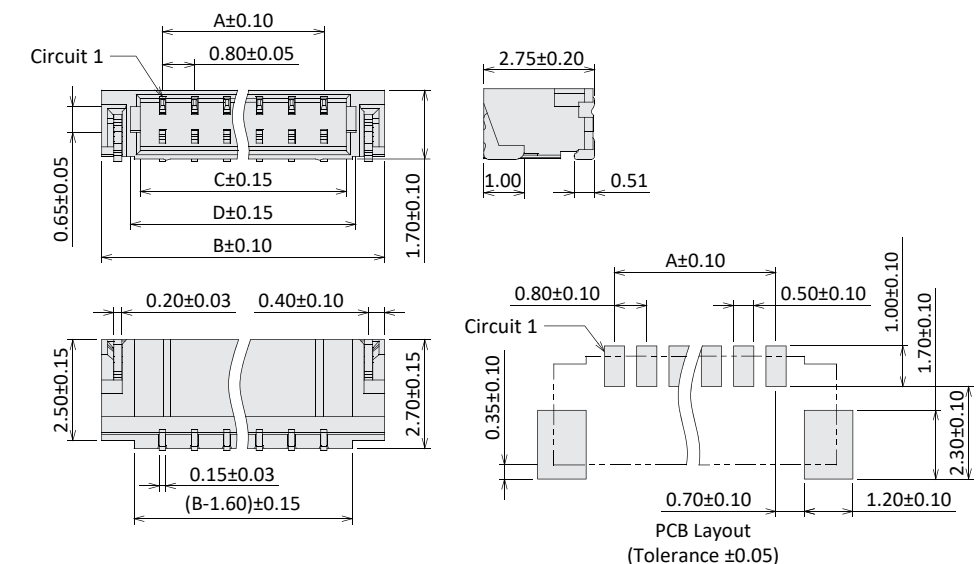
## IDC Type Housing Wafer 0800 Series 0.80mm Pitch



Part No.	Dimensions	
	A	B
HIDC08-02	0.80	2.40
HIDC08-03	1.60	3.20
HIDC08-04	2.40	4.00
HIDC08-05	3.20	4.80
HIDC08-06	4.00	5.60
HIDC08-07	4.80	6.40
HIDC08-08	5.60	7.20
HIDC08-10	7.20	8.80
HIDC08-12	8.80	10.40
HIDC08-14	10.40	12.00
HIDC08-15	11.20	12.80
HIDC08-16	12.00	13.60
HIDC08-17	12.80	14.40
HIDC08-20	15.20	16.80



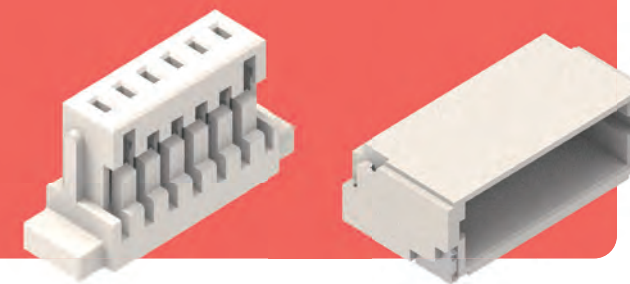
Part No.	Dimensions			
	A	B	C	D
W0800ML-02	0.80	3.80	1.90	2.38
W0800ML-03	1.60	4.60	2.70	3.18
W0800ML-04	2.40	5.40	3.50	3.98
W0800ML-05	3.20	6.20	4.30	4.78
W0800ML-06	4.00	7.00	5.10	5.58
W0800ML-07	4.80	7.80	5.90	6.38
W0800ML-08	5.60	8.60	6.70	7.18
W0800ML-10	7.20	10.20	8.30	8.78
W0800ML-12	8.80	11.80	9.90	10.38
W0800ML-14	10.40	13.40	11.50	11.98
W0800ML-15	11.20	14.20	12.30	12.78
W0800ML-16	12.00	15.00	13.10	13.58
W0800ML-17	12.80	15.80	13.90	14.38
W0800ML-20	15.20	18.20	16.30	16.78



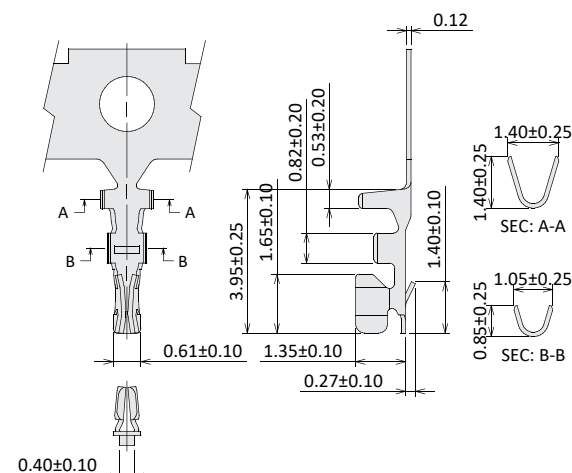
Part No.	Dimensions			
	A	B	C	D
W0800MR-02	0.80	3.80	1.90	2.38
W0800MR-03	1.60	4.60	2.70	3.18
W0800MR-04	2.40	5.40	3.50	3.98
W0800MR-05	3.20	6.20	4.30	4.78
W0800MR-06	4.00	7.00	5.10	5.58
W0800MR-07	4.80	7.80	5.90	6.38
W0800MR-08	5.60	8.60	6.70	7.18
W0800MR-10	7.20	10.20	8.30	8.78
W0800MR-12	8.80	11.80	9.90	10.38
W0800MR-14	10.40	13.40	11.50	11.98
W0800MR-15	11.20	14.20	12.30	12.78
W0800MR-16	12.00	15.00	13.10	13.58
W0800MR-17	12.80	15.80	13.90	14.38
W0800MR-20	15.20	18.20	16.30	16.78

# Wafer Housing Terminal

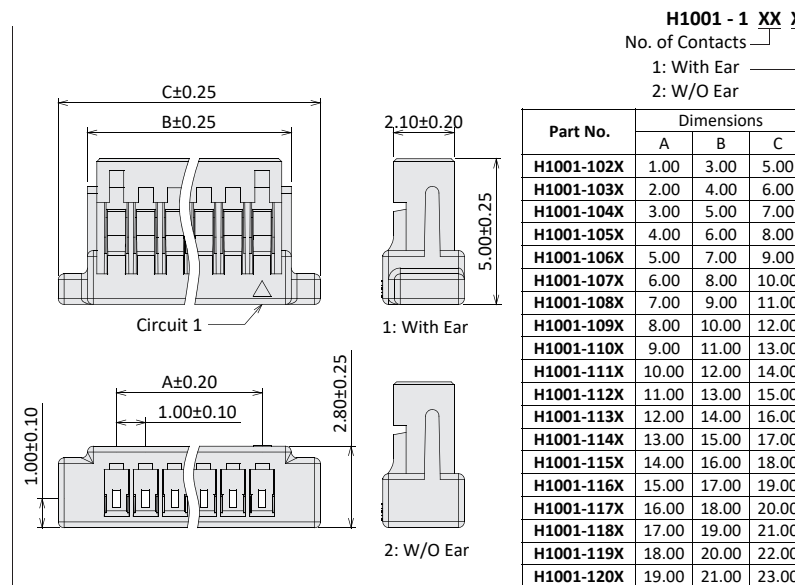
Current Rate: 1A / 50V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 100MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Solder Tabs: Copper Alloy, Tin Plated  
 Material Insulator: PBT or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



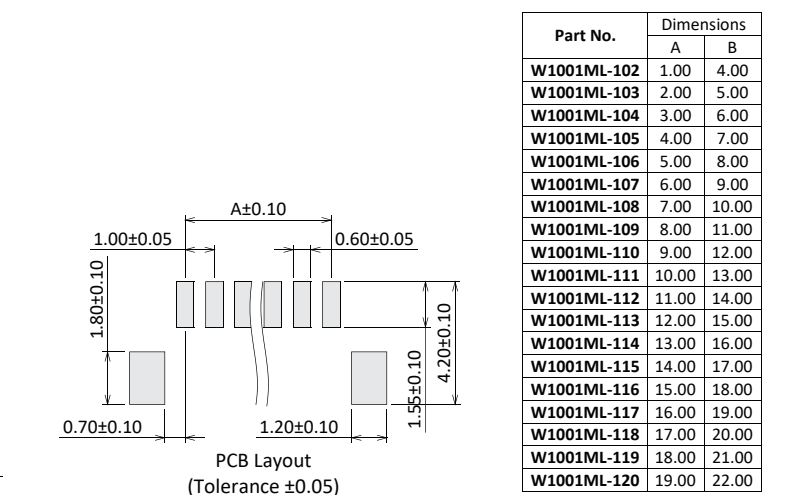
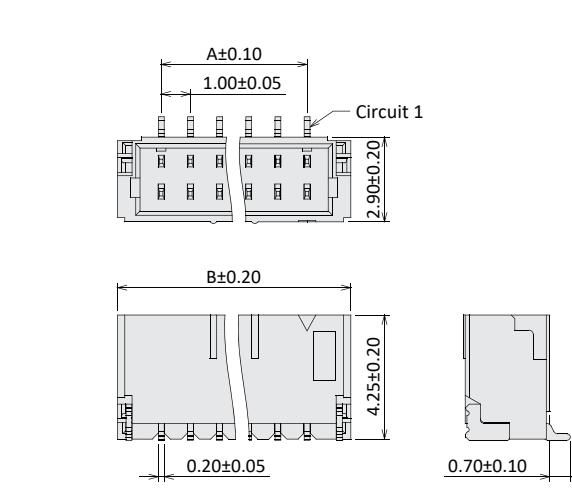
## Terminal Housing Wafer Single Row 1001 Series 1.00mm Pitch



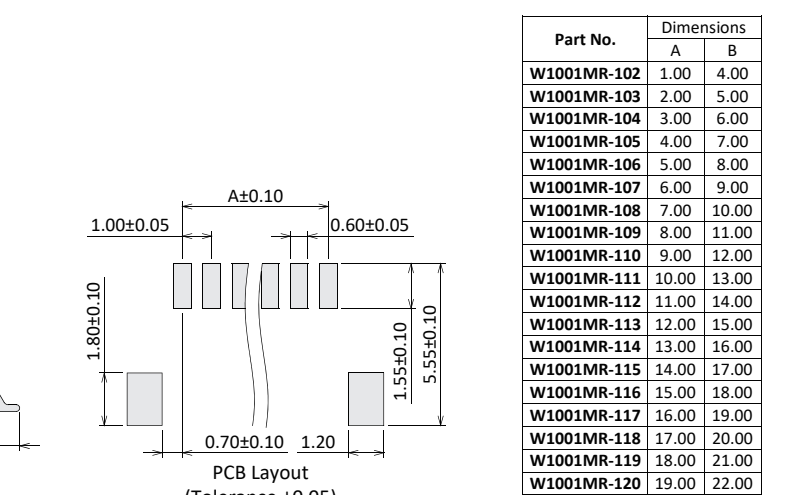
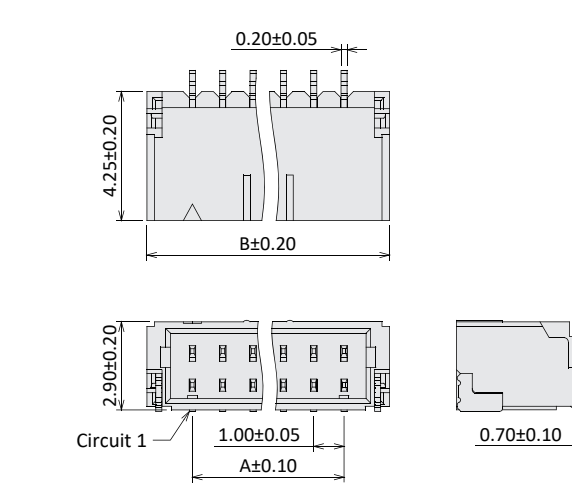
Part No.	Wire Range	Insulation O.D.	Material	Finish
T1001-TP	#28-#32	0.80mm(Max.)	Phosphor Bronze	Tin Plated
T1001-MP	#28-#32	0.80mm(Max.)	Phosphor Bronze	Mist Tin Plated
T1001-GP	#28-#32	0.80mm(Max.)	Phosphor Bronze	Gold Plated



Part No.	Dimensions		
	A	B	C
H1001-102X	1.00	3.00	5.00
H1001-103X	2.00	4.00	6.00
H1001-104X	3.00	5.00	7.00
H1001-105X	4.00	6.00	8.00
H1001-106X	5.00	7.00	9.00
H1001-107X	6.00	8.00	10.00
H1001-108X	7.00	9.00	11.00
H1001-109X	8.00	10.00	12.00
H1001-110X	9.00	11.00	13.00
H1001-111X	10.00	12.00	14.00
H1001-112X	11.00	13.00	15.00
H1001-113X	12.00	14.00	16.00
H1001-114X	13.00	15.00	17.00
H1001-115X	14.00	16.00	18.00
H1001-116X	15.00	17.00	19.00
H1001-117X	16.00	18.00	20.00
H1001-118X	17.00	19.00	21.00
H1001-119X	18.00	20.00	22.00
H1001-120X	19.00	21.00	23.00



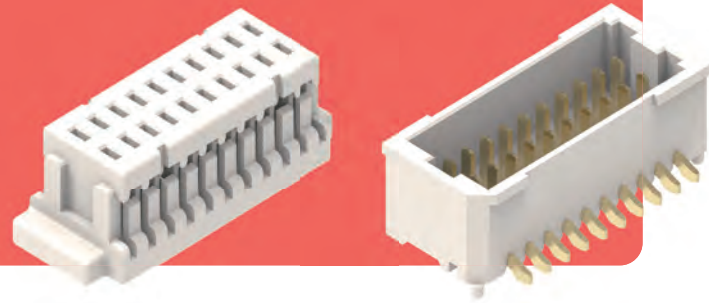
Part No.	Dimensions	
	A	B
W1001ML-102	1.00	4.00
W1001ML-103	2.00	5.00
W1001ML-104	3.00	6.00
W1001ML-105	4.00	7.00
W1001ML-106	5.00	8.00
W1001ML-107	6.00	9.00
W1001ML-108	7.00	10.00
W1001ML-109	8.00	11.00
W1001ML-110	9.00	12.00
W1001ML-111	10.00	13.00
W1001ML-112	11.00	14.00
W1001ML-113	12.00	15.00
W1001ML-114	13.00	16.00
W1001ML-115	14.00	17.00
W1001ML-116	15.00	18.00
W1001ML-117	16.00	19.00
W1001ML-118	17.00	20.00
W1001ML-119	18.00	21.00
W1001ML-120	19.00	22.00



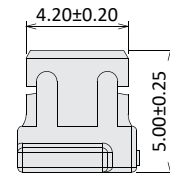
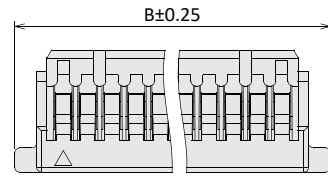
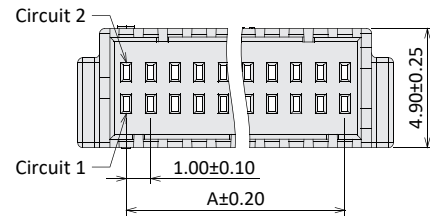
Part No.	Dimensions	
	A	B
W1001MR-102	1.00	4.00
W1001MR-103	2.00	5.00
W1001MR-104	3.00	6.00
W1001MR-105	4.00	7.00
W1001MR-106	5.00	8.00
W1001MR-107	6.00	9.00
W1001MR-108	7.00	10.00
W1001MR-109	8.00	11.00
W1001MR-110	9.00	12.00
W1001MR-111	10.00	13.00
W1001MR-112	11.00	14.00
W1001MR-113	12.00	15.00
W1001MR-114	13.00	16.00
W1001MR-115	14.00	17.00
W1001MR-116	15.00	18.00
W1001MR-117	16.00	19.00
W1001MR-118	17.00	20.00
W1001MR-119	18.00	21.00
W1001MR-120	19.00	22.00

# Wafer Housing Terminal

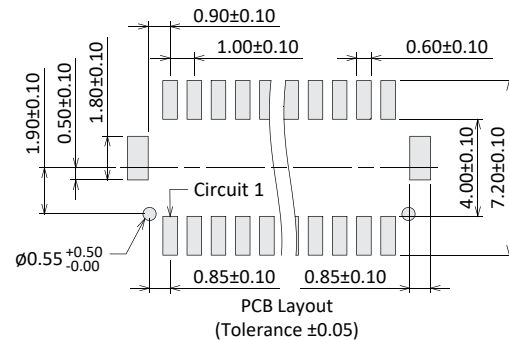
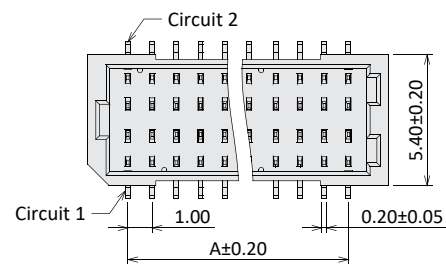
Current Rate: 1A / 50V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 100MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Gold Plated  
 Solder Tabs: Copper Alloy, Tin Plated  
 Material Insulator: PBT or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



## Housing Wafer Dual Row 1001 Series 1.00mm Pitch

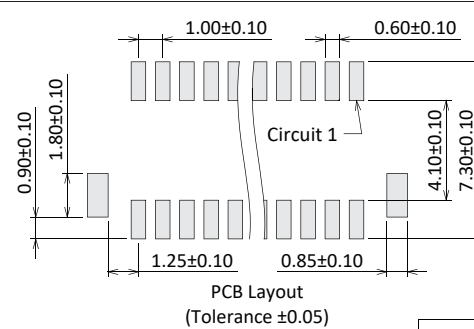
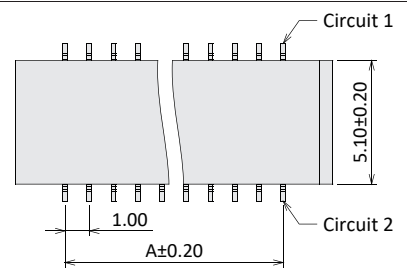
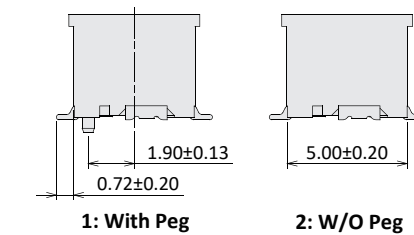
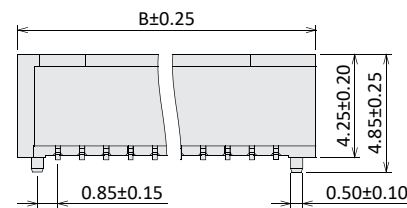


Part No.	Dimensions	
	A	B
H1001-206	5.00	9.00
H1001-208	7.00	11.00
H1001-210	9.00	13.00
H1001-215	14.00	18.10
H1001-220	19.00	23.00
H1001-225	24.00	28.00

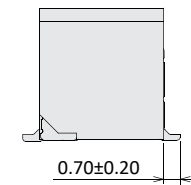
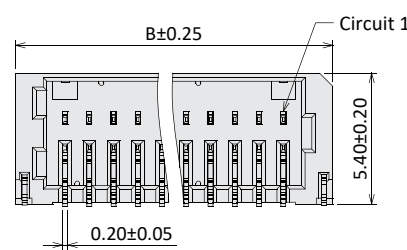


**W1001ML - 2 XX X**  
 No. of Contacts  
 1: With Peg  
 2: W/O Peg

Part No.	Dimensions	
	A	B
W1001ML-206	5.00	9.10
W1001ML-208	7.00	11.10
W1001ML-210	9.00	13.10
W1001ML-215	14.00	18.10
W1001ML-220	19.00	23.10
W1001ML-225	24.00	28.10

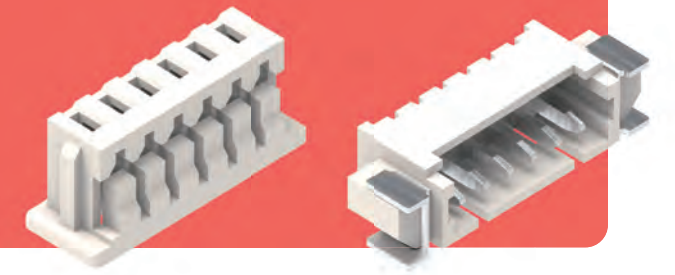


Part No.	Dimensions	
	A	B
W1001MR-206	5.00	9.10
W1001MR-208	7.00	11.10
W1001MR-210	9.00	13.10
W1001MR-215	14.00	18.10
W1001MR-220	19.00	23.10
W1001MR-225	24.00	28.10

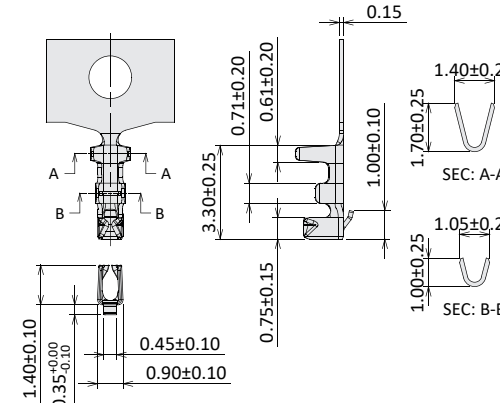


# Wafer Housing Terminal

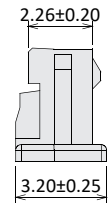
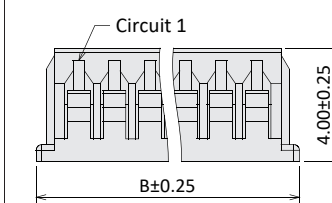
Current Rate: 1A / 125V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 100MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Solder Tabs: Copper Alloy, Tin Plated  
 Material Insulator: PBT or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



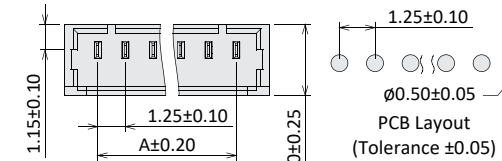
## Terminal Housing Wafer 1250 Series 1.25mm Pitch



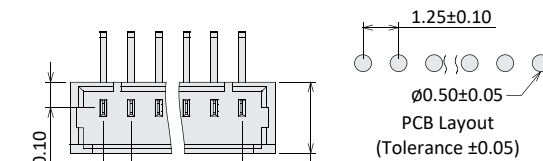
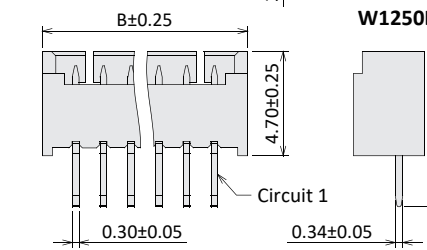
Part No.	Wire Range	Insulation O.D.	Material	Finish
T1250-TP	#28-#32	1.00mm(Max.)	Phosphor Bronze	Tin Plated
T1250-GP	#28-#32	1.00mm(Max.)	Phosphor Bronze	Gold Plated



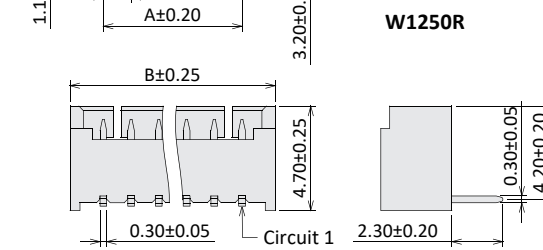
Part No.	Dimensions	
	A	B
H1250-02	1.25	4.25
H1250-03	2.50	5.50
H1250-04	3.75	6.75
H1250-05	5.00	8.00
H1250-06	6.25	9.25
H1250-07	7.50	10.50
H1250-08	8.75	11.75
H1250-09	10.00	13.00
H1250-10	11.25	14.25
H1250-11	12.50	15.50
H1250-12	13.75	16.75
H1250-13	15.00	18.00
H1250-14	16.25	19.25
H1250-15	17.50	20.50
H1250-16	18.75	21.75
H1250-17	20.00	23.00
H1250-18	21.25	24.25



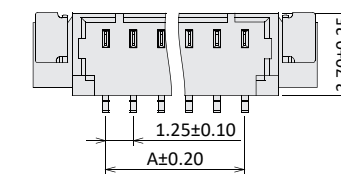
**W1250L**



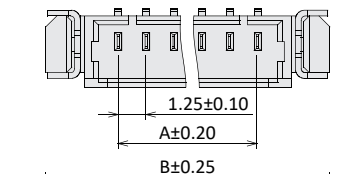
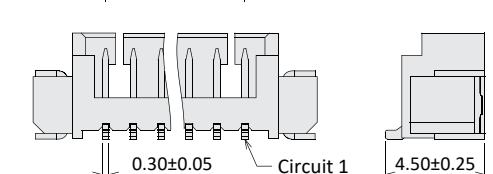
**W1250R**



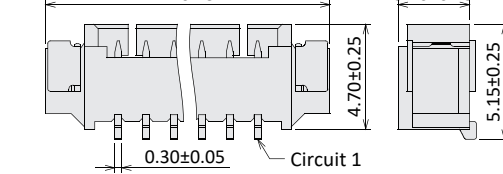
Part No.	Dimensions	
	A	B
W1250L(R)-02	1.25	4.25
W1250L(R)-03	2.50	5.50
W1250L(R)-04	3.75	6.75
W1250L(R)-05	5.00	8.00
W1250L(R)-06	6.25	9.25
W1250L(R)-07	7.50	10.50
W1250L(R)-08	8.75	11.75
W1250L(R)-09	10.00	13.00
W1250L(R)-10	11.25	14.25
W1250L(R)-11	12.50	15.50
W1250L(R)-12	13.75	16.75
W1250L(R)-13	15.00	18.00
W1250L(R)-14	16.25	19.25
W1250L(R)-15	17.50	20.50
W1250L(R)-16	18.75	21.75
W1250L(R)-17	20.00	23.00
W1250L(R)-18	21.25	24.25



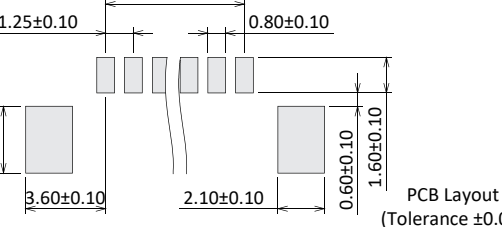
**W1250ML**



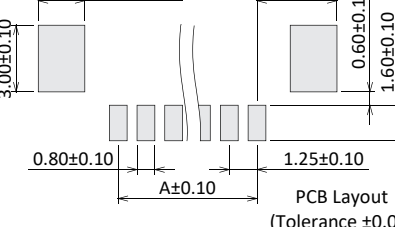
**W1250MR**



Part No.	Dimensions	
	A	B
W1250ML(MR)-02	1.25	7.75
W1250ML(MR)-03	2.50	9.00
W1250ML(MR)-04	3.75	10.25
W1250ML(MR)-05	5.00	11.50
W1250ML(MR)-06	6.25	12.75
W1250ML(MR)-07	7.50	14.00
W1250ML(MR)-08	8.75	15.25
W1250ML(MR)-09	10.00	16.50
W1250ML(MR)-10	11.25	17.75
W1250ML(MR)-11	12.50	19.00
W1250ML(MR)-12	13.75	20.25
W1250ML(MR)-13	15.00	21.50
W1250ML(MR)-14	16.25	22.75
W1250ML(MR)-15	17.50	24.00
W1250ML(MR)-16	18.75	25.25
W1250ML(MR)-17	20.00	26.50
W1250ML(MR)-18	21.25	27.75



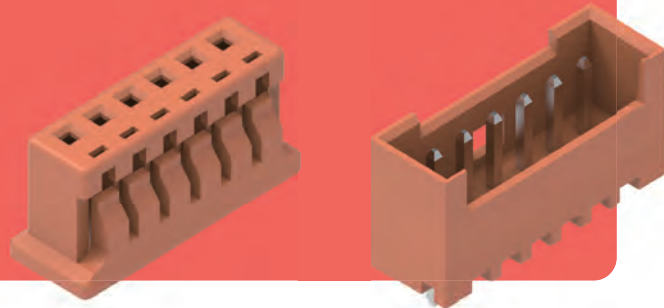
PCB Layout (Tolerance ±0.05)



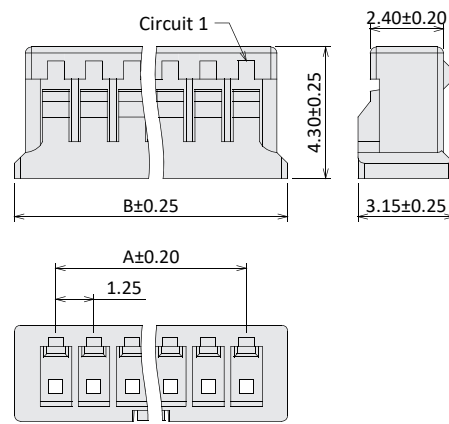
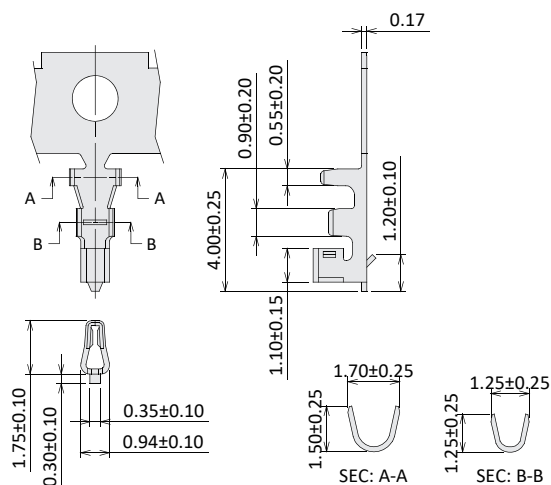
PCB Layout (Tolerance ±0.05)

# Wafer Housing Terminal

Current Rate: 1A / 200V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 100MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Solder Tabs: Copper Alloy, Tin Plated  
 Material Insulator: NY 66, UL94V-0  
 Operating Temperature: -25°C~+85°C

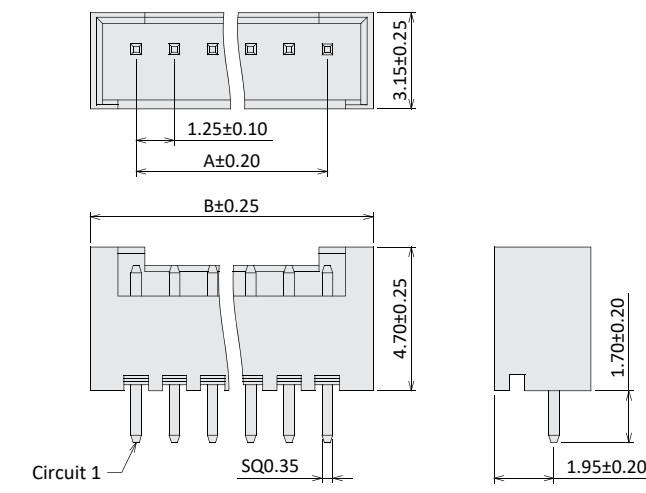


## Terminal Housing Wafer 1251 Series 1.25mm Pitch

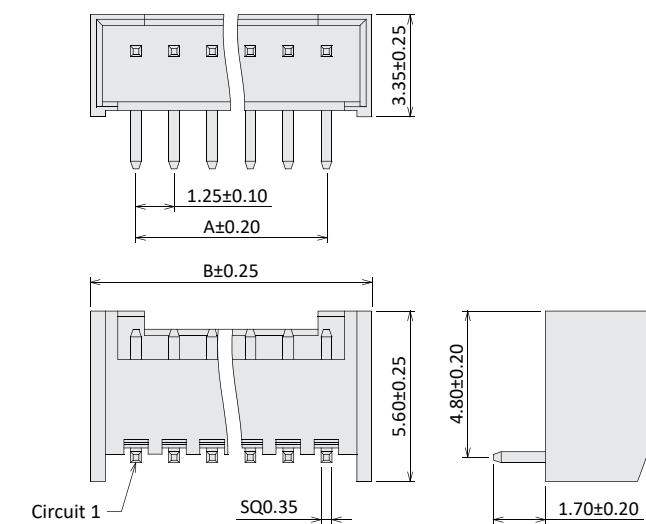


Part No.	Dimensions	
	A	B
H1251-02	1.25	3.95
H1251-03	2.50	5.20
H1251-04	3.75	6.45
H1251-05	5.00	7.70
H1251-06	6.25	8.95
H1251-07	7.50	10.20
H1251-08	8.75	11.45
H1251-09	10.00	12.70
H1251-10	11.25	13.95
H1251-11	12.50	15.20
H1251-12	13.75	16.45
H1251-13	15.00	17.70
H1251-14	16.25	18.95
H1251-15	17.50	20.20

Part No.	Wire Range	Insulation O.D.	Material	Finish
T1251-TP	#28-#32	1.00mm(Max.)	Phosphor Bronze	Tin Plated



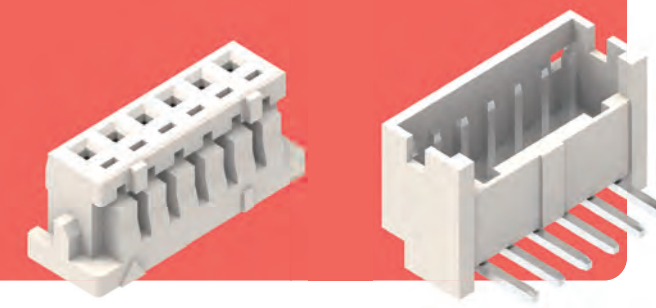
Part No.	Dimensions	
	A	B
W1251L-02	1.25	4.25
W1251L-03	2.50	5.50
W1251L-04	3.75	6.75
W1251L-05	5.00	8.00
W1251L-06	6.25	9.25
W1251L-07	7.50	10.50
W1251L-08	8.75	11.75
W1251L-09	10.00	13.00
W1251L-10	11.25	14.25
W1251L-11	12.50	15.50
W1251L-12	13.75	16.75
W1251L-13	15.00	18.00
W1251L-14	16.25	19.25
W1251L-15	17.50	20.50



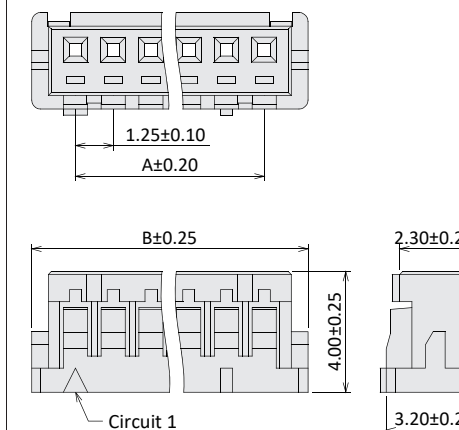
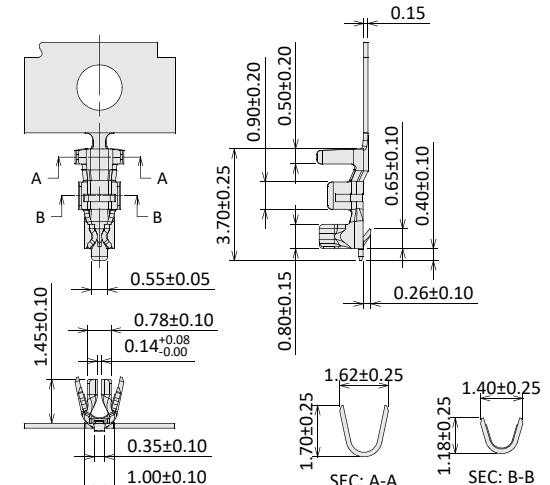
Part No.	Dimensions	
	A	B
W1251R-02	1.25	4.25
W1251R-03	2.50	5.50
W1251R-04	3.75	6.75
W1251R-05	5.00	8.00
W1251R-06	6.25	9.25
W1251R-07	7.50	10.50
W1251R-08	8.75	11.75
W1251R-09	10.00	13.00
W1251R-10	11.25	14.25
W1251R-11	12.50	15.50
W1251R-12	13.75	16.75
W1251R-13	15.00	18.00
W1251R-14	16.25	19.25
W1251R-15	17.50	20.50

# Wafer Housing Terminal

Current Rate: 1A / 150V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 500MΩ Min.  
 Contact Resistance: 30mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Solder Tabs: Copper Alloy, Tin Plated  
 Material Insulator: NY 66, UL94V-0  
 Operating Temperature: -25°C~+85°C

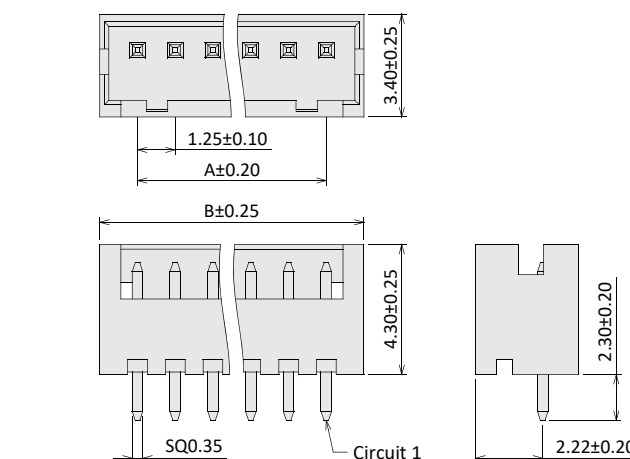


## Terminal Housing Wafer Single Row 1252 Series 1.25mm Pitch

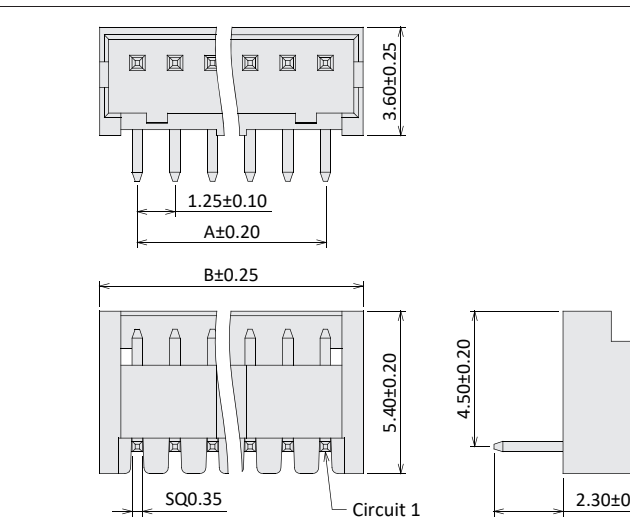


Part No.	Dimensions	
	A	B
H1252-102	1.25	4.15
H1252-103	2.50	5.40
H1252-104	3.75	6.65
H1252-105	5.00	7.90
H1252-106	6.25	9.15
H1252-107	7.50	10.40
H1252-108	8.75	11.65
H1252-109	10.00	12.90
H1252-110	11.25	14.15
H1252-111	12.50	15.40
H1252-112	13.75	16.65
H1252-113	15.00	17.90
H1252-114	16.25	19.15
H1252-115	17.50	20.40

Part No.	Wire Range	Insulation O.D.	Material	Finish
T1252-TP	#26-#30	1.00mm(Max.)	Phosphor Bronze	Tin Plated
T1252-GP	#26-#30	1.00mm(Max.)	Phosphor Bronze	Gold Plated



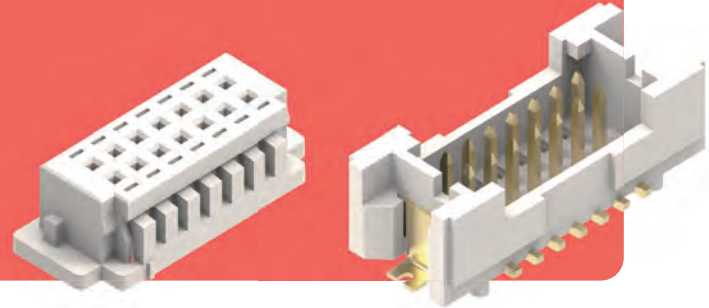
Part No.	Dimensions	
	A	B
W1252L-02	1.25	3.75
W1252L-03	2.50	5.00
W1252L-04	3.75	6.25
W1252L-05	5.00	7.50
W1252L-06	6.25	8.75
W1252L-07	7.50	10.00
W1252L-08	8.75	11.25
W1252L-09	10.00	12.50
W1252L-10	11.25	13.75
W1252L-11	12.50	15.00
W1252L-12	13.75	16.25
W1252L-13	15.00	17.50
W1252L-14	16.25	18.75
W1252L-15	17.50	20.00



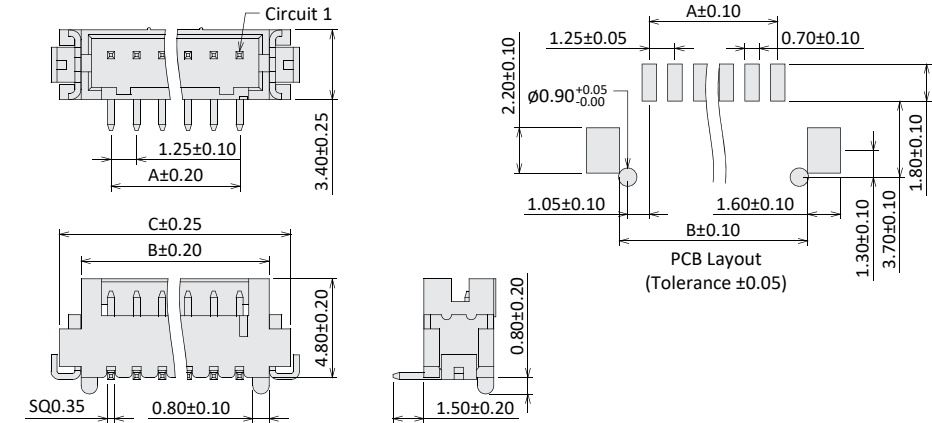
Part No.	Dimensions	
	A	B
W1252R-02	1.25	3.75
W1252R-03	2.50	5.00
W1252R-04	3.75	6.25
W1252R-05	5.00	7.50
W1252R-06	6.25	8.75
W1252R-07	7.50	10.00
W1252R-08	8.75	11.25
W1252R-09	10.00	12.50
W1252R-10	11.25	13.75
W1252R-11	12.50	15.00
W1252R-12	13.75	16.25
W1252R-13	15.00	17.50
W1252R-14	16.25	18.75
W1252R-15	17.50	20.00

# Wafer Housing Terminal

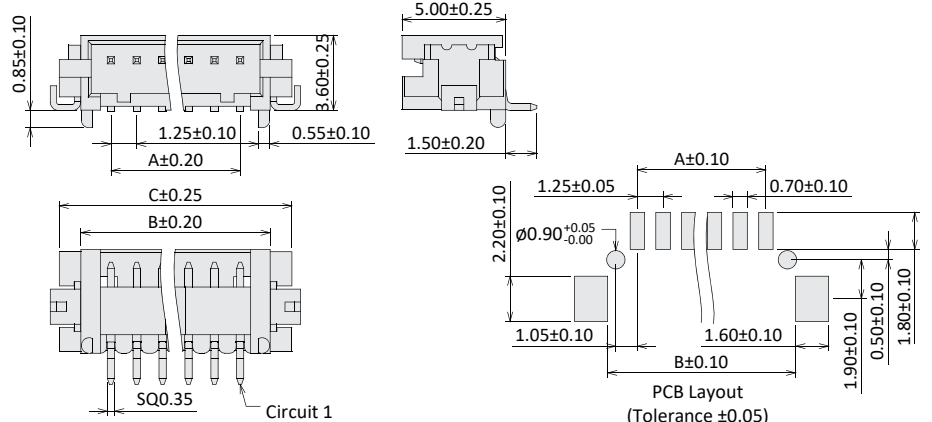
Current Rate: 1A / 150V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 500MΩ Min.  
 Contact Resistance: 30mΩ Max.  
 Material Contact: Copper Alloy, Gold Plated  
 Solder Tabs: Copper Alloy, Gold Plated  
 Material Insulator: NY66 or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



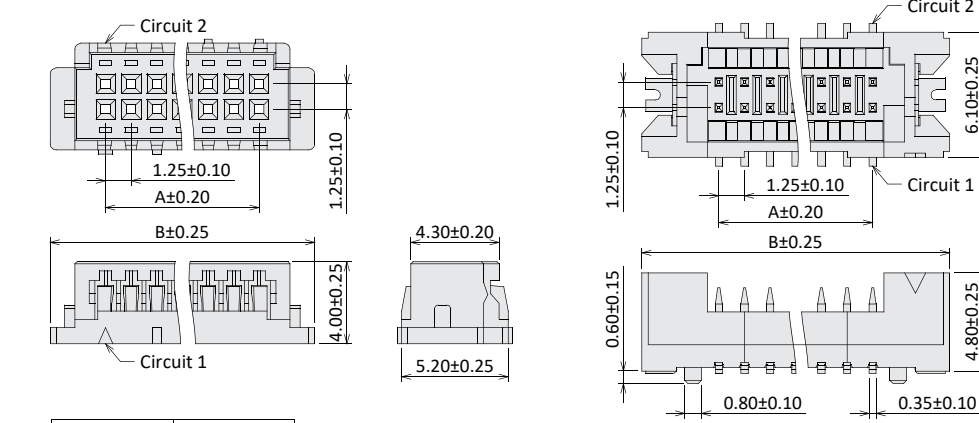
## Housing Wafer Single/Dual Row 1252 Series 1.25mm Pitch



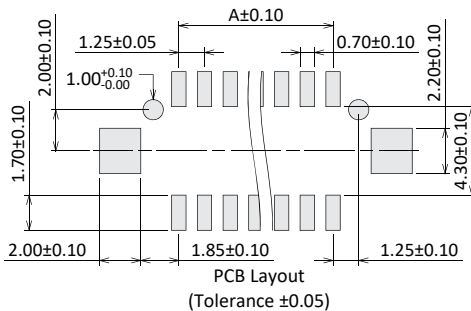
Part No.	Dimensions		
	A	B	C
W1252ML-102	1.25	4.15	6.25
W1252ML-103	2.50	5.40	7.50
W1252ML-104	3.75	6.65	8.75
W1252ML-105	5.00	7.90	10.00
W1252ML-106	6.25	9.15	11.25
W1252ML-107	7.50	10.40	12.50
W1252ML-108	8.75	11.65	13.75
W1252ML-109	10.00	12.90	15.00
W1252ML-110	11.25	14.15	16.25
W1252ML-111	12.50	15.40	17.50
W1252ML-112	13.75	16.65	18.75
W1252ML-113	15.00	17.90	20.00
W1252ML-114	16.25	19.15	21.25
W1252ML-115	17.50	20.40	22.50



Part No.	Dimensions		
	A	B	C
W1252MR-102	1.25	4.15	6.25
W1252MR-103	2.50	5.40	7.50
W1252MR-104	3.75	6.65	8.75
W1252MR-105	5.00	7.90	10.00
W1252MR-106	6.25	9.15	11.25
W1252MR-107	7.50	10.40	12.50
W1252MR-108	8.75	11.65	13.75
W1252MR-109	10.00	12.90	15.00
W1252MR-110	11.25	14.15	16.25
W1252MR-111	12.50	15.40	17.50
W1252MR-112	13.75	16.65	18.75
W1252MR-113	15.00	17.90	20.00
W1252MR-114	16.25	19.15	21.25
W1252MR-115	17.50	20.40	22.50



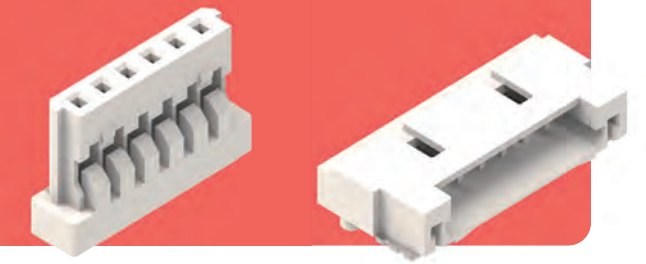
Part No.	Dimensions	
	A	B
H1252-205	5.00	10.40
H1252-207	7.50	12.90
H1252-210	11.25	16.65
H1252-215	17.50	22.90
H1252-220	23.75	29.15



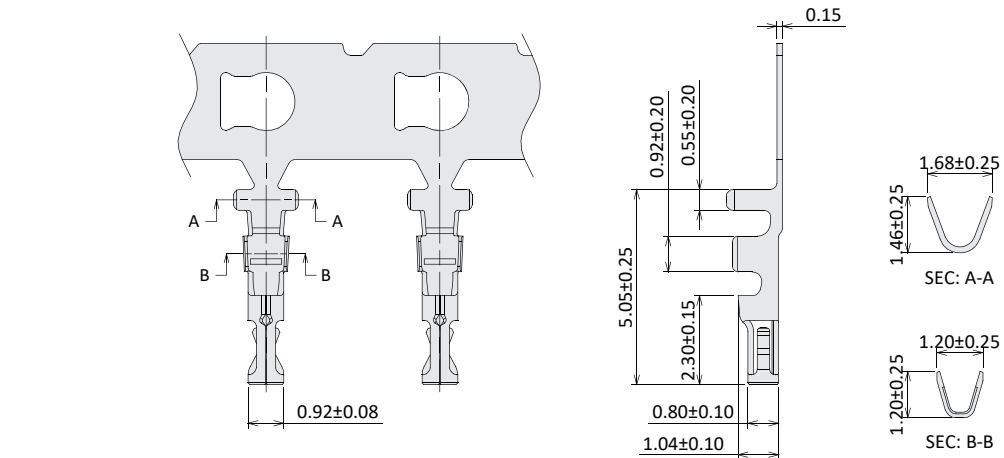
Part No.	Dimensions	
	A	B
W1252ML-205	5.00	12.50
W1252ML-207	7.50	15.00
W1252ML-210	11.25	18.75
W1252ML-215	17.50	25.00
W1252ML-220	23.75	31.25

# Wafer Housing Terminal

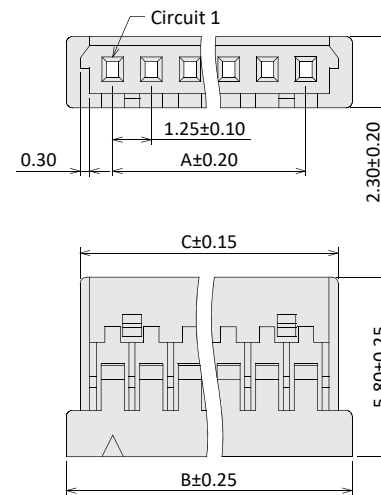
Current Rate: 1A / 150V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 500MΩ Min.  
 Contact Resistance: 30mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Solder Tabs: Copper Alloy, Tin Plated  
 Material Insulator: NY 66 or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



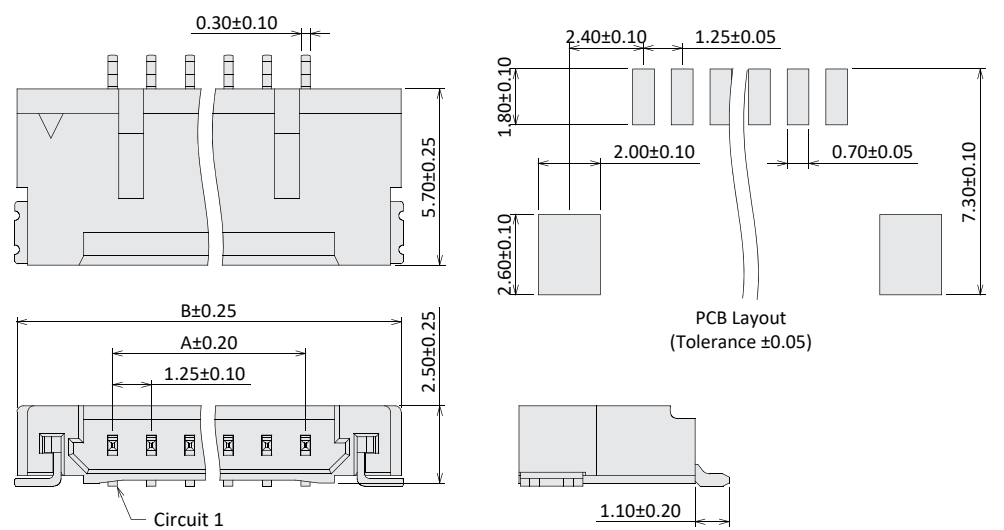
## Terminal Housing Wafer 1253 Series 1.25mm Pitch



Part No.	Wire Range	Insulation O.D.	Material	Finish
T1253-TP	#28-#32	0.90mm(Max.)	Phosphor Bronze	Tin Plated
T1253-GP	#28-#32	0.90mm(Max.)	Phosphor Bronze	Gold Plated



Part No.	Dimensions		
	A	B	C
H1253-02	1.25	4.25	3.35
H1253-03	2.50	5.50	4.60
H1253-04	3.75	6.75	5.85
H1253-05	5.00	8.00	7.10
H1253-06	6.25	9.25	8.35
H1253-07	7.50	10.50	9.60
H1253-08	8.75	11.75	10.85
H1253-09	10.00	13.00	12.10
H1253-10	11.25	14.25	13.35
H1253-11	12.50	15.50	14.60
H1253-12	13.75	16.75	15.85
H1253-13	15.00	18.00	17.10
H1253-14	16.25	19.25	18.35
H1253-15	17.50	20.50	19.60
H1253-20	23.75	26.75	25.85
H1253-21	25.00	28.00	27.10
H1253-25	30.00	33.00	32.10
H1253-30	36.25	39.25	38.35



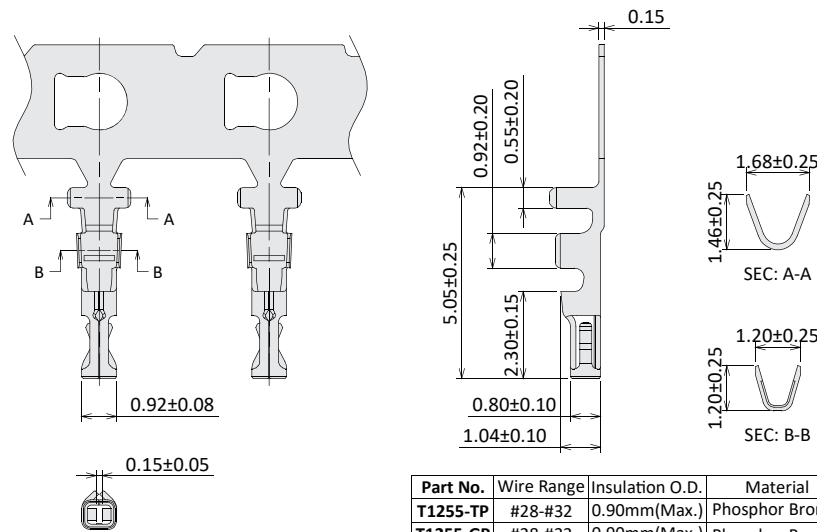
Part No.	Dimensions	
	A	B
W1253MR-02	1.25	7.45
W1253MR-03	2.50	8.70
W1253MR-04	3.75	9.95
W1253MR-05	5.00	11.20
W1253MR-06	6.25	12.45
W1253MR-07	7.50	13.70
W1253MR-08	8.75	14.95
W1253MR-09	10.00	16.20
W1253MR-10	11.25	17.45
W1253MR-11	12.50	18.70
W1253MR-12	13.75	19.95
W1253MR-13	15.00	21.20
W1253MR-14	16.25	22.45
W1253MR-15	17.50	23.70
W1253MR-20	23.75	29.95
W1253MR-21	25.00	31.20
W1253MR-25	30.00	36.20
W1253MR-30	36.25	42.45

# Wafer Housing Terminal

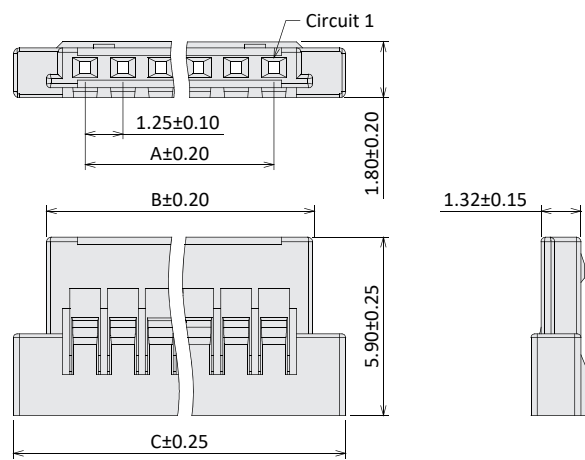
Current Rate: 1A / 200V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 100MΩ Min.  
 Contact Resistance: 40mΩ Max.  
 Material Contact: Copper Alloy, Gold Plated  
 Solder Tabs: Copper Alloy, Gold Plated  
 Material Insulator: NY66 or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



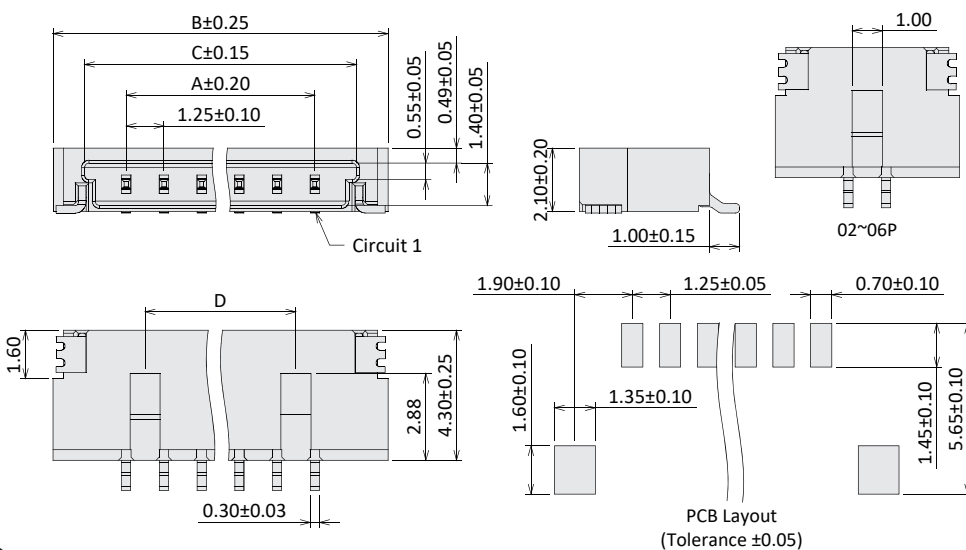
## Terminal Housing Wafer 1255 Series 1.25mm Pitch



Part No.	Wire Range	Insulation O.D.	Material	Finish
T1255-TP	#28-#32	0.90mm(Max.)	Phosphor Bronze	Tin Plated
T1255-GP	#28-#32	0.90mm(Max.)	Phosphor Bronze	Gold Plated



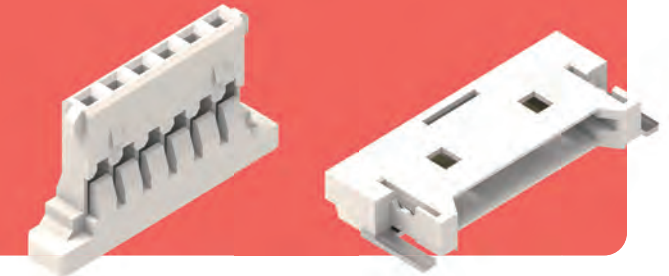
Part No.	Dimensions		
	A	B	C
H1255-02	1.25	3.80	6.00
H1255-03	2.50	5.05	7.25
H1255-04	3.75	6.30	8.50
H1255-05	5.00	7.55	9.75
H1255-06	6.25	8.80	11.00
H1255-07	7.50	10.05	12.25
H1255-08	8.75	11.30	13.50
H1255-09	10.00	12.55	14.75
H1255-10	11.25	13.80	16.00
H1255-11	12.50	15.05	17.25
H1255-12	13.75	16.30	18.50
H1255-13	15.00	17.55	19.75
H1255-14	16.25	18.80	21.00
H1255-15	17.50	20.05	22.25
H1255-20	23.75	26.30	28.50
H1255-25	30.00	32.55	34.75
H1255-30	36.25	38.80	41.00



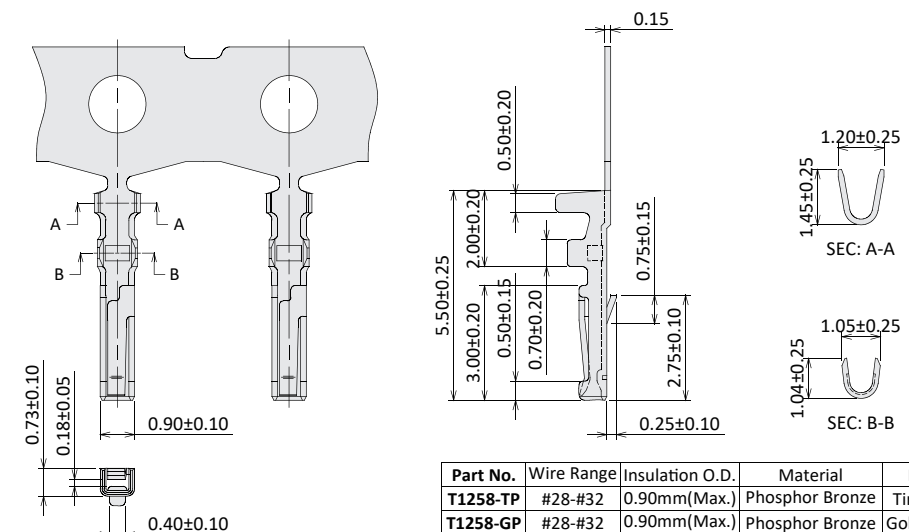
Part No.	Dimensions			
	A	B	C	D
W1255MR-02	1.25	6.10	4.01	---
W1255MR-03	2.50	7.35	5.26	---
W1255MR-04	3.75	8.60	6.51	---
W1255MR-05	5.00	9.85	7.76	---
W1255MR-06	6.25	11.10	9.01	---
W1255MR-07	7.50	12.35	10.26	7.50
W1255MR-08	8.75	13.60	11.51	8.75
W1255MR-09	10.00	14.85	12.76	10.00
W1255MR-10	11.25	16.10	14.01	11.25
W1255MR-11	12.50	17.35	15.26	12.50
W1255MR-12	13.75	18.60	16.51	13.75
W1255MR-13	15.00	19.85	17.76	15.00
W1255MR-14	16.25	21.10	19.01	16.25
W1255MR-15	17.50	22.35	20.26	17.50
W1255MR-20	23.75	28.60	26.51	22.50
W1255MR-25	30.00	34.85	32.76	28.75
W1255MR-30	36.25	41.10	39.01	35.00

# Wafer Housing Terminal

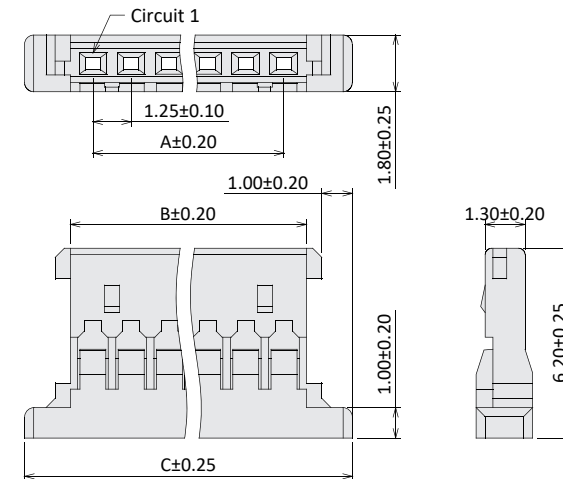
Current Rate: 1A / 125V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 100MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Gold Plated  
 Solder Tabs: Copper Alloy, Tin Plated  
 Material Insulator: NY 66 or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



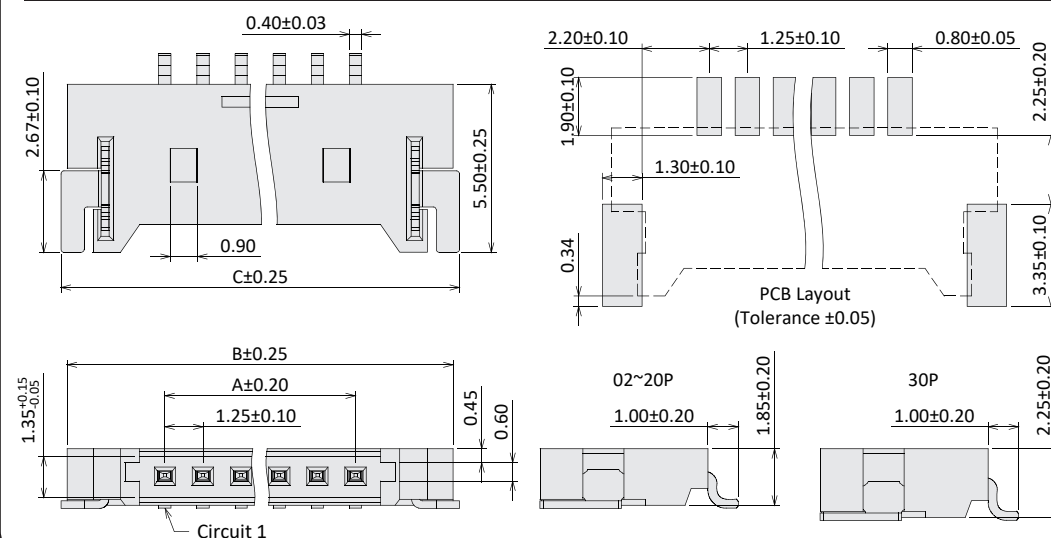
## Terminal Housing Wafer 1258 Series 1.25mm Pitch



Part No.	Wire Range	Insulation O.D.	Material	Finish
T1258-TP	#28-#32	0.90mm(Max.)	Phosphor Bronze	Tin Plated
T1258-GP	#28-#32	0.90mm(Max.)	Phosphor Bronze	Gold Plated



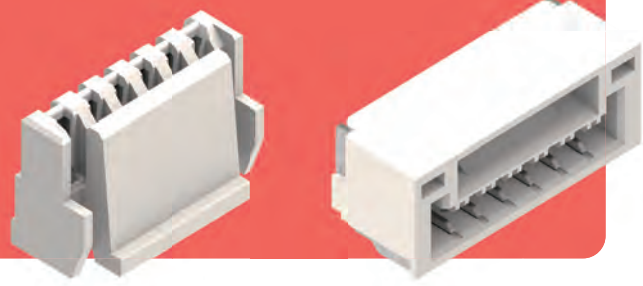
Part No.	Dimensions		
	A	B	C
H1258-02	1.25	2.72	5.72
H1258-03	2.50	3.97	6.97
H1258-04	3.75	5.22	8.22
H1258-05	5.00	6.47	9.47
H1258-06	6.25	7.72	10.72
H1258-07	7.50	8.97	11.97
H1258-08	8.75	10.22	13.22
H1258-09	10.00	11.47	14.47
H1258-10	11.25	12.72	15.72
H1258-11	12.50	13.97	16.97
H1258-12	13.75	15.22	18.22
H1258-13	15.00	16.47	19.47
H1258-14	16.25	17.72	20.72
H1258-15	17.50	18.97	21.97
H1258-16	18.75	20.22	23.22
H1258-20	23.75	25.22	28.22
H1258-30	36.25	37.72	40.72



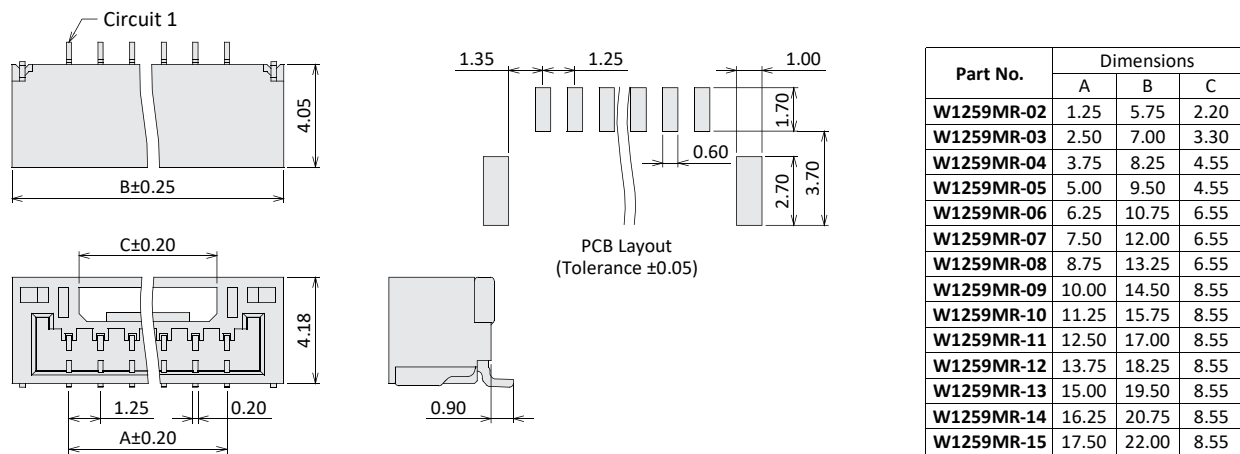
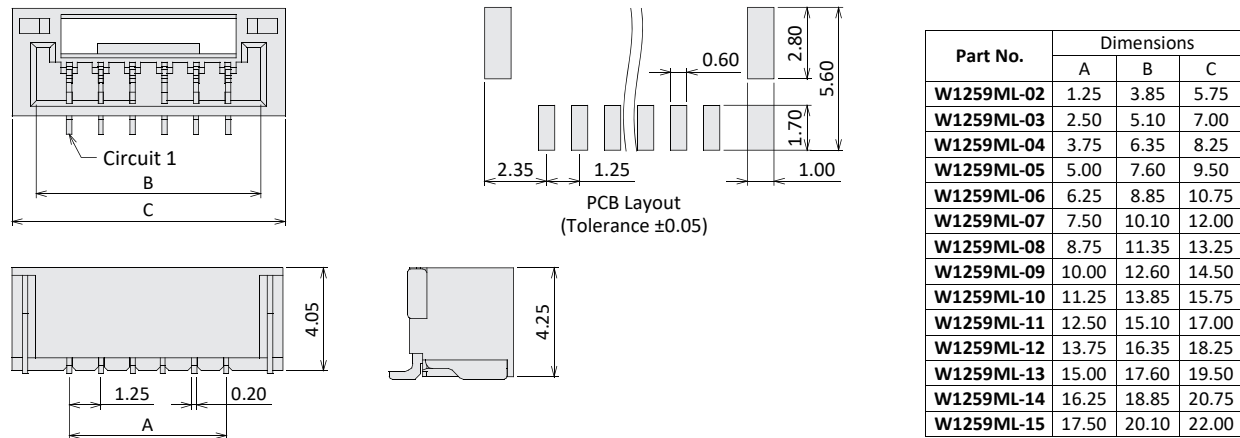
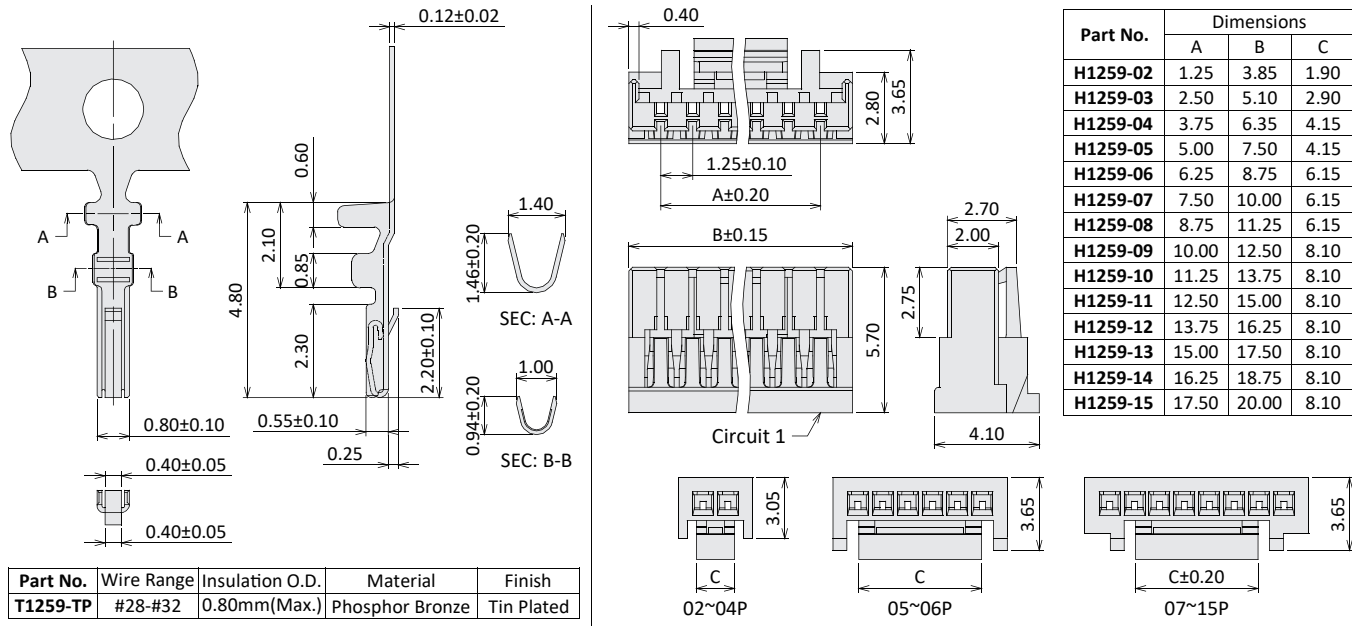
Part No.	Dimensions		
	A	B	C
W1258MR-02	1.25	7.65	8.07
W1258MR-03	2.50	8.90	9.32
W1258MR-04	3.75	10.15	10.57
W1258MR-05	5.00	11.40	11.82
W1258MR-06	6.25	12.65	13.07
W1258MR-07	7.50	13.90	14.32
W1258MR-08	8.75	15.15	15.57
W1258MR-09	10.00	16.40	16.82
W1258MR-10	11.25	17.65	18.07
W1258MR-11	12.50	18.90	19.32
W1258MR-12	13.75	20.15	20.57
W1258MR-13	15.00	21.40	21.82
W1258MR-14	16.25	22.65	23.07
W1258MR-15	17.50	23.90	24.32
W1258MR-16	18.75	25.15	25.57
W1258MR-20	23.75	30.15	30.57
W1258MR-30	36.25	42.65	43.07

# Wafer Housing Terminal

Current Rate: 1A / 50V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 100MΩ Min.  
 Contact Resistance: 30mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Solder Tabs: Copper Alloy, Tin Plated  
 Material Insulator: NY 66/NY 46/LCP, UL94V-0  
 Operating Temperature: -25°C~+85°C

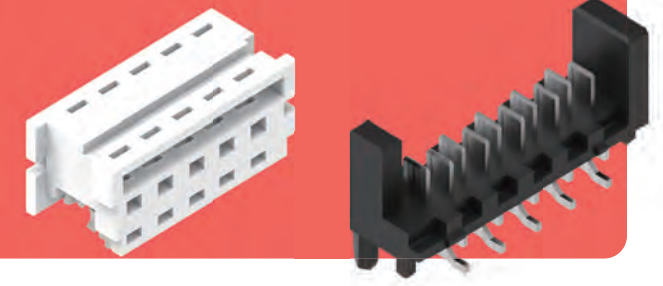


## Terminal Housing Wafer 1259 Series 1.25mm Pitch

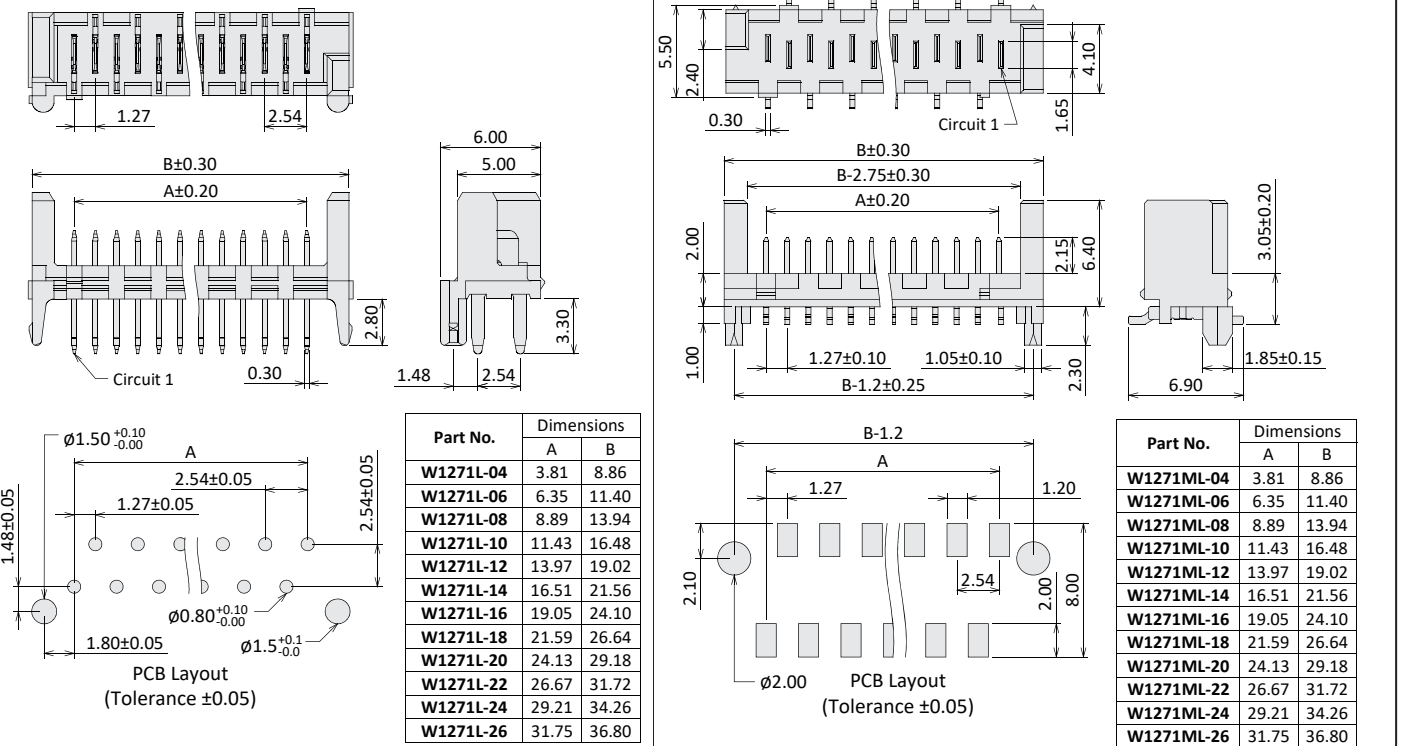
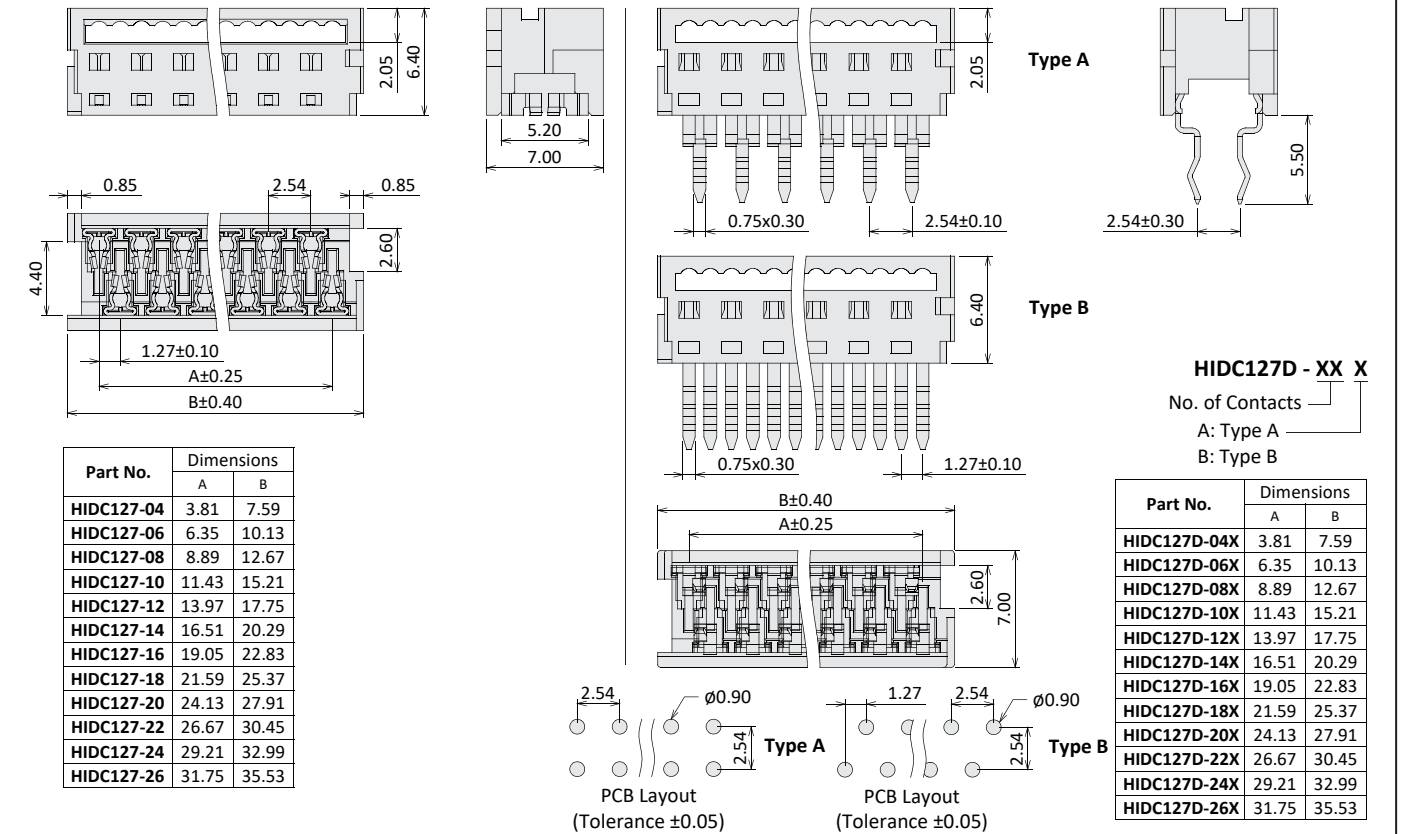


# Wafer Housing Terminal

Current Rate: 1A / 500V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Hi-Temp. Plastic, UL94V-0  
 Operating Temperature: -40°C~+105°C

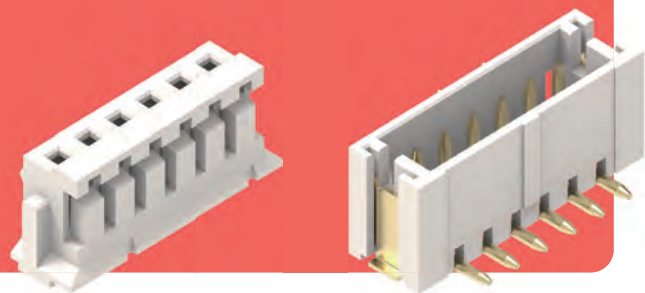


## IDC Type Housing Wafer 1271 Series 1.27mm Pitch

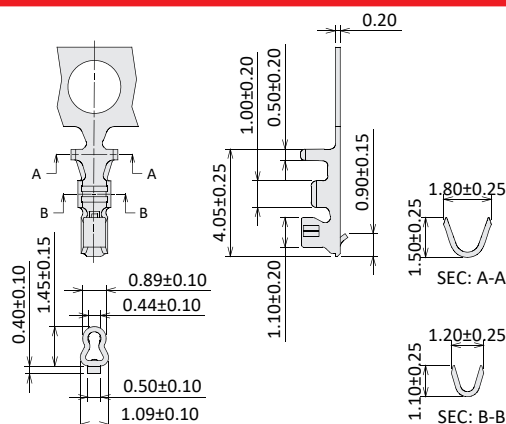


# Wafer Housing Terminal

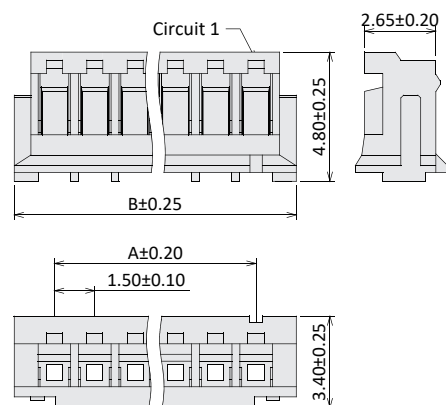
Current Rate: 1A / 100V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 500MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Gold or Tin  
 Solder Tabs: Copper Alloy, Gold Plated  
 Material Insulator: NY66 or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



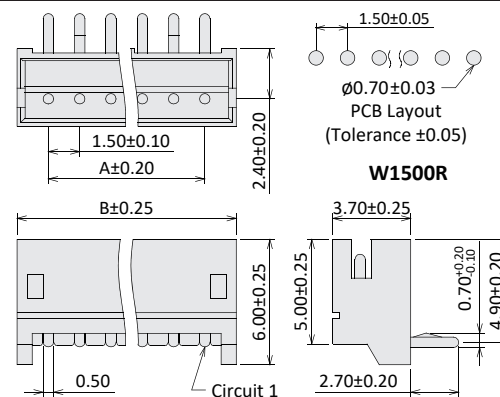
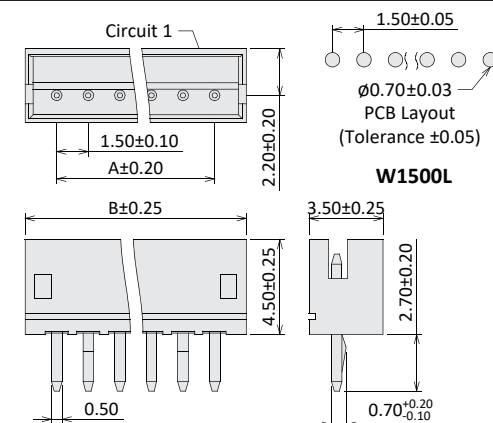
## Terminal Housing Wafer 1500 Series 1.50mm Pitch



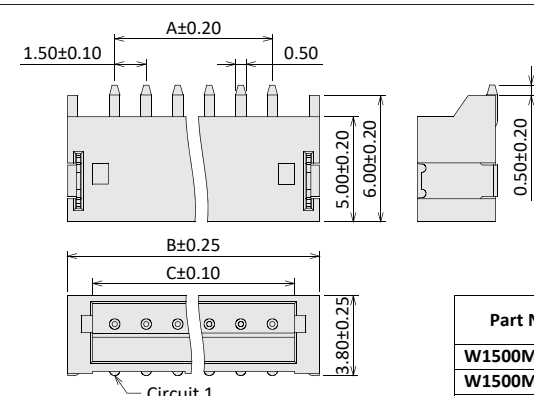
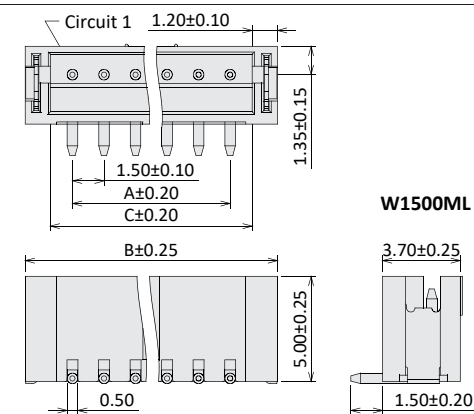
Part No.	Wire Range	Insulation O.D.	Material	Finish
T1500-TP	#26-#32	1.10mm(Max.)	Phosphor Bronze	Tin Plated
T1500-GP	#26-#32	1.10mm(Max.)	Phosphor Bronze	Gold Plated



Part No.	Dimensions	
	A	B
H1500-02	1.50	4.50
H1500-03	3.00	6.00
H1500-04	4.50	7.50
H1500-05	6.00	9.00
H1500-06	7.50	10.50
H1500-07	9.00	12.00
H1500-08	10.50	13.50
H1500-09	12.00	15.00
H1500-10	13.50	16.50
H1500-11	15.00	18.00
H1500-12	16.50	19.50
H1500-13	18.00	21.00



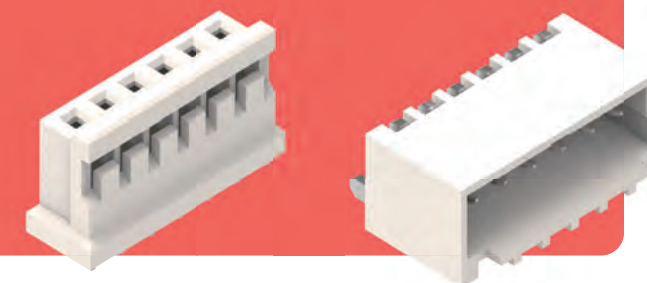
Part No.	Dimensions	
	A	B
W1500L(R)-02	1.50	4.50
W1500L(R)-03	3.00	6.00
W1500L(R)-04	4.50	7.50
W1500L(R)-05	6.00	9.00
W1500L(R)-06	7.50	10.50
W1500L(R)-07	9.00	12.00
W1500L(R)-08	10.50	13.50
W1500L(R)-09	12.00	15.00
W1500L(R)-10	13.50	16.50
W1500L(R)-11	15.00	18.00
W1500L(R)-12	16.50	19.50
W1500L(R)-13	18.00	21.00



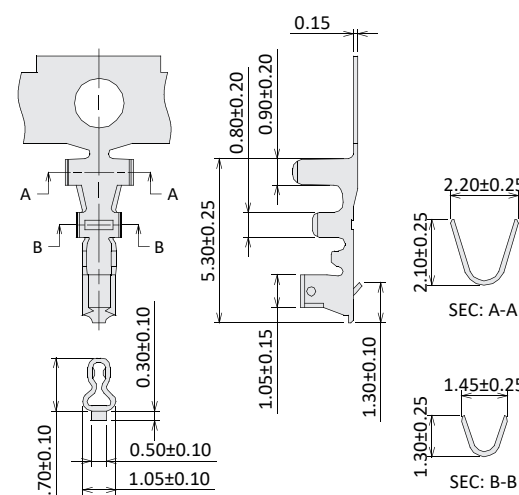
Part No.	Dimensions		
	A	B	C
W1500ML(R)-02	1.50	6.00	3.60
W1500ML(R)-03	3.00	7.50	5.10
W1500ML(R)-04	4.50	9.00	6.60
W1500ML(R)-05	6.00	10.50	8.10
W1500ML(R)-06	7.50	12.00	9.60
W1500ML(R)-07	9.00	13.50	11.10
W1500ML(R)-08	10.50	15.00	12.60
W1500ML(R)-09	12.00	16.50	14.10
W1500ML(R)-10	13.50	18.00	15.60
W1500ML(R)-11	15.00	19.50	17.10
W1500ML(R)-12	16.50	21.00	18.60
W1500ML(R)-13	18.00	22.50	20.10

# Wafer Housing Terminal

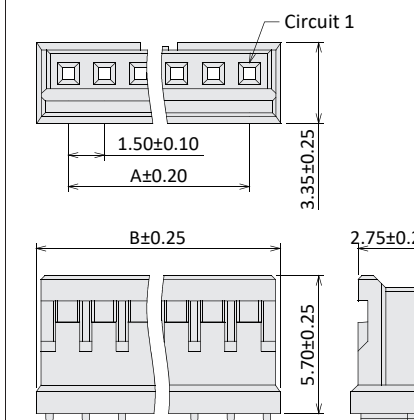
Current Rate: 3A / 350V AC,DC  
 Dielectric Voltage: 500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: NY66 or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



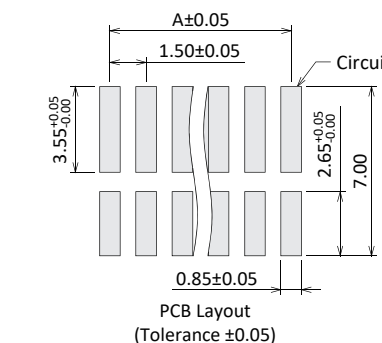
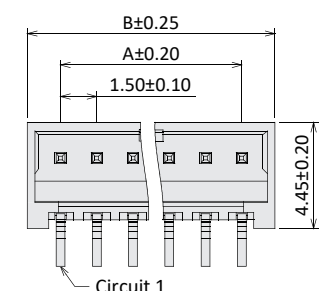
## Terminal Housing Wafer 1501 Series 1.50mm Pitch



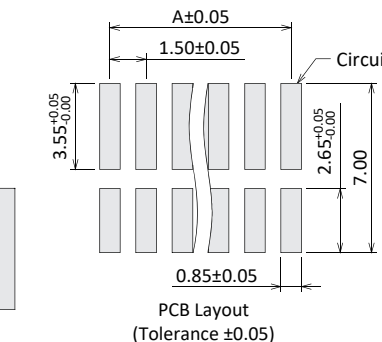
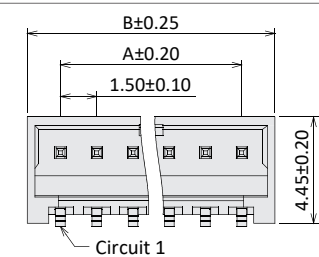
Part No.	Wire Range	Insulation O.D.	Material	Finish
T1501-TP	#24-#28	1.10mm(Max.)	Phosphor Bronze	Tin Plated



Part No.	Dimensions	
	A	B
H1501-02	1.50	4.10
H1501-03	3.00	5.60
H1501-04	4.50	7.10
H1501-05	6.00	8.60
H1501-06	7.50	10.10
H1501-07	9.00	11.60
H1501-08	10.50	13.10
H1501-09	12.00	14.60
H1501-10	13.50	16.10
H1501-11	15.00	17.60
H1501-12	16.50	19.10
H1501-13	18.00	20.60
H1501-14	19.50	22.10
H1501-15	21.00	23.60



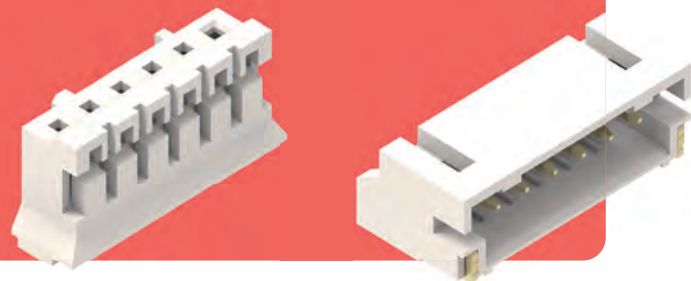
Part No.	Dimensions	
	A	B
W1501ML-02	1.50	4.30
W1501ML-03	3.00	5.80
W1501ML-04	4.50	7.30
W1501ML-05	6.00	8.80
W1501ML-06	7.50	10.30
W1501ML-07	9.00	11.80
W1501ML-08	10.50	13.30
W1501ML-09	12.00	14.80
W1501ML-10	13.50	16.30
W1501ML-11	15.00	17.80
W1501ML-12	16.50	19.30
W1501ML-13	18.00	20.80
W1501ML-14	19.50	22.30
W1501ML-15	21.00	23.80



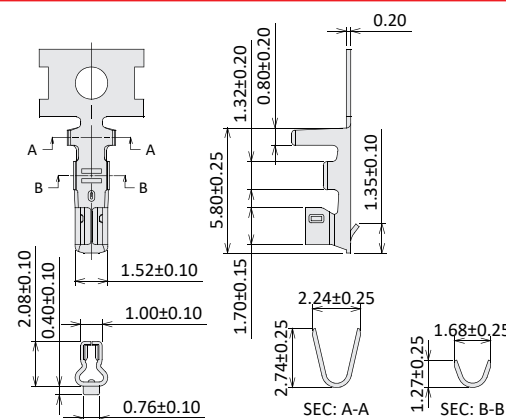
Part No.	Dimensions	
	A	B
W1501MR-02	1.50	4.30
W1501MR-03	3.00	5.80
W1501MR-04	4.50	7.30
W1501MR-05	6.00	8.80
W1501MR-06	7.50	10.30
W1501MR-07	9.00	11.80
W1501MR-08	10.50	13.30
W1501MR-09	12.00	14.80
W1501MR-10	13.50	16.30
W1501MR-11	15.00	17.80
W1501MR-12	16.50	19.30
W1501MR-13	18.00	20.80
W1501MR-14	19.50	22.30
W1501MR-15	21.00	23.80

# Wafer Housing Terminal

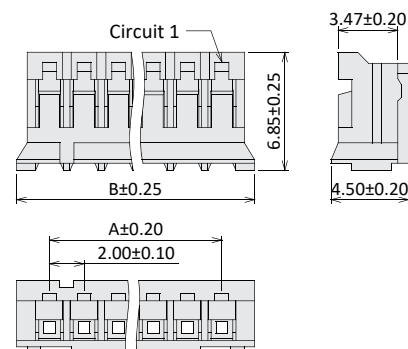
Current Rate: 2A / 100V AC,DC  
 Dielectric Voltage: 800V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin or Gold  
 Material Insulator: NY66 or NY 6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



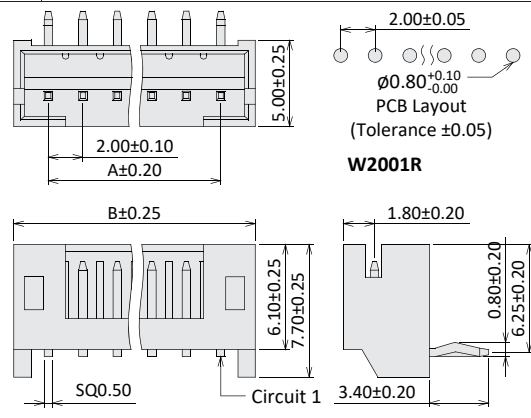
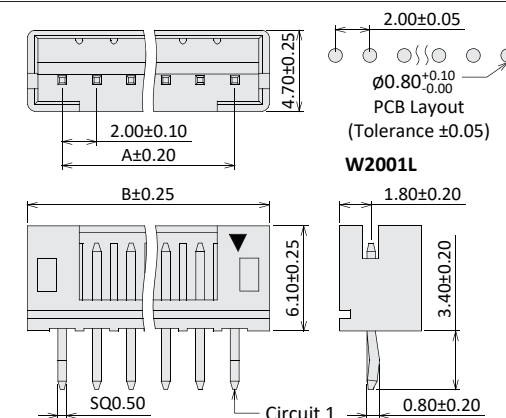
## Terminal Housing Wafer 2001 Series 2.00mm Pitch



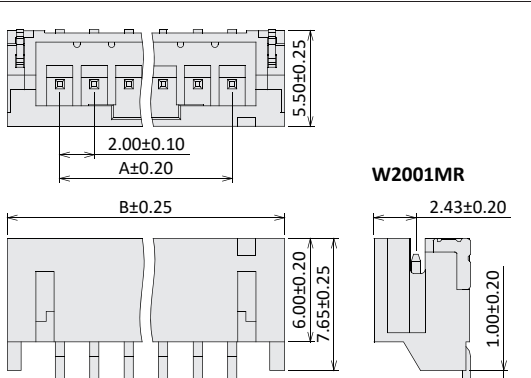
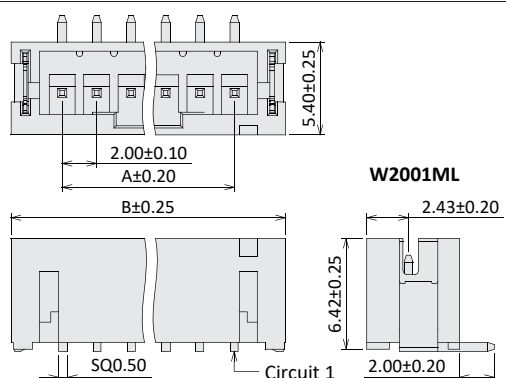
Part No.	Wire Range	Insulation O.D.	Material	Finish
T2001-TP	#24-#30	1.50mm(Max.)	Phosphor Bronze	Tin Plated
T2001-MP	#24-#30	1.50mm(Max.)	Phosphor Bronze	Mist Tin Plated
T2001-GP	#24-#30	1.50mm(Max.)	Phosphor Bronze	Gold Plated



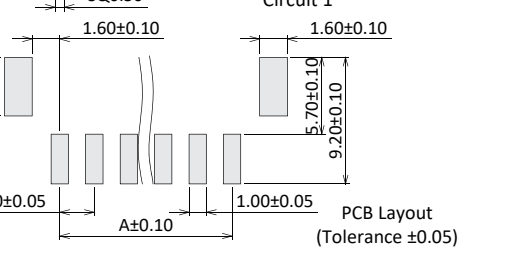
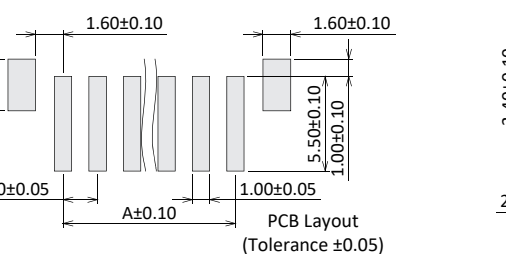
Part No.	Dimensions	
	A	B
H2001-02	2.00	5.80
H2001-03	4.00	7.80
H2001-04	6.00	9.80
H2001-05	8.00	11.80
H2001-06	10.00	13.80
H2001-07	12.00	15.80
H2001-08	14.00	17.80
H2001-09	16.00	19.80
H2001-10	18.00	21.80
H2001-11	20.00	23.80
H2001-12	22.00	25.80
H2001-13	24.00	27.80
H2001-14	26.00	29.80
H2001-15	28.00	31.80
H2001-16	30.00	33.80



Part No.	Dimensions	
	A	B
W2001L(R)-02	2.00	6.00
W2001L(R)-03	4.00	8.00
W2001L(R)-04	6.00	10.00
W2001L(R)-05	8.00	12.00
W2001L(R)-06	10.00	14.00
W2001L(R)-07	12.00	16.00
W2001L(R)-08	14.00	18.00
W2001L(R)-09	16.00	20.00
W2001L(R)-10	18.00	22.00
W2001L(R)-11	20.00	24.00
W2001L(R)-12	22.00	26.00
W2001L(R)-13	24.00	28.00
W2001L(R)-14	26.00	30.00
W2001L(R)-15	28.00	32.00
W2001L(R)-16	30.00	34.00

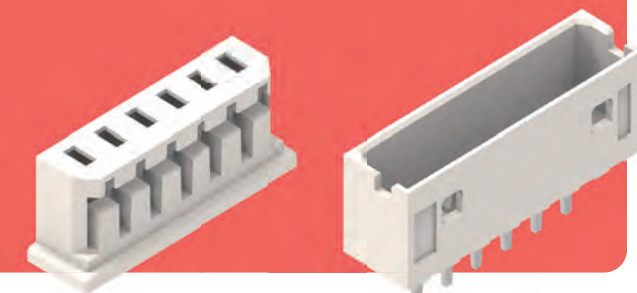


Part No.	Dimensions	
	A	B
W2001ML(MR)-02	2.00	8.00
W2001ML(MR)-03	4.00	10.00
W2001ML(MR)-04	6.00	12.00
W2001ML(MR)-05	8.00	14.00
W2001ML(MR)-06	10.00	16.00
W2001ML(MR)-07	12.00	18.00
W2001ML(MR)-08	14.00	20.00
W2001ML(MR)-09	16.00	22.00
W2001ML(MR)-10	18.00	24.00
W2001ML(MR)-11	20.00	26.00
W2001ML(MR)-12	22.00	28.00
W2001ML(MR)-13	24.00	30.00
W2001ML(MR)-14	26.00	32.00
W2001ML(MR)-15	28.00	34.00
W2001ML(MR)-16	30.00	36.00

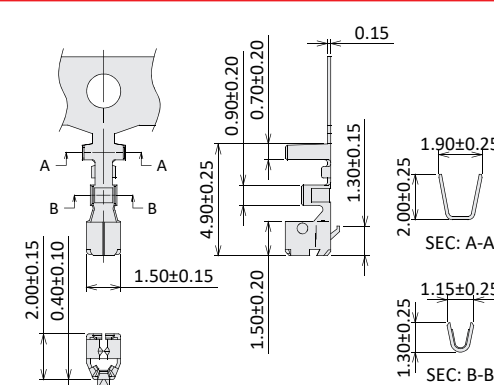


# Wafer Housing Terminal

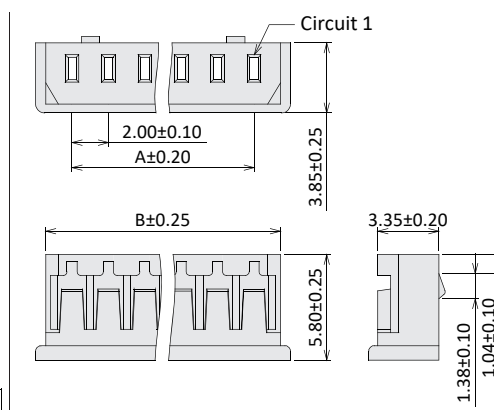
Current Rate: 2A / 125V AC,DC  
 Dielectric Voltage: 800V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C



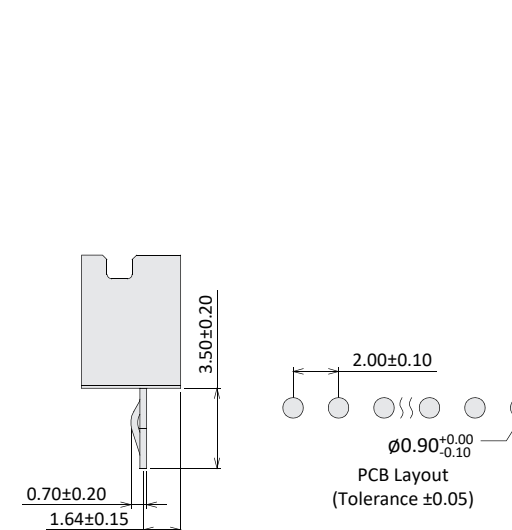
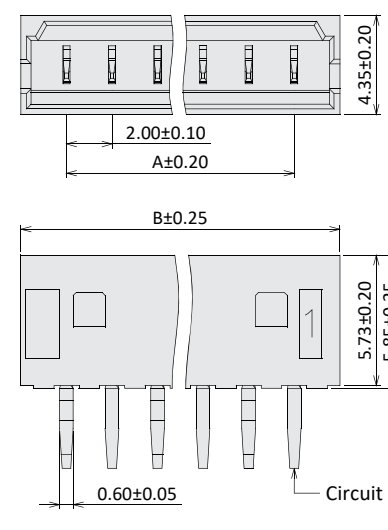
## Terminal Housing Wafer 2002 Series 2.00mm Pitch



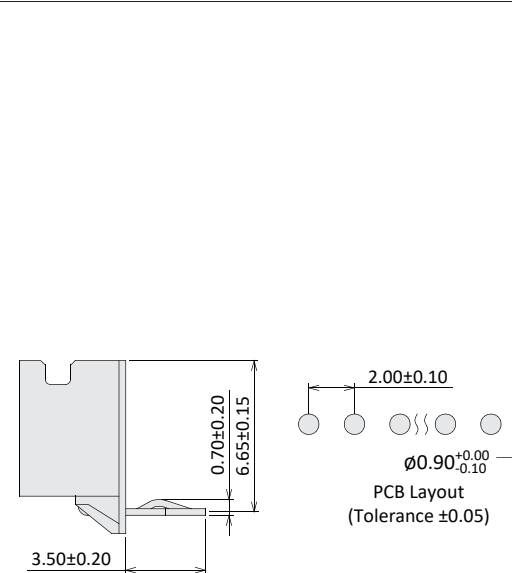
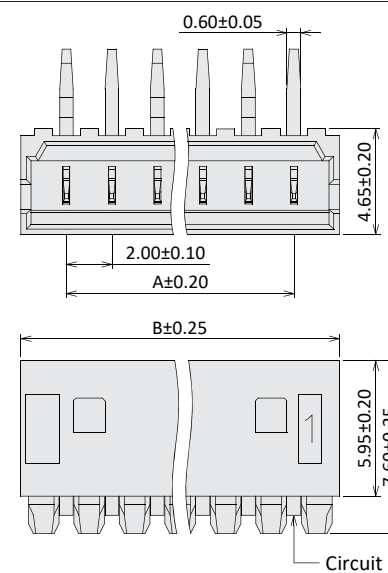
Part No.	Wire Range	Insulation O.D.	Material	Finish
T2002-TP	#24-#30	1.40mm(Max.)	Phosphor Bronze	Tin Plated



Part No.	Dimensions	
	A	B
H2002-02	2.00	4.90
H2002-03	4.00	6.90
H2002-04	6.00	8.90
H2002-05	8.00	10.90
H2002-06	10.00	12.90
H2002-07	12.00	14.90
H2002-08	14.00	16.90
H2002-09	16.00	18.90
H2002-10	18.00	20.90
H2002-11	20.00	22.90
H2002-12	22.00	24.90
H2002-13	24.00	26.90
H2002-14	26.00	28.90
H2002-15	28.00	30.90



Part No.	Dimensions	
	A	B
W2002L-02	2.00	6.00
W2002L-03	4.00	8.00
W2002L-04	6.00	10.00
W2002L-05	8.00	12.00
W2002L-06	10.00	14.00
W2002L-07	12.00	16.00
W2002L-08	14.00	18.00
W2002L-09	16.00	20.00
W2002L-10	18.00	22.00
W2002L-11	20.00	24.00
W2002L-12	22.00	26.00
W2002L-13	24.00	28.00
W2002L-14	26.00	30.00
W2002L-15	28.00	32.00

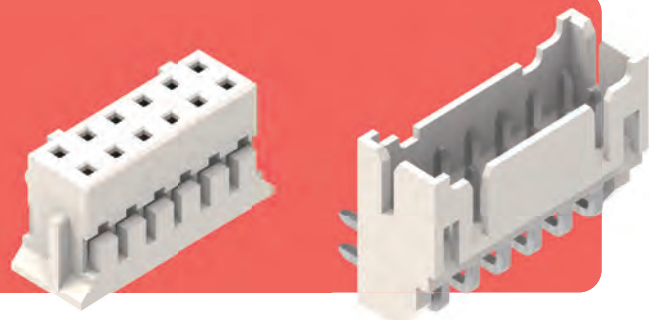


Part No.	Dimensions	
	A	B
W2002R-02	2.00	6.00
W2002R-03	4.00	8.00
W2002R-04	6.00	10.00
W2002R-05	8.00	12.00
W2002R-06	10.00	14.00
W2002R-07	12.00	16.00
W2002R-08	14.00	18.00
W2002R-09	16.00	20.00
W2002R-10	18.00	22.00
W2002R-11	20.00	24.00
W2002R-12	22.00	26.00
W2002R-13	24.00	28.00
W2002R-14	26.00	30.00
W2002R-15	28.00	32.00



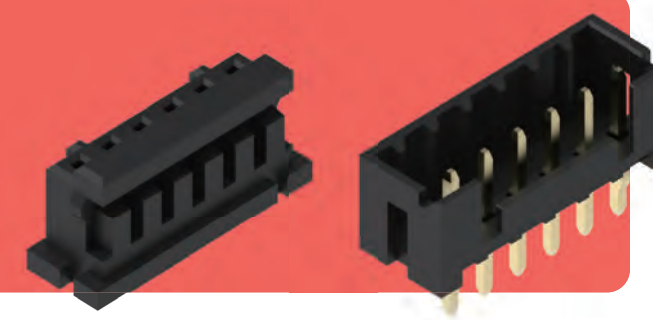
# Wafer Housing Terminal

Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 800V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin or Gold  
 Material Insulator: NY66 or NY6T, UL94V-0  
 Operating Temperature: -25°C~+85°C

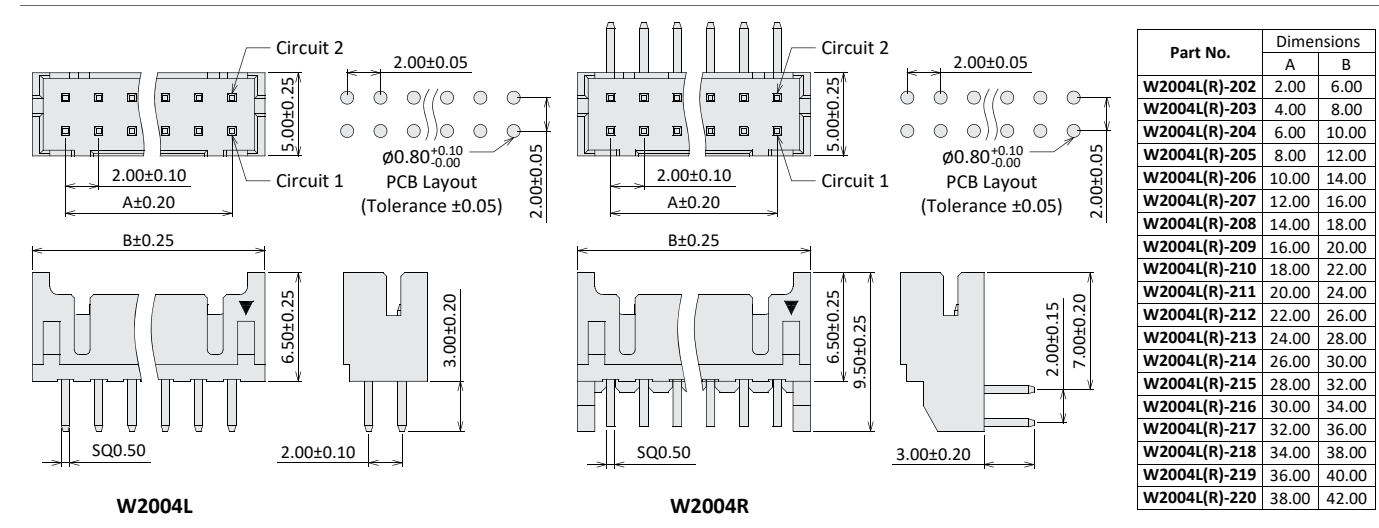
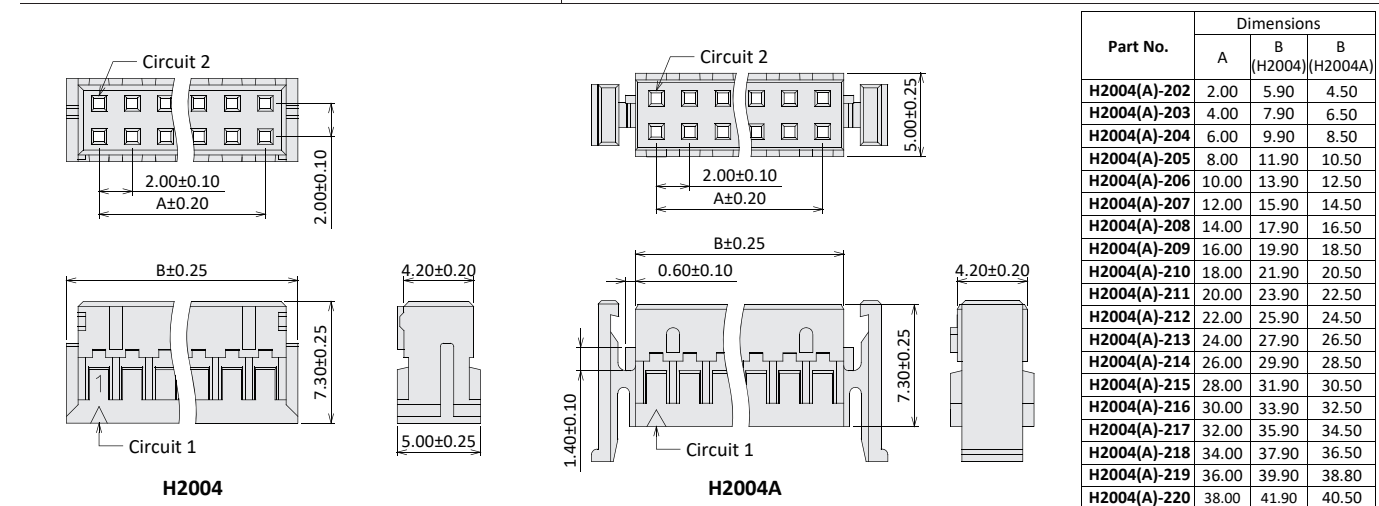
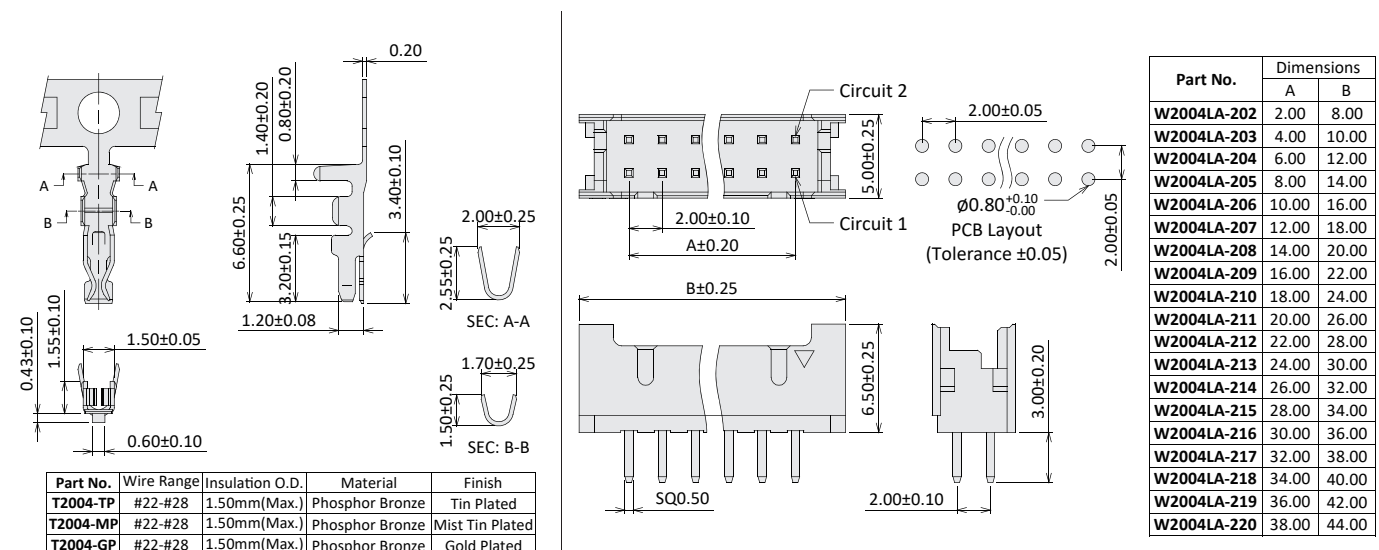


# Wafer Housing Terminal

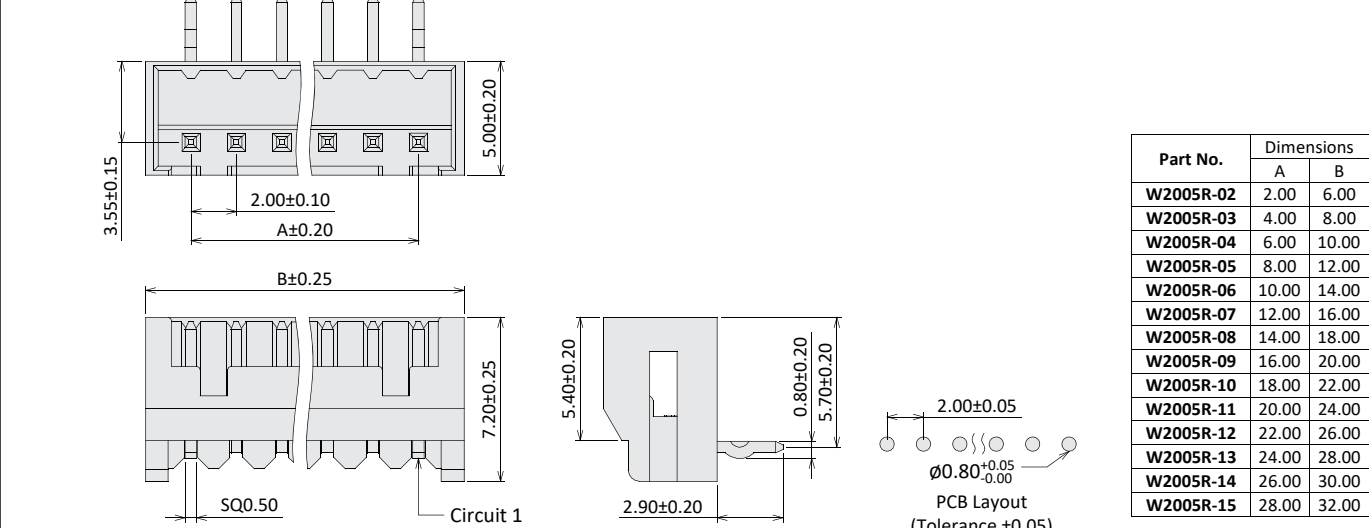
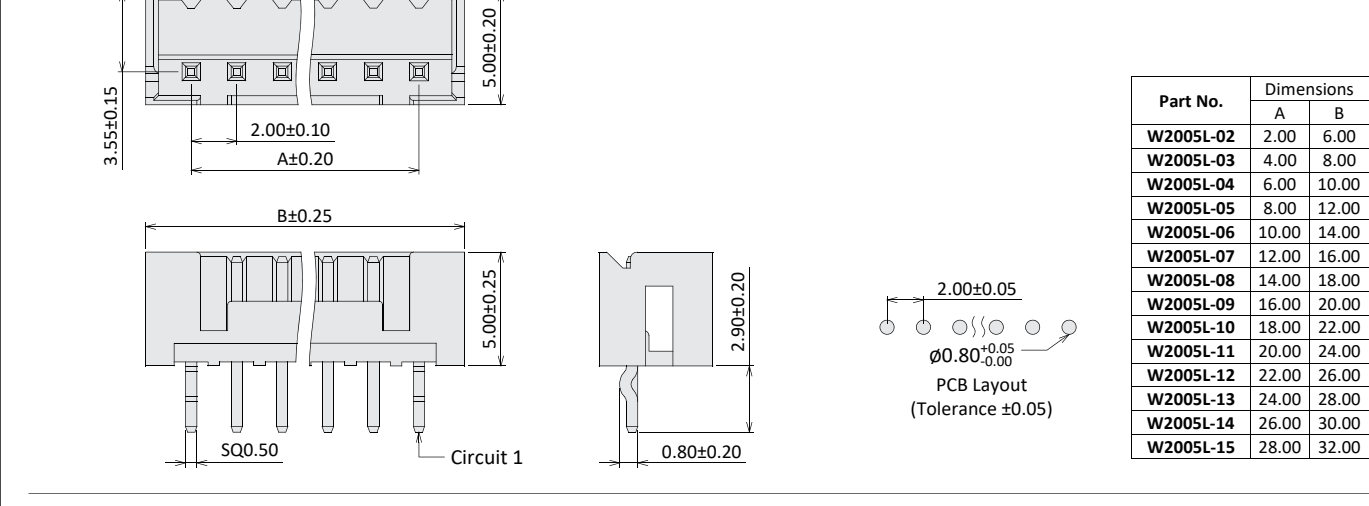
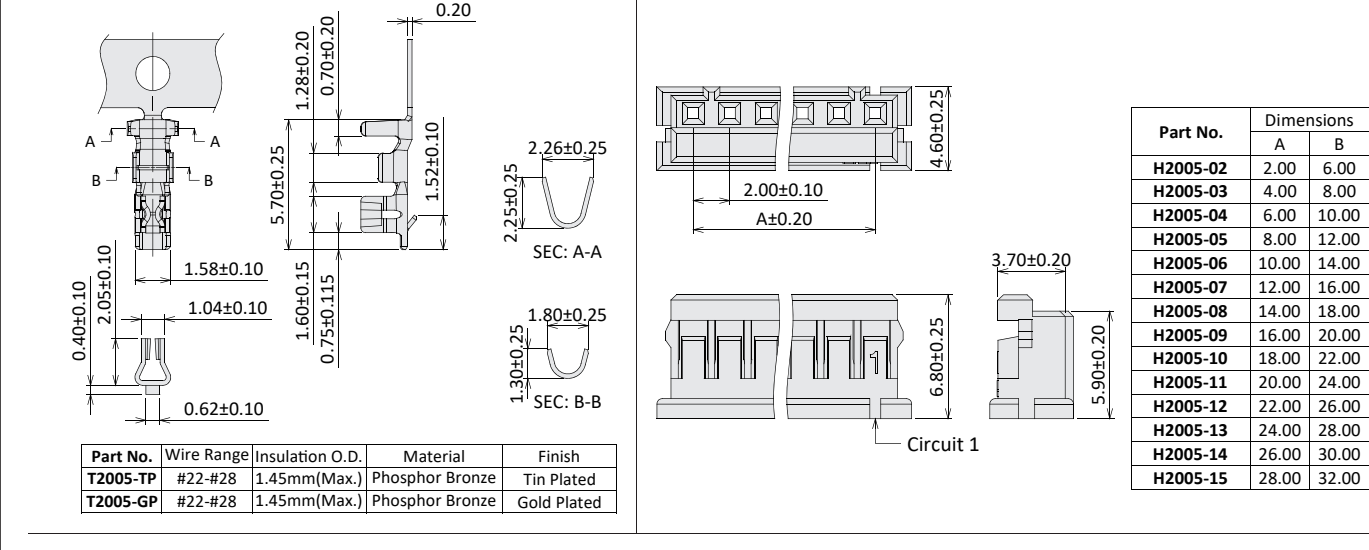
Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 650V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 30mΩ Max.  
 Material Contact: Copper Alloy, Gold Plated  
 Material Insulator: NY66 or NY6T, UL94V-0  
 Operating Temperature: -25°C~+85°C



## Terminal Housing Wafer 2004 Series 2.00mm Pitch

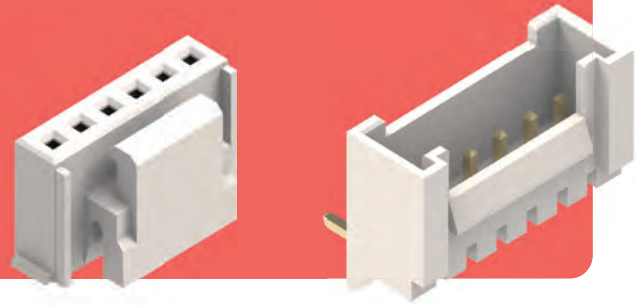


## Terminal Housing Wafer 2005 Series 2.00mm Pitch

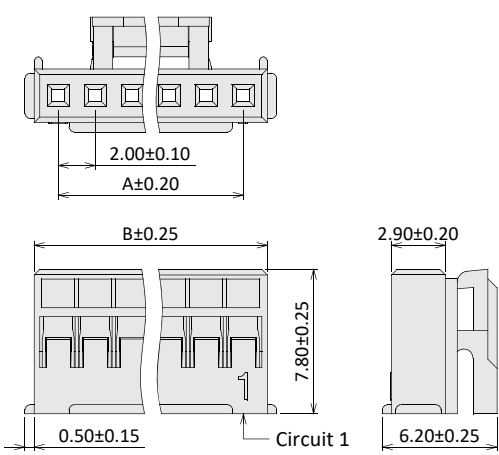
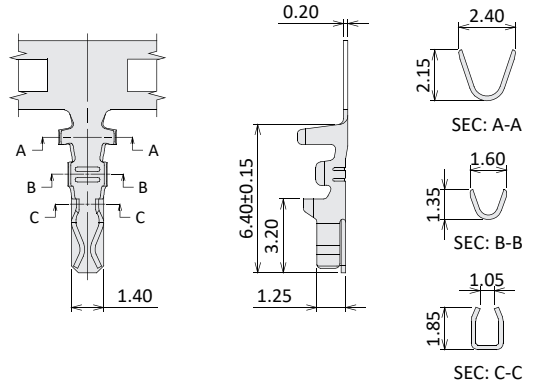


# Wafer Housing Terminal

Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 1000V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 30mΩ Max.  
 Material Contact: Copper Alloy, Gold Plated  
 Material Insulator: NY66 or NY46, UL94V-0  
 Operating Temperature: -25°C~+85°C

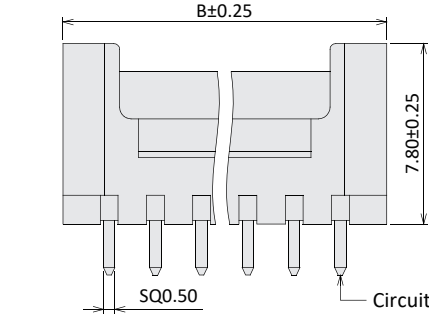
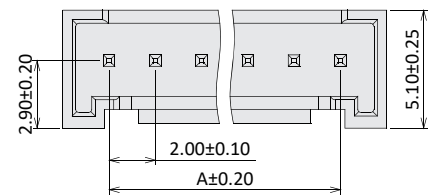


## Terminal Housing Wafer 2006 Series 2.00mm Pitch

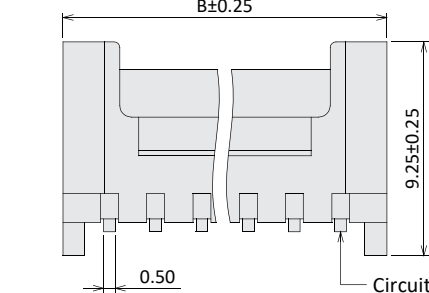
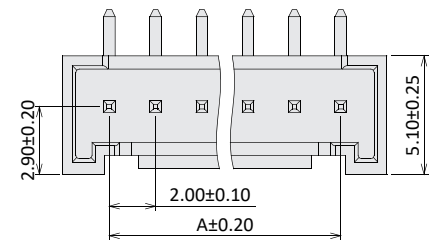
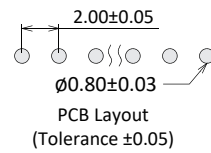


Part No.	Dimensions	
	A	B
H2006-02	2.00	4.60
H2006-03	4.00	6.60
H2006-04	6.00	8.60
H2006-05	8.00	10.60
H2006-06	10.00	12.60
H2006-07	12.00	14.60
H2006-08	14.00	16.60
H2006-09	16.00	18.60
H2006-10	18.00	20.60
H2006-11	20.00	22.60
H2006-12	22.00	24.60
H2006-13	24.00	26.60
H2006-14	26.00	28.60
H2006-15	28.00	30.60
H2006-16	30.00	32.60

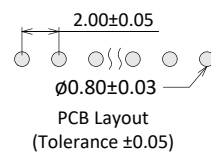
Part No.	Wire Range	Insulation O.D.	Material	Finish
T2006-TP	#22-#30	1.45mm(Max.)	Phosphor Bronze	Tin Plated



Part No.	Dimensions	
	A	B
W2006L-02	2.00	6.00
W2006L-03	4.00	8.00
W2006L-04	6.00	10.00
W2006L-05	8.00	12.00
W2006L-06	10.00	14.00
W2006L-07	12.00	16.00
W2006L-08	14.00	18.00
W2006L-09	16.00	20.00
W2006L-10	18.00	22.00
W2006L-11	20.00	24.00
W2006L-12	22.00	26.00
W2006L-13	24.00	28.00
W2006L-14	26.00	30.00
W2006L-15	28.00	32.00
W2006L-16	30.00	34.00

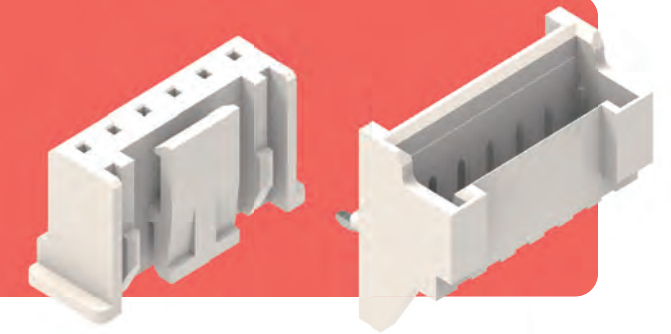


Part No.	Dimensions	
	A	B
W2006R-02	2.00	6.00
W2006R-03	4.00	8.00
W2006R-04	6.00	10.00
W2006R-05	8.00	12.00
W2006R-06	10.00	14.00
W2006R-07	12.00	16.00
W2006R-08	14.00	18.00
W2006R-09	16.00	20.00
W2006R-10	18.00	22.00
W2006R-11	20.00	24.00
W2006R-12	22.00	26.00
W2006R-13	24.00	28.00
W2006R-14	26.00	30.00
W2006R-15	28.00	32.00
W2006R-16	30.00	34.00

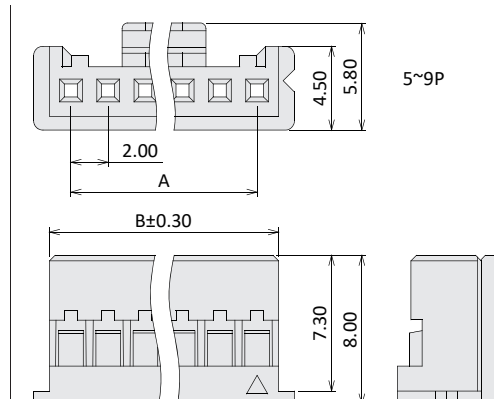
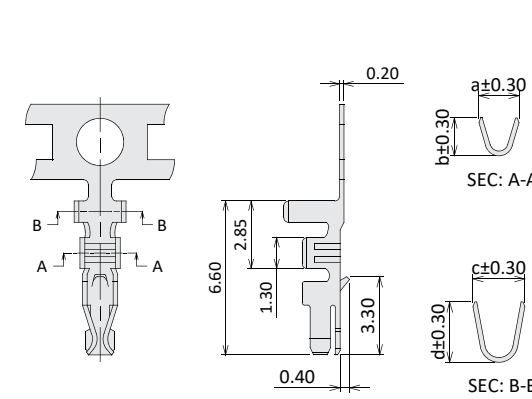


# Wafer Housing Terminal

Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 800V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: NY66 or PBT, UL94V-0  
 Operating Temperature: -25°C~+85°C

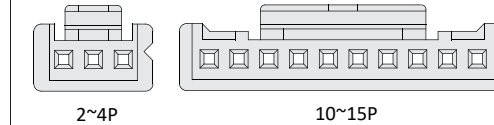


## Terminal Housing Wafer 2007 Series 2.00mm Pitch

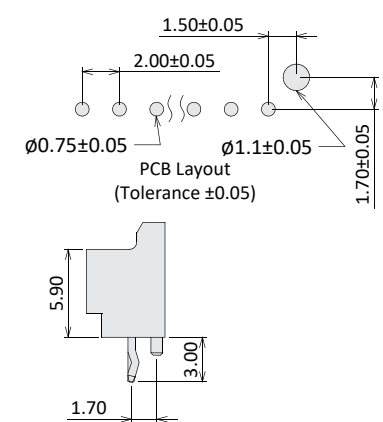
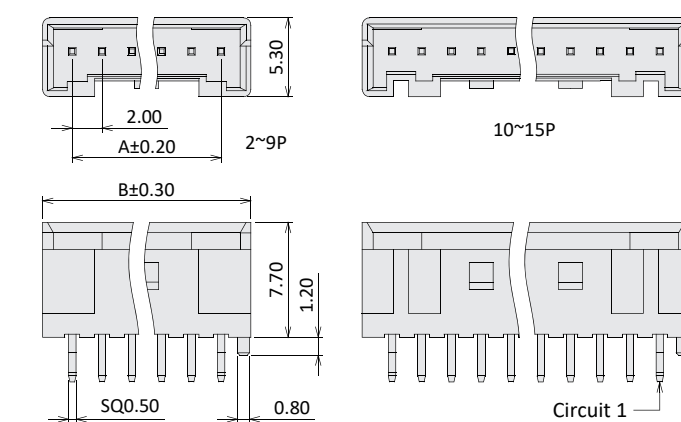


Part No.	Dim. a	Dim. b	Dim. c	Dim. d
T2007-TP	1.60	1.35	2.10	2.50
T2007-TPA	1.70	1.60	2.10	2.50

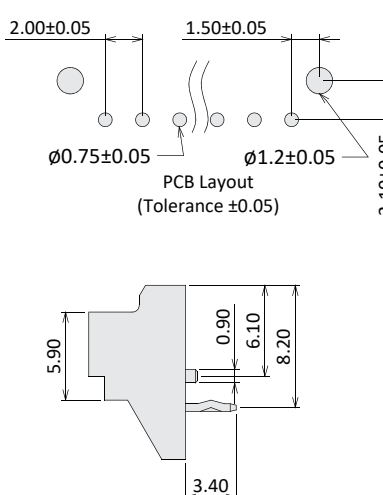
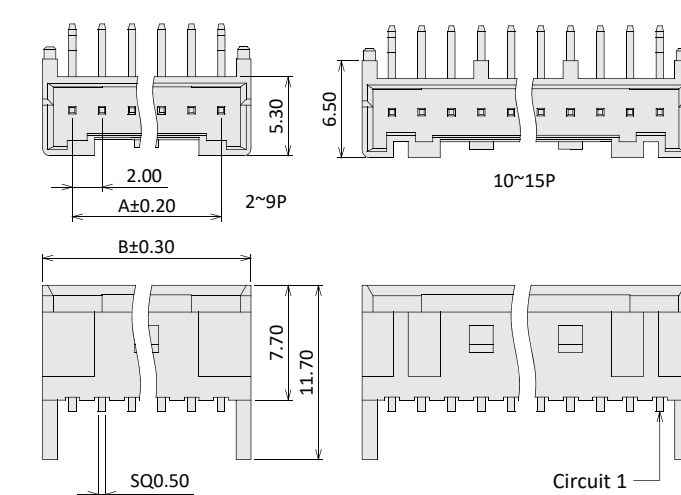
Part No.	Wire Range	Insulation O.D.	Material	Finish
T2007-TP	#24-#28	1.45mm(Max.)	Phosphor Bronze	Tin Plated
T2007-TPA	#22-#26	1.45mm(Max.)	Phosphor Bronze	Tin Plated



Part No.	Dimensions	
	A	B
H2007-02	2.00	4.30
H2007-03	4.00	6.30
H2007-04	6.00	8.30
H2007-05	8.00	10.30
H2007-06	10.00	12.30
H2007-07	12.00	14.30
H2007-08	14.00	16.30
H2007-09	16.00	18.30
H2007-10	18.00	20.30
H2007-11	20.00	22.30
H2007-12	22.00	24.30
H2007-13	24.00	26.30
H2007-14	26.00	28.30
H2007-15	28.00	30.30



Part No.	Dimensions	
	A	B
W2007L-02	2.00	6.00
W2007L-03	4.00	8.00
W2007L-04	6.00	10.00
W2007L-05	8.00	12.00
W2007L-06	10.00	14.00
W2007L-07	12.00	16.00
W2007L-08	14.00	18.00
W2007L-09	16.00	20.00
W2007L-10	18.00	22.00
W2007L-11	20.00	24.00
W2007L-12	22.00	26.00
W2007L-13	24.00	28.00
W2007L-14	26.00	30.00
W2007L-15	28.00	32.00



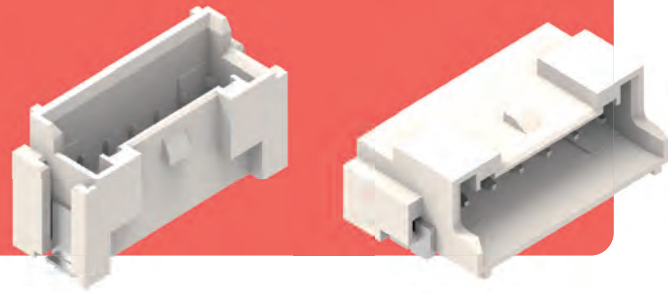
Part No.	Dimensions	
	A	B
W2007R-02	2.00	6.00
W2007R-03	4.00	8.00
W2007R-04	6.00	10.00
W2007R-05	8.00	12.00
W2007R-06	10.00	14.00
W2007R-07	12.00	16.00
W2007R-08	14.00	18.00
W2007R-09	16.00	20.00
W2007R-10	18.00	22.00
W2007R-11	20.00	24.00
W2007R-12	22.00	26.00
W2007R-13	24.00	28.00
W2007R-14	26.00	30.00
W2007R-15	28.00	32.00

Wafer Housing Terminal

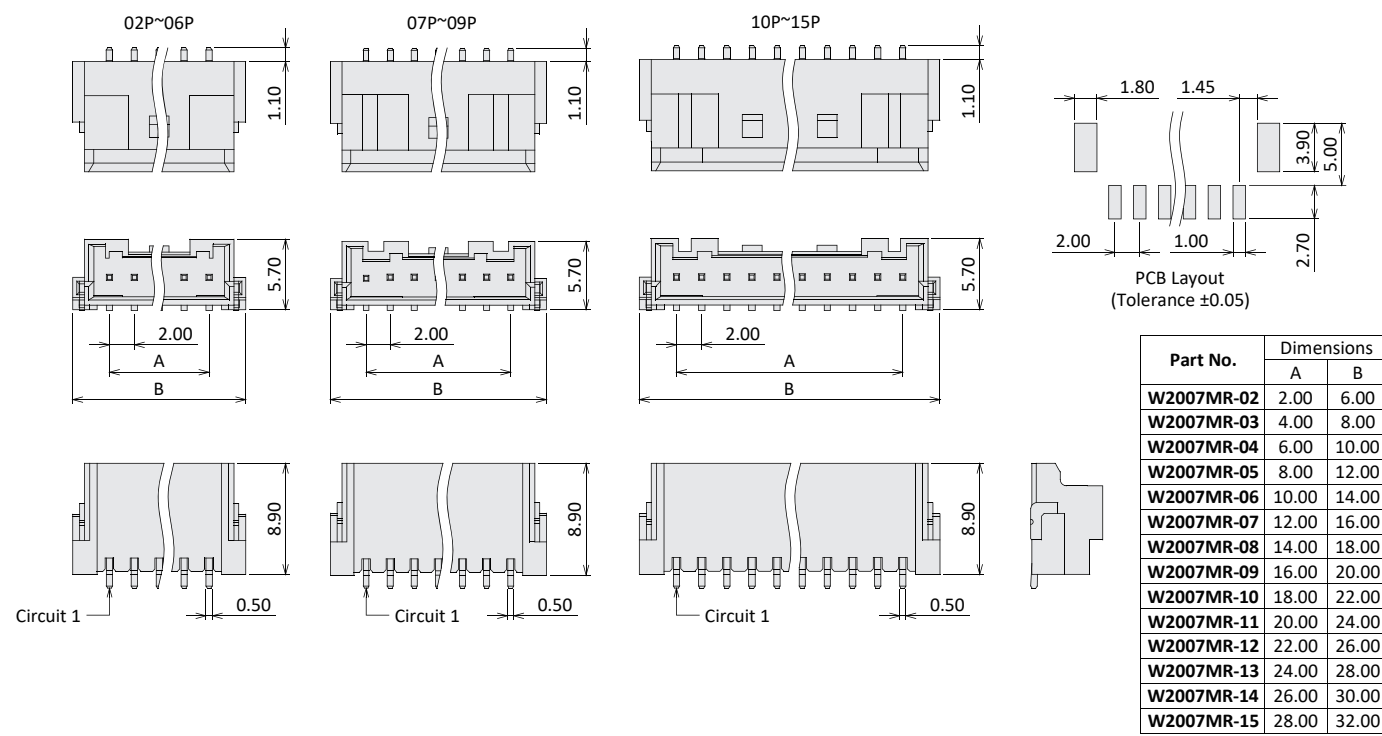
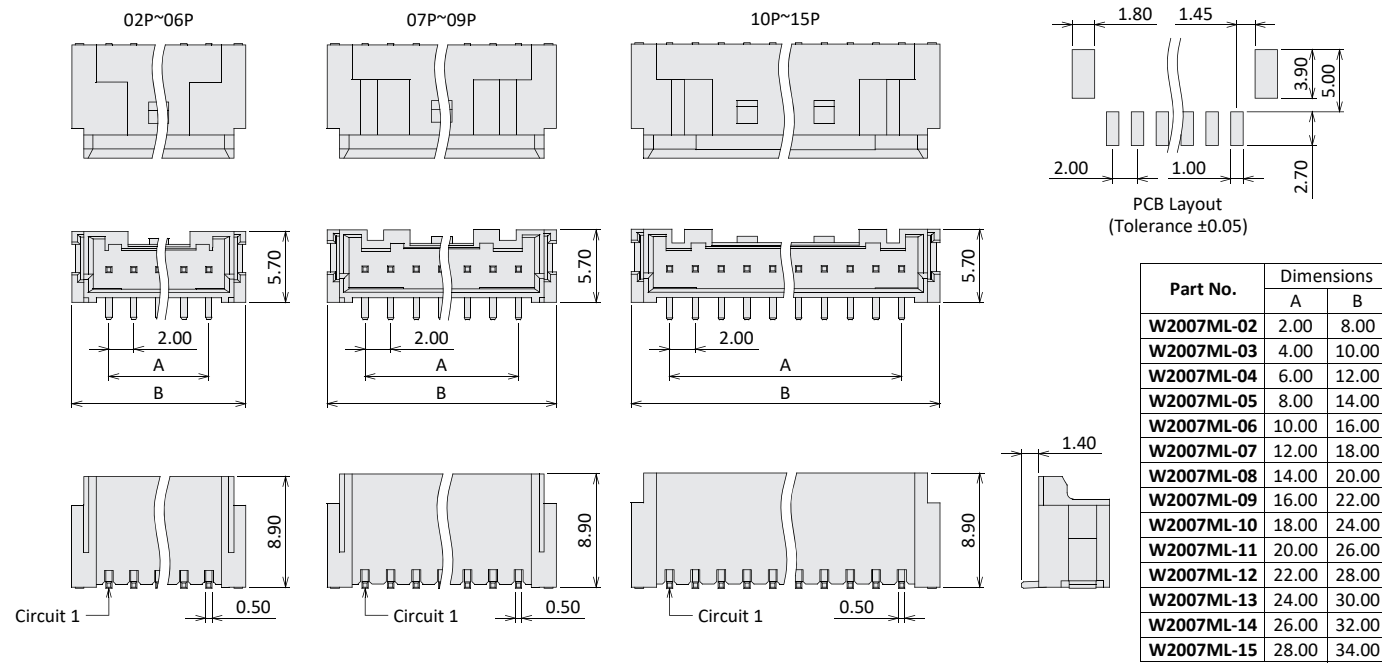
Wafer Housing Terminal

# Wafer Housing Terminal

Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 800V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 6T, UL94V-0  
 Operating Temperature: -25°C~+105°C

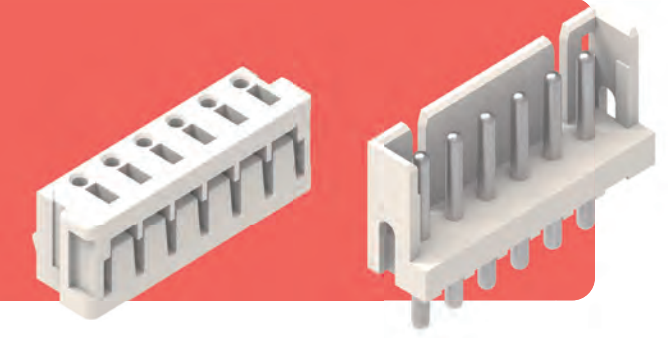


## Wafer 2007 Series 2.00mm Pitch

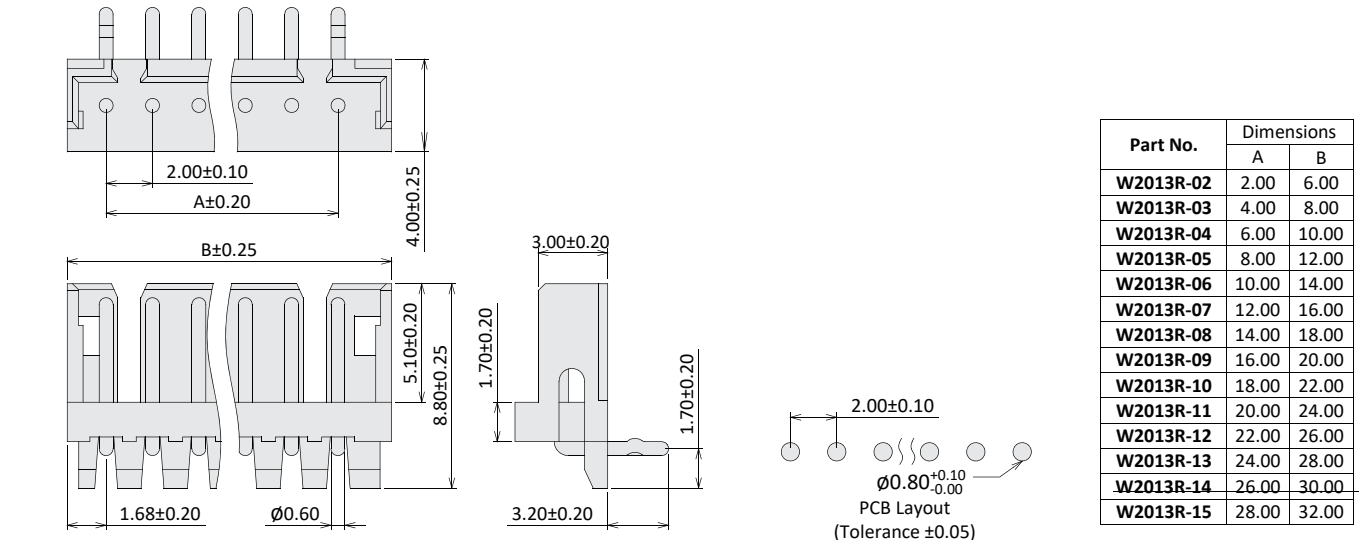
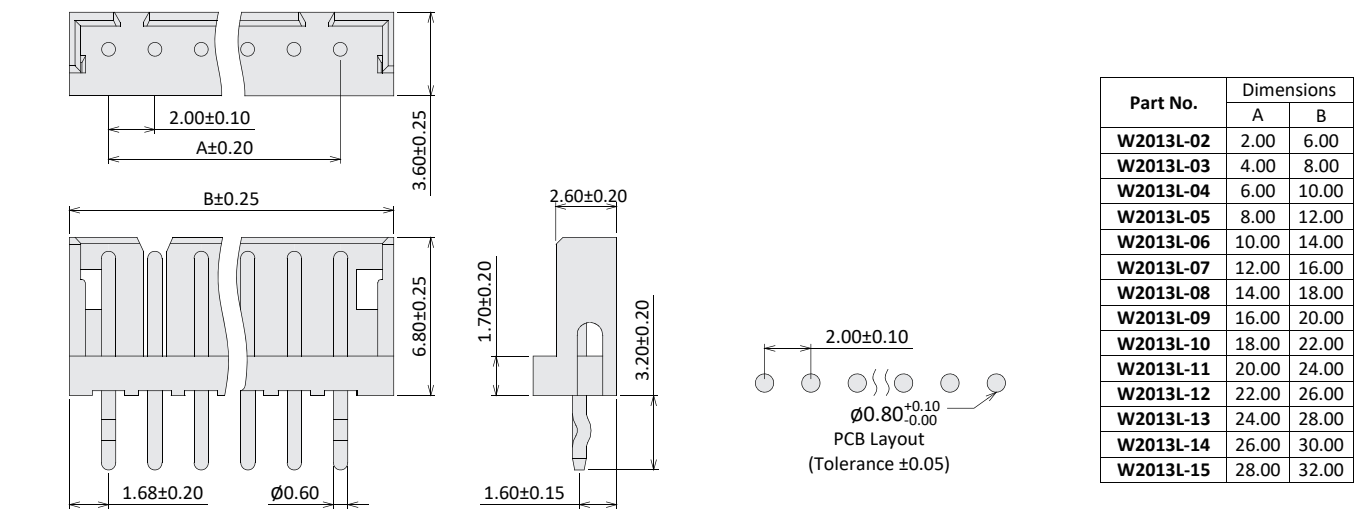
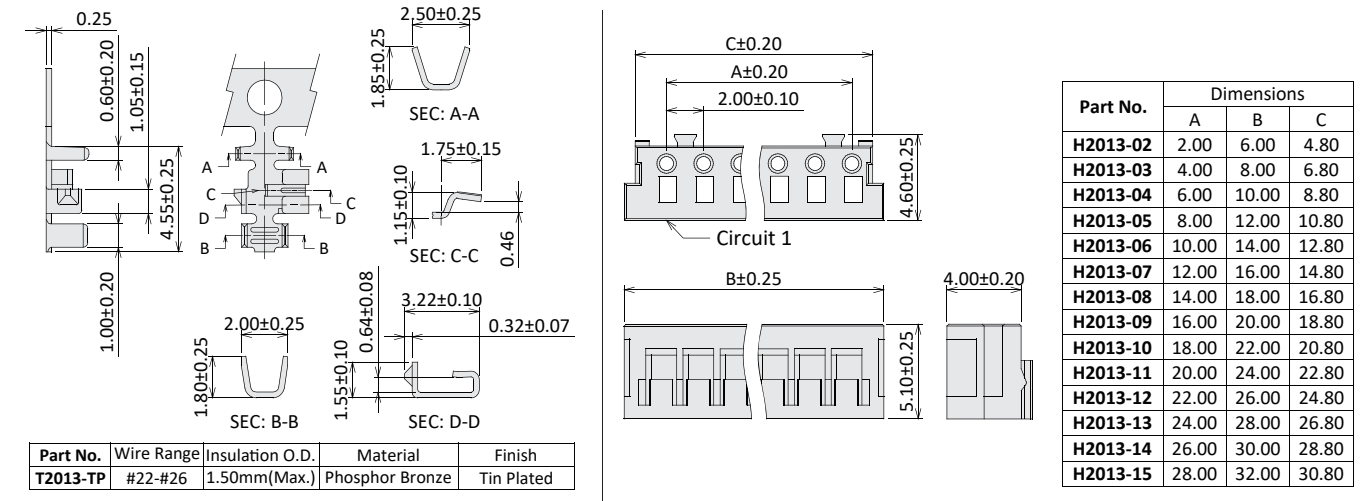


# Wafer Housing Terminal

Current Rate: 4A / 125V AC,DC  
 Dielectric Voltage: 1000V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C

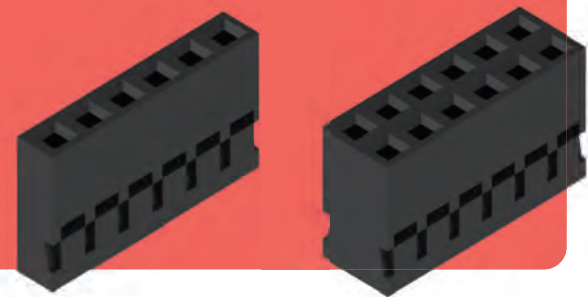


## Terminal Housing Wafer 2013 Series 2.00mm Pitch

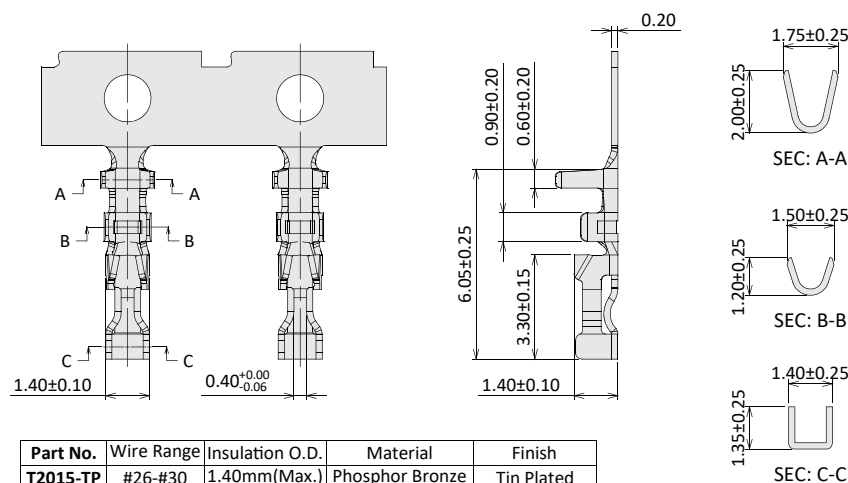


# Wafer Housing Terminal

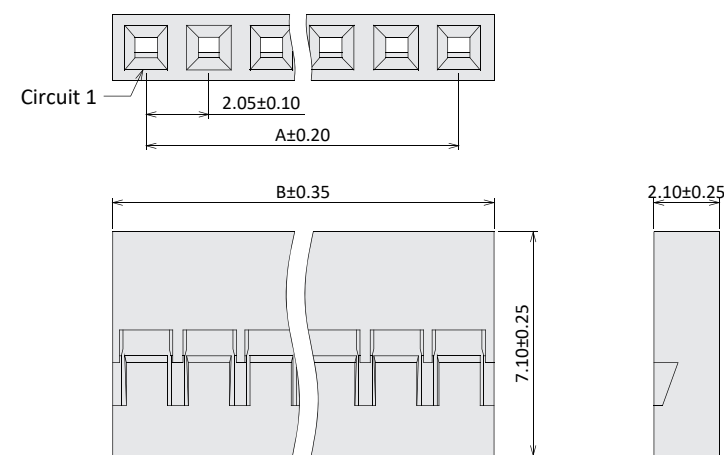
Current Rate: 2A / 250V AC,DC  
 Dielectric Voltage: 1000V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C



## Terminal Housing 2015/2016 Series 2.00mm Pitch

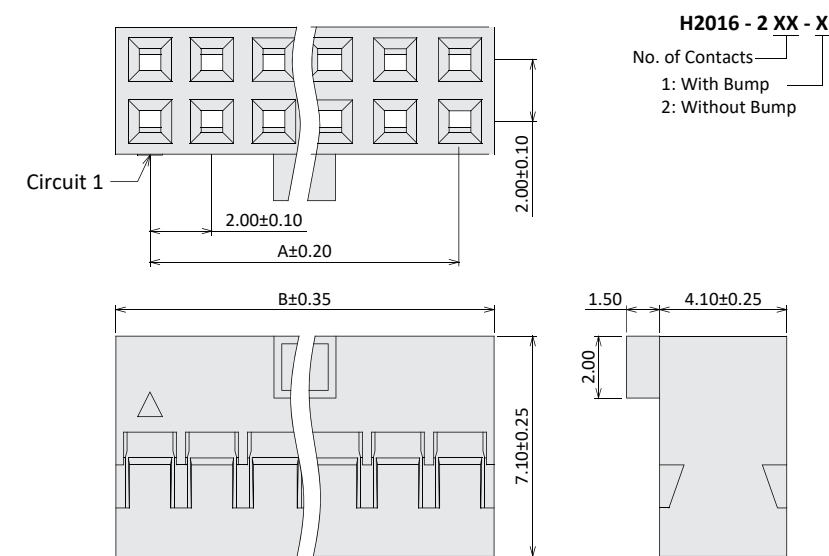


Part No.	Wire Range	Insulation O.D.	Material	Finish
T2015-TP	#26-#30	1.40mm(Max.)	Phosphor Bronze	Tin Plated
T2015-GP	#26-#30	1.40mm(Max.)	Phosphor Bronze	Gold Plated



Part No.	Dimensions	
	A	B
H2015-02	2.00	4.20
H2015-03	4.00	6.20
H2015-04	6.00	8.20
H2015-05	8.00	10.20
H2015-06	10.00	12.20
H2015-07	12.00	14.20
H2015-08	14.00	16.20
H2015-09	16.00	18.20
H2015-10	18.00	20.20
H2015-11	20.00	22.20
H2015-12	22.00	24.20
H2015-13	24.00	26.20
H2015-14	26.00	28.20
H2015-15	28.00	30.20
H2015-16	30.00	32.20

Part No.	Dimensions	
	A	B
H2015-17	32.00	34.20
H2015-18	34.00	36.20
H2015-19	36.00	38.20
H2015-20	38.00	40.20
H2015-21	40.00	42.20
H2015-22	42.00	44.20
H2015-23	44.00	46.20
H2015-24	46.00	48.20
H2015-25	48.00	50.20
H2015-26	50.00	52.20
H2015-27	52.00	54.20
H2015-28	54.00	56.20
H2015-29	56.00	58.20
H2015-30	58.00	60.20



Part No.	Dimensions	
	A	B
H2016-202-X	2.00	4.20
H2016-203-X	4.00	6.20
H2016-204-X	6.00	8.20
H2016-205-X	8.00	10.20
H2016-206-X	10.00	12.20
H2016-207-X	12.00	14.20
H2016-208-X	14.00	16.20
H2016-209-X	16.00	18.20
H2016-210-X	18.00	20.20
H2016-211-X	20.00	22.20
H2016-212-X	22.00	24.20
H2016-213-X	24.00	26.20
H2016-214-X	26.00	28.20
H2016-215-X	28.00	30.20
H2016-216-X	30.00	32.20
H2016-217-X	32.00	34.20
H2016-218-X	34.00	36.20
H2016-219-X	36.00	38.20
H2016-220-X	38.00	40.20
H2016-221-X	40.00	42.20

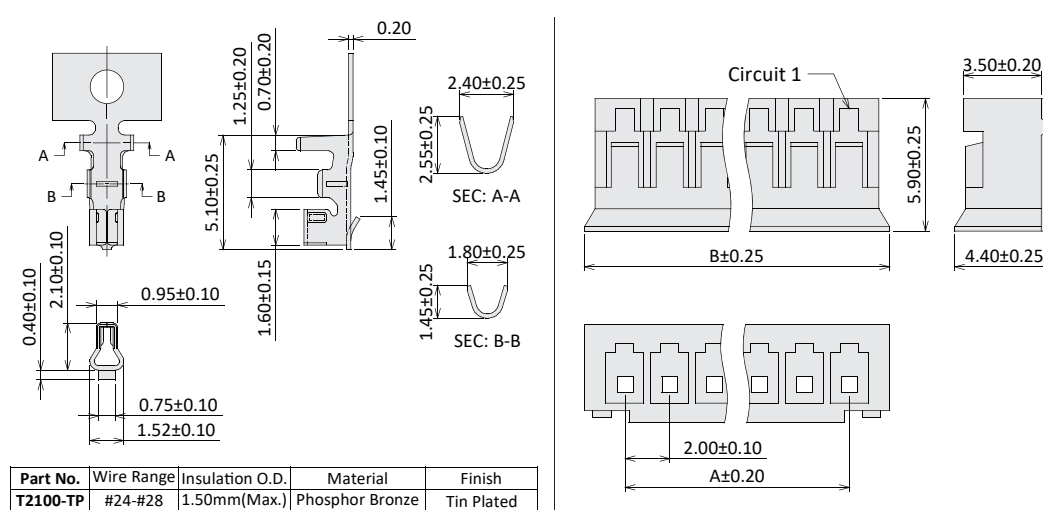
Part No.	Dimensions	
	A	B
H2016-222-X	42.00	44.20
H2016-223-X	44.00	46.20
H2016-224-X	46.00	48.20
H2016-225-X	48.00	50.20
H2016-226-X	50.00	52.20
H2016-227-X	52.00	54.20
H2016-228-X	54.00	56.20
H2016-229-X	56.00	58.20
H2016-230-X	58.00	60.20
H2016-231-X	60.00	62.20
H2016-232-X	62.00	64.20
H2016-233-X	64.00	66.20
H2016-234-X	66.00	68.20
H2016-235-X	68.00	70.20
H2016-236-X	70.00	72.20
H2016-237-X	72.00	74.20
H2016-238-X	74.00	76.20
H2016-239-X	76.00	78.20
H2016-240-X	78.00	80.20

# Wafer Housing Terminal

Current Rate: 3A / 300V AC,DC  
 Dielectric Voltage: 1000V AC for one minute  
 Insulation Resistance: 100MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C

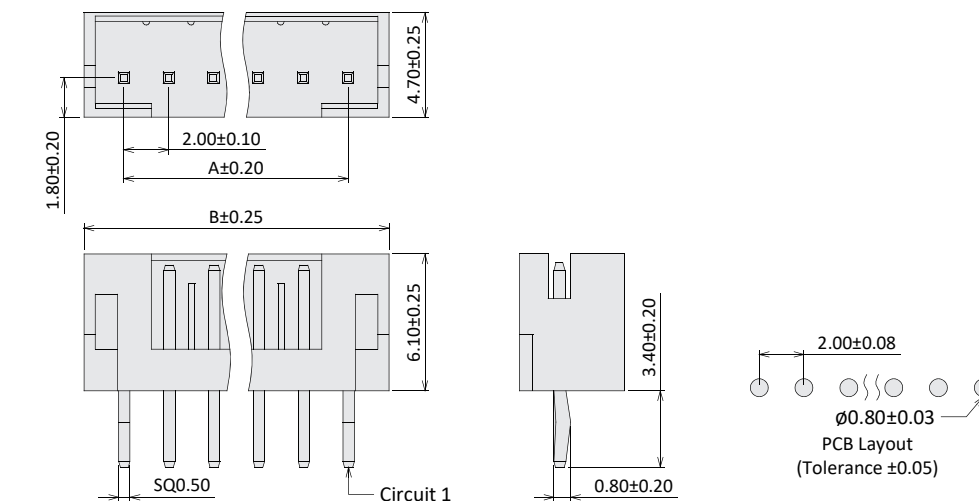


## Terminal Housing Wafer 2100 Series 2.00mm Pitch

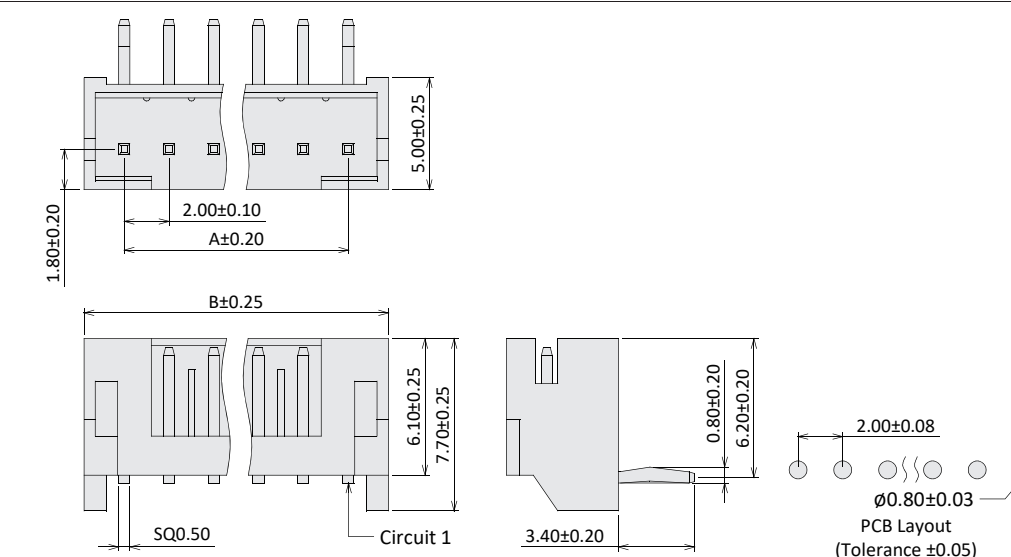


Part No.	Wire Range	Insulation O.D.	Material	Finish
T2100-TP	#24-#28	1.50mm(Max.)	Phosphor Bronze	Tin Plated

Part No.	Dimensions	
	A	B
H2100-02	2.00	5.60
H2100-03	4.00	7.60
H2100-04	6.00	9.60
H2100-05	8.00	11.60
H2100-06	10.00	13.60
H2100-07	12.00	15.60
H2100-08	14.00	17.60
H2100-09	16.00	19.60
H2100-10	18.00	21.60
H2100-11	20.00	23.60
H2100-12	22.00	25.60
H2100-13	24.00	27.60
H2100-14	26.00	29.60
H2100-15	28.00	31.60



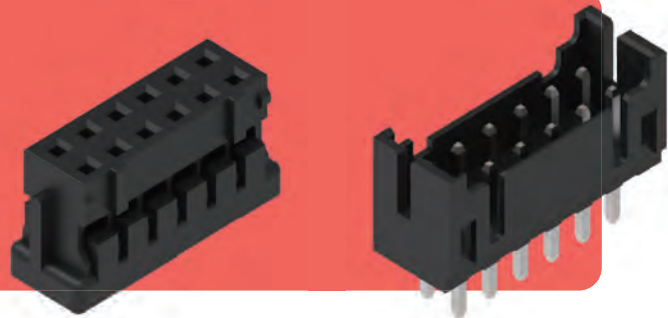
Part No.	Dimensions	
	A	B
W2100L-02	2.00	6.00
W2100L-03	4.00	8.00
W2100L-04	6.00	10.00
W2100L-05	8.00	12.00
W2100L-06	10.00	14.00
W2100L-07	12.00	16.00
W2100L-08	14.00	18.00
W2100L-09	16.00	20.00
W2100L-10	18.00	22.00
W2100L-11	20.00	24.00
W2100L-12	22.00	26.00
W2100L-13	24.00	28.00
W2100L-14	26.00	30.00
W2100L-15	28.00	32.00



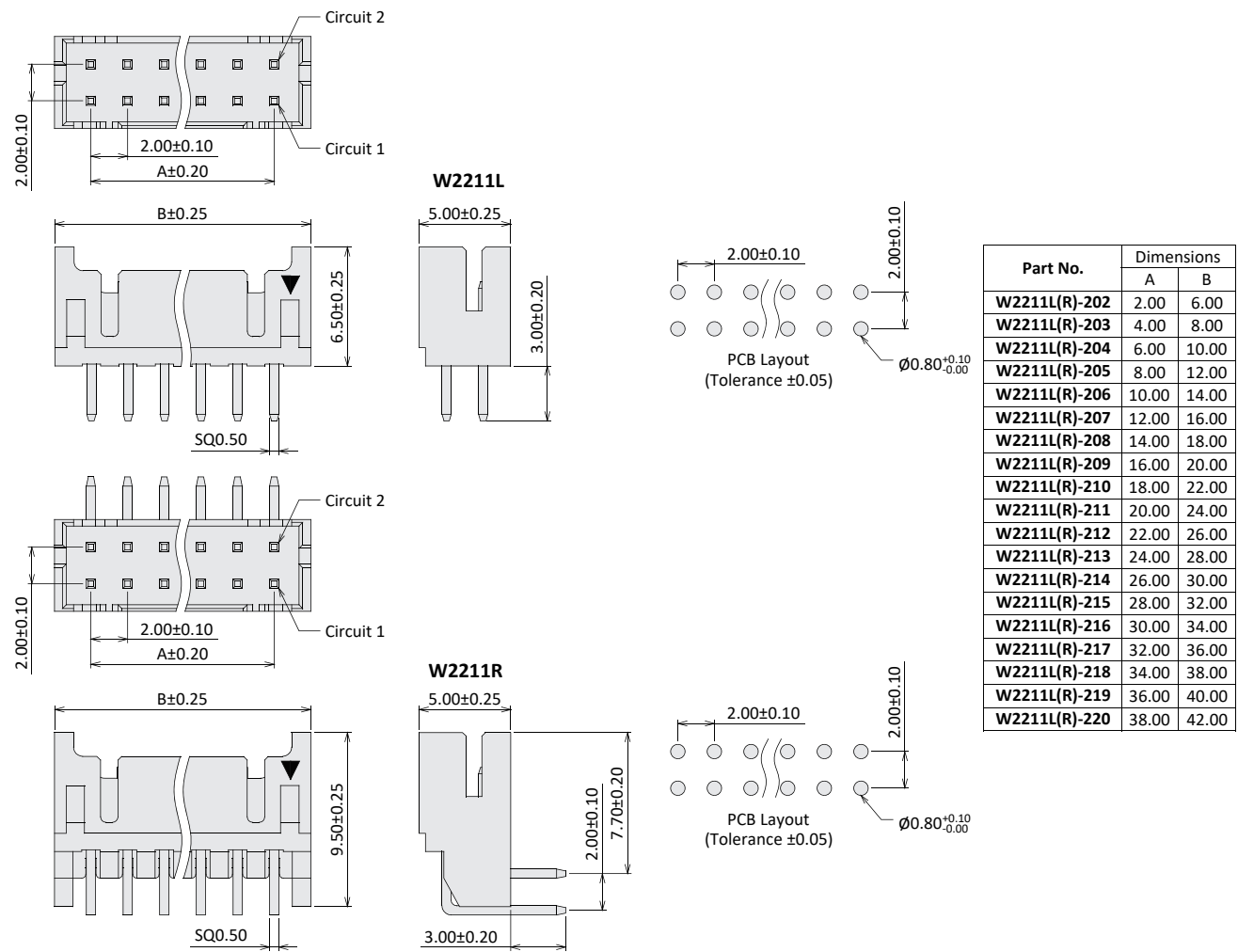
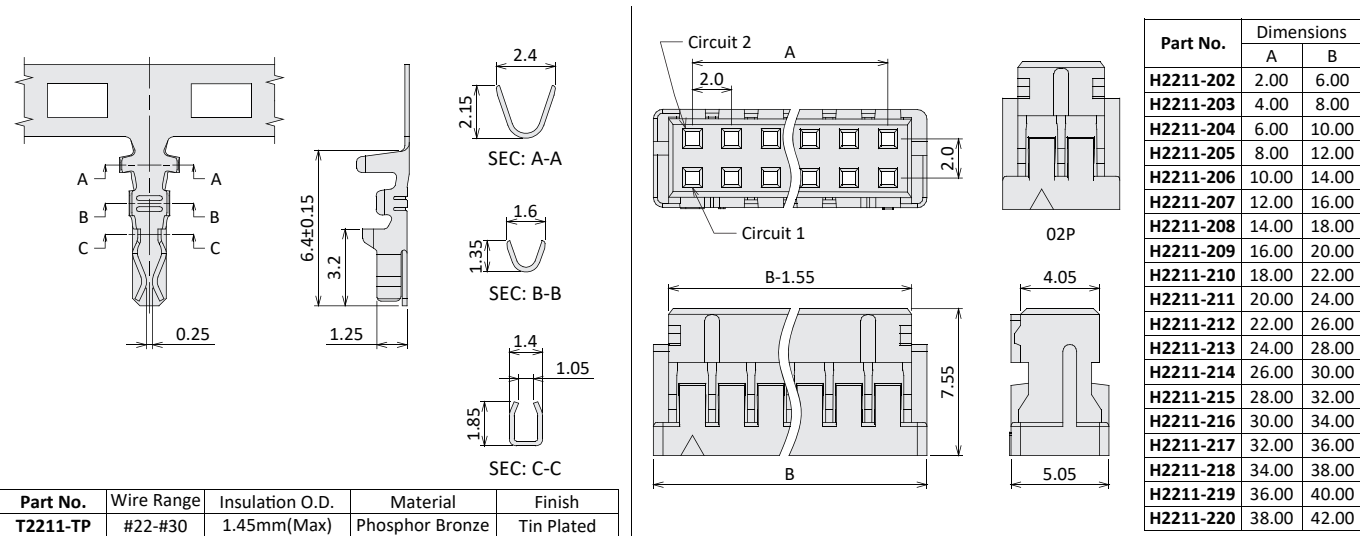
Part No.	Dimensions	
	A	B
W2100R-02	2.00	6.00
W2100R-03	4.00	8.00
W2100R-04	6.00	10.00
W2100R-05	8.00	12.00
W2100R-06	10.00	14.00
W2100R-07	12.00	16.00
W2100R-08	14.00	18.00
W2100R-09	16.00	20.00
W2100R-10	18.00	22.00
W2100R-11	20.00	24.00
W2100R-12	22.00	26.00
W2100R-13	24.00	28.00
W2100R-14	26.00	30.00
W2100R-15	28.00	32.00

# Wafer Housing Terminal

Current Rate: 2A /250V AC,DC  
 Dielectric Voltage: 800V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 30mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C

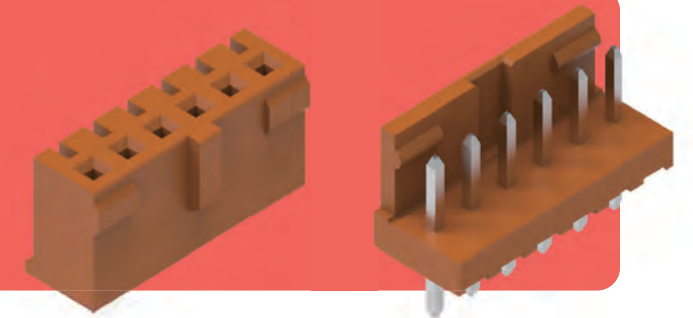


## Terminal Housing Wafer 2211 Series 2.00mm Pitch

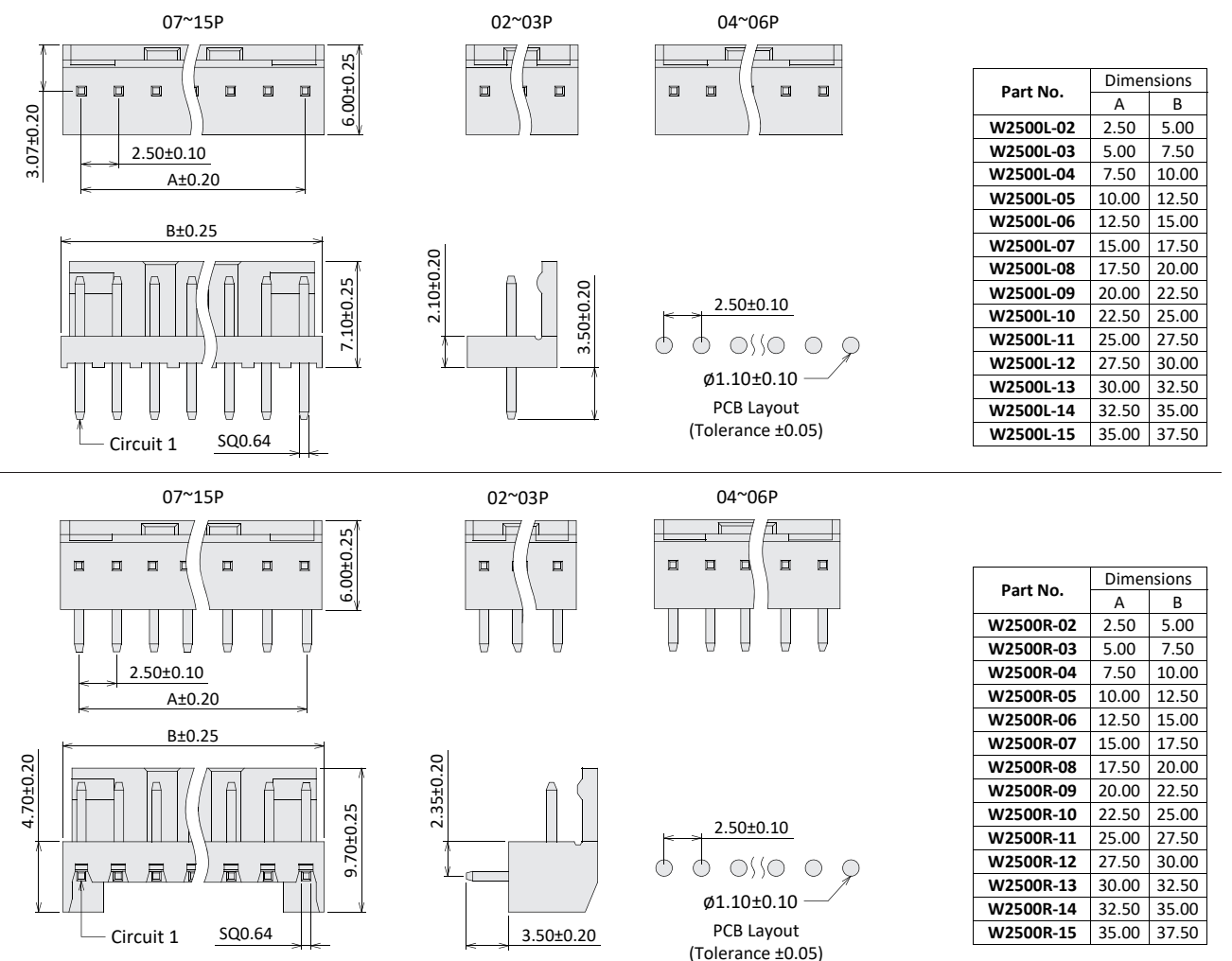
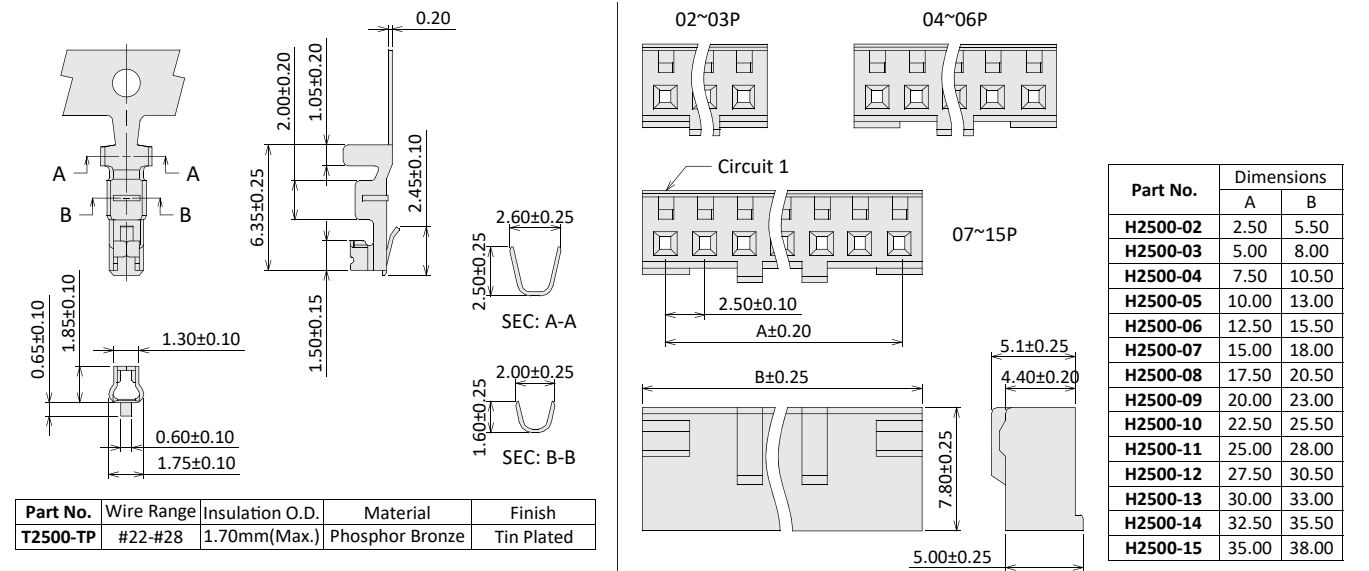


# Wafer Housing Terminal

Current Rate: 3A / 500V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 100MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C

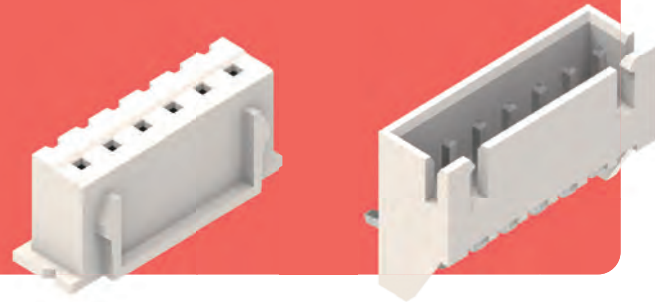


## Terminal Housing Wafer 2500 Series 2.50mm Pitch



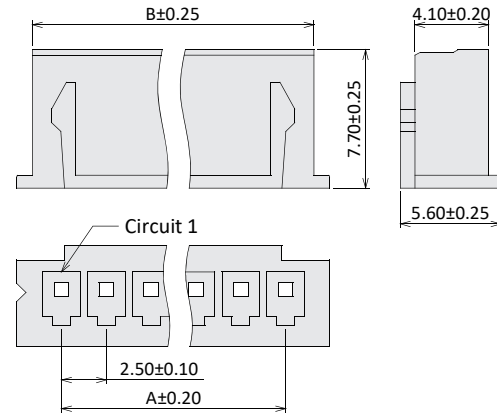
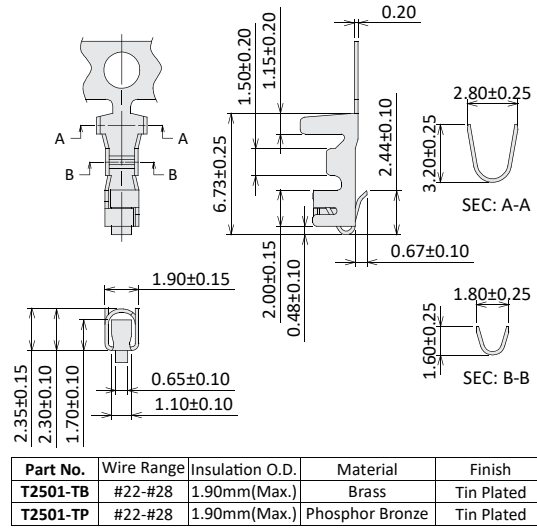
# Wafer Housing Terminal

Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 1000V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C

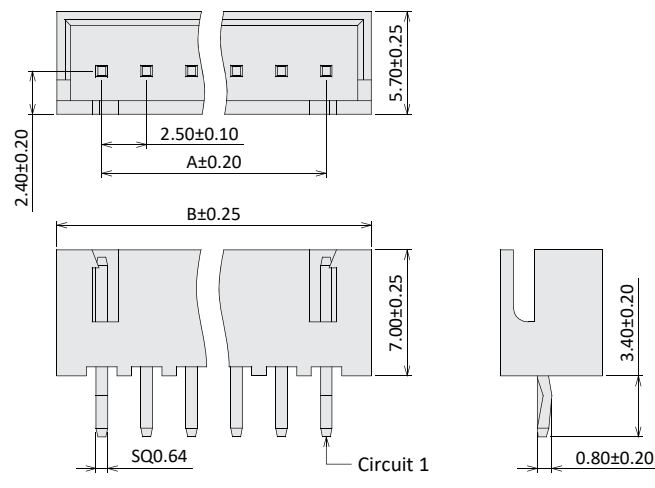


Wafer Housing Terminal

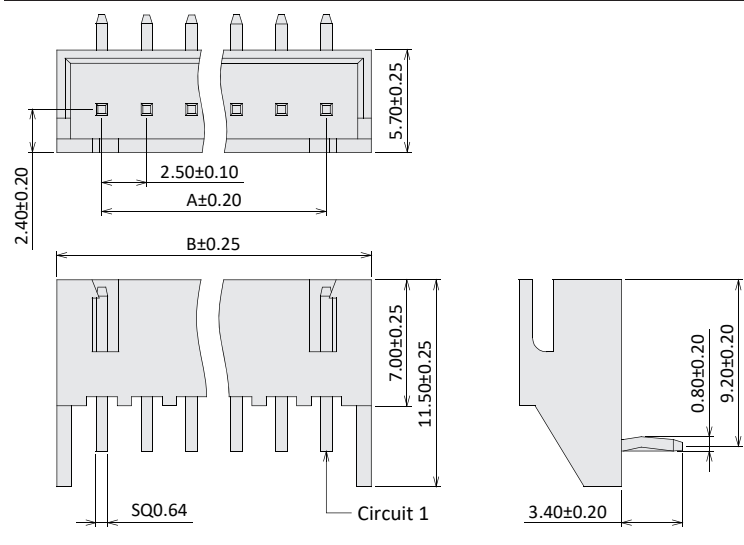
## Terminal Housing Wafer 2501 Series 2.50mm Pitch



Part No.	Dimensions	
	A	B
H2501-02	2.50	5.70
H2501-03	5.00	8.20
H2501-04	7.50	10.70
H2501-05	10.00	13.20
H2501-06	12.50	15.70
H2501-07	15.00	18.20
H2501-08	17.50	20.70
H2501-09	20.00	23.20
H2501-10	22.50	25.70
H2501-11	25.00	28.20
H2501-12	27.50	30.70
H2501-13	30.00	33.20
H2501-14	32.50	35.70
H2501-15	35.00	38.20
H2501-16	37.50	40.70
H2501-17	40.00	43.20
H2501-18	42.50	45.70
H2501-19	45.00	48.20
H2501-20	47.50	50.70



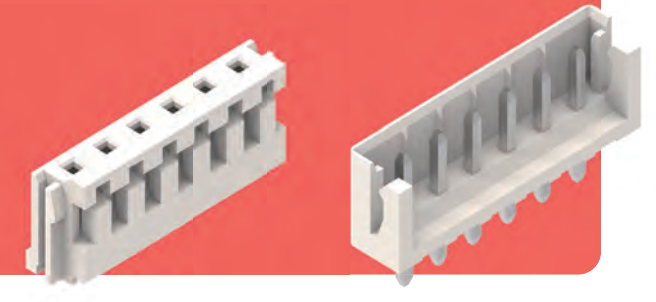
Part No.	Dimensions	
	A	B
W2501L-02	2.50	7.50
W2501L-03	5.00	10.00
W2501L-04	7.50	12.50
W2501L-05	10.00	15.00
W2501L-06	12.50	17.50
W2501L-07	15.00	20.00
W2501L-08	17.50	22.50
W2501L-09	20.00	25.00
W2501L-10	22.50	27.50
W2501L-11	25.00	30.00
W2501L-12	27.50	32.50
W2501L-13	30.00	35.00
W2501L-14	32.50	37.50
W2501L-15	35.00	40.00
W2501L-16	37.50	42.50
W2501L-17	40.00	45.00
W2501L-18	42.50	47.50
W2501L-19	45.00	50.00
W2501L-20	47.50	52.50



Part No.	Dimensions	
	A	B
W2501R-02	2.50	7.50
W2501R-03	5.00	10.00
W2501R-04	7.50	12.50
W2501R-05	10.00	15.00
W2501R-06	12.50	17.50
W2501R-07	15.00	20.00
W2501R-08	17.50	22.50
W2501R-09	20.00	25.00
W2501R-10	22.50	27.50
W2501R-11	25.00	30.00
W2501R-12	27.50	32.50
W2501R-13	30.00	35.00
W2501R-14	32.50	37.50
W2501R-15	35.00	40.00
W2501R-16	37.50	42.50
W2501R-17	40.00	45.00
W2501R-18	42.50	47.50
W2501R-19	45.00	50.00
W2501R-20	47.50	52.50

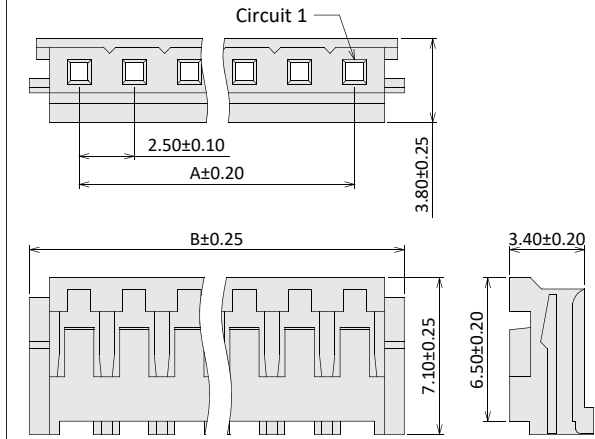
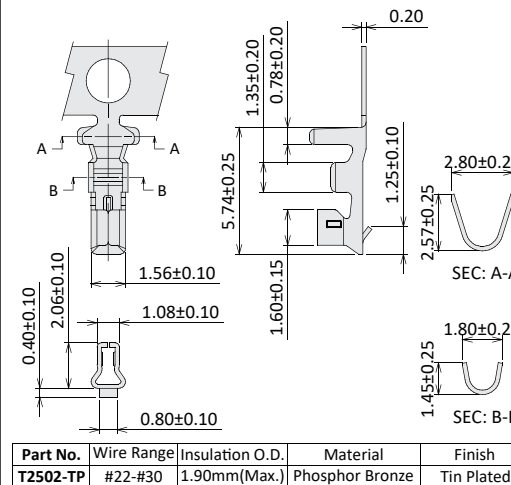
# Wafer Housing Terminal

Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 800V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C

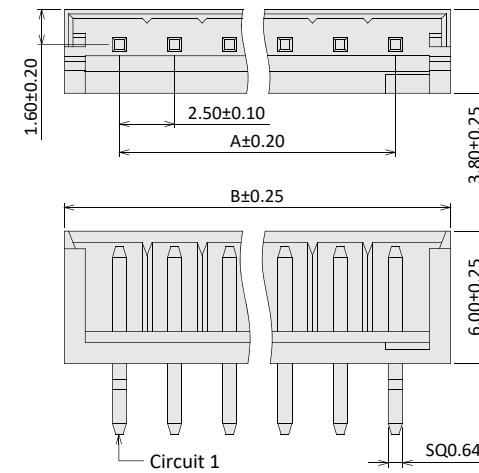


Wafer Housing Terminal

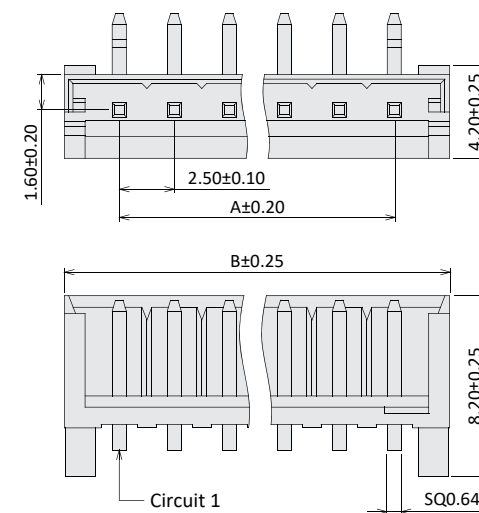
## Terminal Housing Wafer 2502 Series 2.50mm Pitch



Part No.	Dimensions	
	A	B
H2502-02	2.50	7.00
H2502-03	5.00	9.50
H2502-04	7.50	12.00
H2502-05	10.00	14.50
H2502-06	12.50	17.00
H2502-07	15.00	19.50
H2502-08	17.50	22.00
H2502-09	20.00	24.50
H2502-10	22.50	27.00
H2502-11	25.00	29.50
H2502-12	27.50	32.00
H2502-13	30.00	34.50
H2502-14	32.50	37.00
H2502-15	35.00	39.50



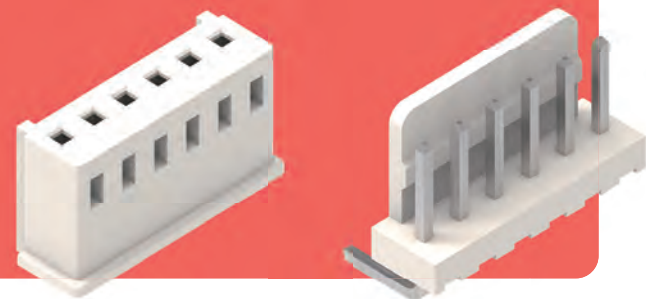
Part No.	Dimensions	
	A	B
W2502L-02	2.50	7.50
W2502L-03	5.00	10.00
W2502L-04	7.50	12.50
W2502L-05	10.00	15.00
W2502L-06	12.50	17.50
W2502L-07	15.00	20.00
W2502L-08	17.50	22.50
W2502L-09	20.00	25.00
W2502L-10	22.50	27.50
W2502L-11	25.00	30.00
W2502L-12	27.50	32.50
W2502L-13	30.00	35.00
W2502L-14	32.50	37.50
W2502L-15	35.00	40.00



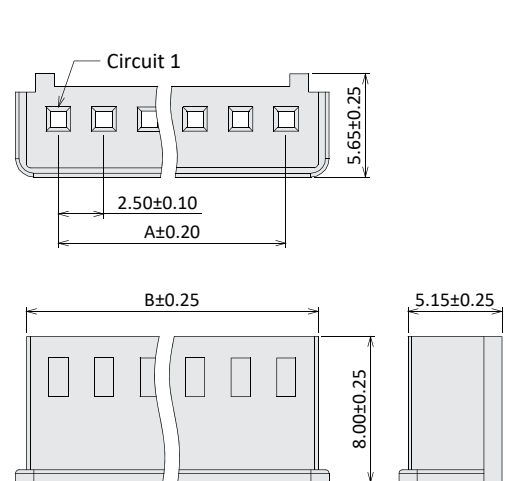
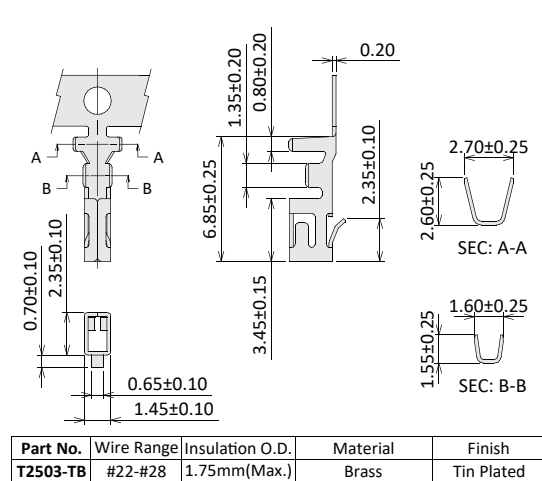
Part No.	Dimensions	
	A	B
W2502R-02	2.50	7.50
W2502R-03	5.00	10.00
W2502R-04	7.50	12.50
W2502R-05	10.00	15.00
W2502R-06	12.50	17.50
W2502R-07	15.00	20.00
W2502R-08	17.50	22.50
W2502R-09	20.00	25.00
W2502R-10	22.50	27.50
W2502R-11	25.00	30.00
W2502R-12	27.50	32.50
W2502R-13	30.00	35.00
W2502R-14	32.50	37.50
W2502R-15	35.00	40.00

# Wafer Housing Terminal

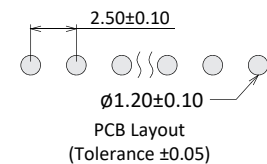
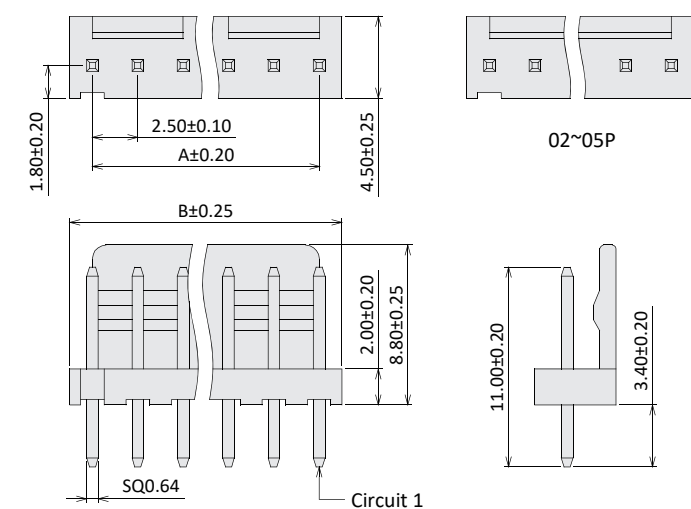
Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 800V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -25°C~+85°C



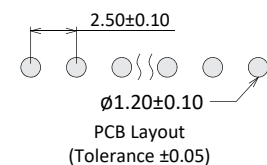
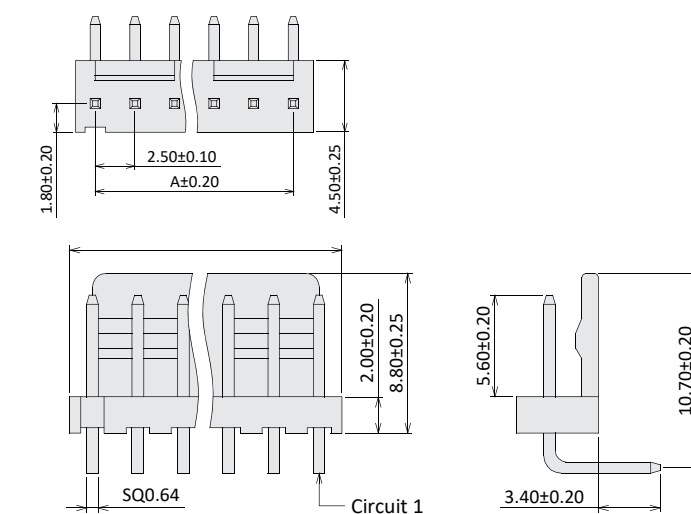
## Terminal Housing Wafer 2503 Series 2.50mm Pitch



Part No.	Dimensions	
	A	B
H2503-02	2.50	6.00
H2503-03	5.00	8.50
H2503-04	7.50	11.00
H2503-05	10.00	13.50
H2503-06	12.50	16.00
H2503-07	15.00	18.50
H2503-08	17.50	21.00
H2503-09	20.00	23.50
H2503-10	22.50	26.00
H2503-11	25.00	28.50
H2503-12	27.50	31.00
H2503-13	30.00	33.50
H2503-14	32.50	36.00
H2503-15	35.00	38.50
H2503-16	37.50	41.00
H2503-17	40.00	43.50
H2503-18	42.50	46.00
H2503-19	45.00	48.50
H2503-20	47.50	51.00



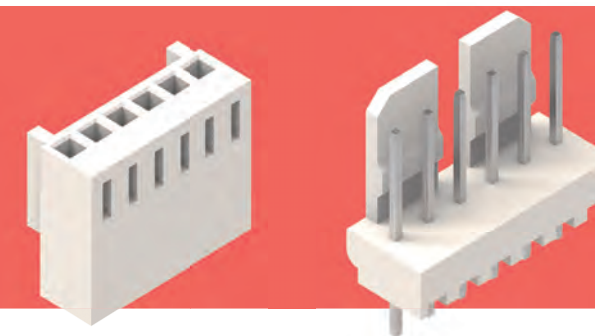
Part No.	Dimensions	
	A	B
W2503L-02	2.50	5.00
W2503L-03	5.00	7.50
W2503L-04	7.50	10.00
W2503L-05	10.00	12.50
W2503L-06	12.50	15.00
W2503L-07	15.00	17.50
W2503L-08	17.50	20.00
W2503L-09	20.00	22.50
W2503L-10	22.50	25.00
W2503L-11	25.00	27.50
W2503L-12	27.50	30.00
W2503L-13	30.00	32.50
W2503L-14	32.50	35.00
W2503L-15	35.00	37.50
W2503L-16	37.50	40.00
W2503L-17	40.00	42.50
W2503L-18	42.50	45.00
W2503L-19	45.00	47.50
W2503L-20	47.50	50.00



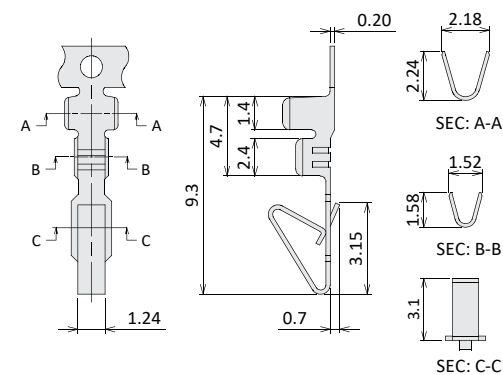
Part No.	Dimensions	
	A	B
W2503R-02	2.50	5.00
W2503R-03	5.00	7.50
W2503R-04	7.50	10.00
W2503R-05	10.00	12.50
W2503R-06	12.50	15.00
W2503R-07	15.00	17.50
W2503R-08	17.50	20.00
W2503R-09	20.00	22.50
W2503R-10	22.50	25.00
W2503R-11	25.00	27.50
W2503R-12	27.50	30.00
W2503R-13	30.00	32.50
W2503R-14	32.50	35.00
W2503R-15	35.00	37.50
W2503R-16	37.50	40.00
W2503R-17	40.00	42.50
W2503R-18	42.50	45.00
W2503R-19	45.00	47.50
W2503R-20	47.50	50.00

# Wafer Housing Terminal

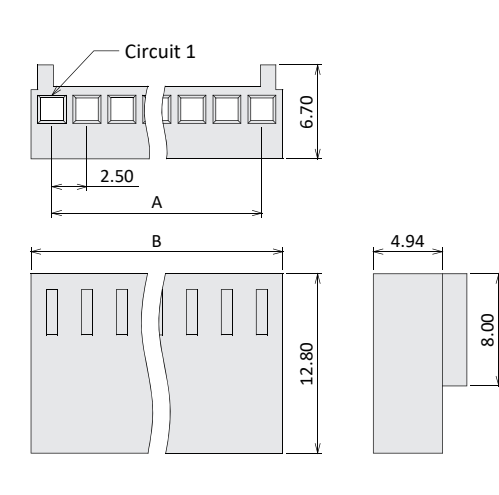
Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -40°C~+105°C



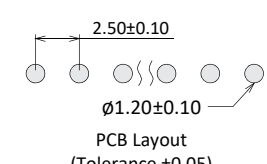
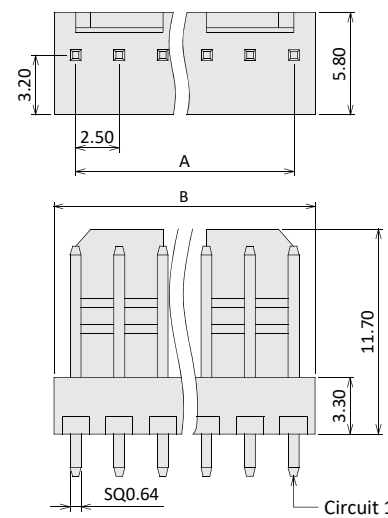
## Terminal Housing Wafer 2504 Series 2.50mm Pitch



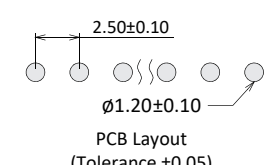
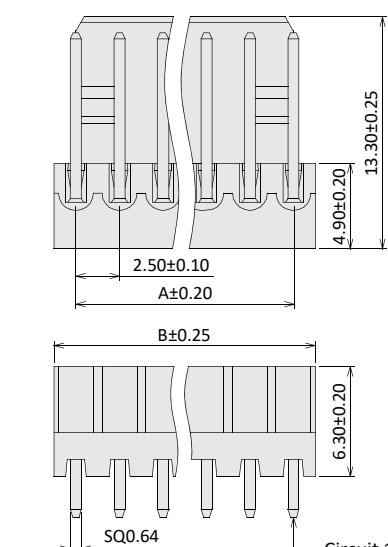
Part No.	Wire Range	Material	Finish
T2504-TP	#22-#28	Phosphor Bronze	Tin Plated
T2504-GP	#22-#28	Phosphor Bronze	Gold Plated
T2504-TB	#22-#28	Brass	Tin Plated
T2504-GB	#22-#28	Brass	Gold Plated



Part No.	Dimensions	
	A	B
H2504-02	2.50	5.50
H2504-03	5.00	8.00
H2504-04	7.50	10.50
H2504-05	10.00	13.00
H2504-06	12.50	15.50
H2504-07	15.00	18.00
H2504-08	17.50	20.50
H2504-09	20.00	23.00
H2504-10	22.50	25.50
H2504-11	25.00	28.00
H2504-12	27.50	30.50
H2504-13	30.00	33.00
H2504-14	32.50	35.50
H2504-15	35.00	38.00
H2504-16	37.50	40.50
H2504-17	40.00	43.00
H2504-18	42.50	45.50
H2504-19	45.00	48.00
H2504-20	47.50	50.50



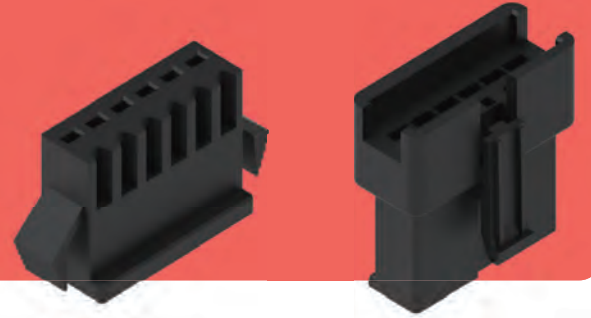
Part No.	Dimensions	
	A	B
W2504L-02	2.50	5.00
W2504L-03	5.00	7.50
W2504L-04	7.50	10.00
W2504L-05	10.00	12.50
W2504L-06	12.50	15.00
W2504L-07	15.00	17.50
W2504L-08	17.50	20.00
W2504L-09	20.00	22.50
W2504L-10	22.50	25.00
W2504L-11	25.00	27.50
W2504L-12	27.50	30.00
W2504L-13	30.00	32.50
W2504L-14	32.50	35.00
W2504L-15	35.00	37.50
W2504L-16	37.50	40.00
W2504L-17	40.00	42.50
W2504L-18	42.50	45.00
W2504L-19	45.00	47.50
W2504L-20	47.50	50.00



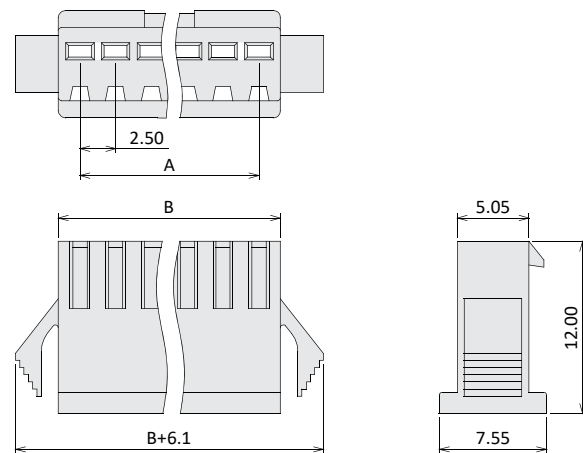
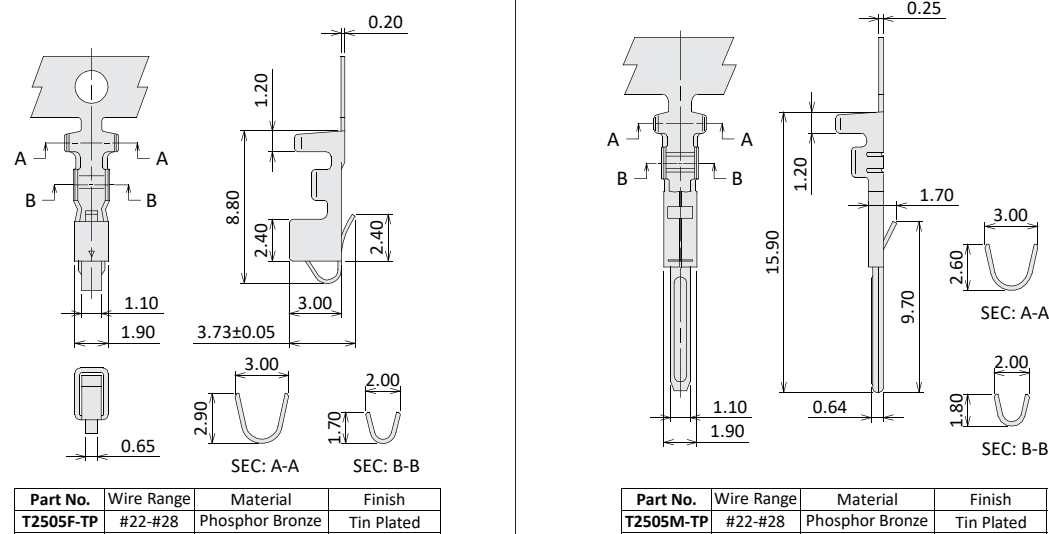
Part No.	Dimensions	
	A	B
W2504R-02	2.50	5.00
W2504R-03	5.00	7.50
W2504R-04	7.50	10.00
W2504R-05	10.00	12.50
W2504R-06	12.50	15.00
W2504R-07	15.00	17.50
W2504R-08	17.50	20.00
W2504R-09	20.00	22.50
W2504R-10	22.50	25.00
W2504R-11	25.00	27.50
W2504R-12	27.50	30.00
W2504R-13	30.00	32.50
W2504R-14	32.50	35.00
W2504R-15	35.00	37.50
W2504R-16	37.50	40.00
W2504R-17	40.00	42.50
W2504R-18	42.50	45.00
W2504R-19	45.00	47.50
W2504R-20	47.50	50.00

# Wafer Housing Terminal

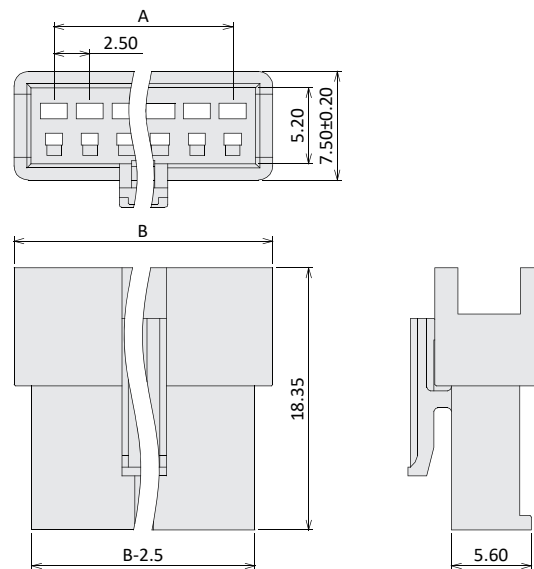
Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 500MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C



## Terminal Housing 2505 Series 2.50mm Pitch



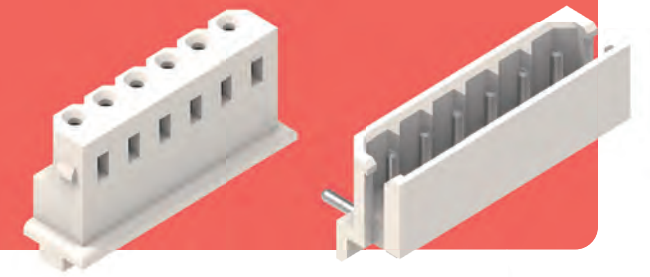
Part No.	Dimensions	
	A	B
H2505F-02	2.50	5.50
H2505F-03	5.00	8.00
H2505F-04	7.50	10.50
H2505F-05	10.00	13.00
H2505F-06	12.50	15.50
H2505F-07	15.00	18.00
H2505F-08	17.50	20.50
H2505F-09	20.00	23.00
H2505F-10	22.50	25.50
H2505F-11	25.00	28.00
H2505F-12	27.50	30.50
H2505F-13	30.00	33.00
H2505F-14	32.50	35.50
H2505F-15	35.00	38.00
H2505F-16	37.50	40.50



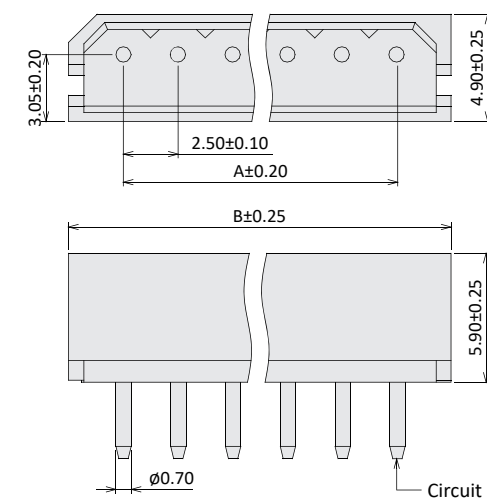
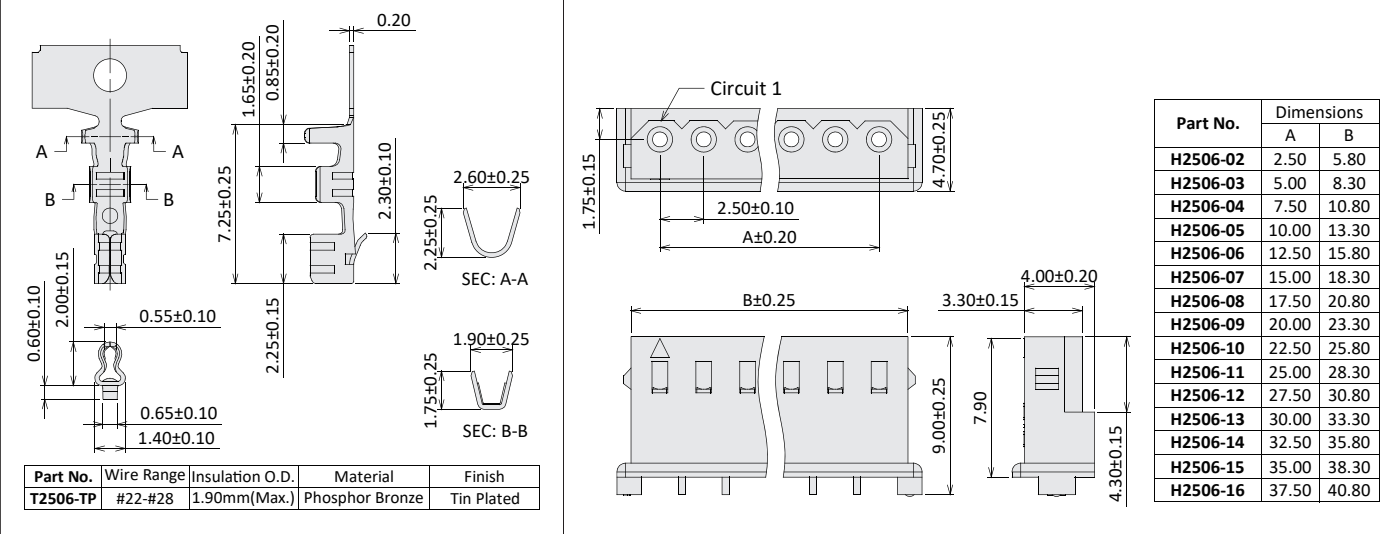
Part No.	Dimensions	
	A	B
H2505M-02	2.50	8.10
H2505M-03	5.00	10.60
H2505M-04	7.50	13.10
H2505M-05	10.00	15.60
H2505M-06	12.50	18.10
H2505M-07	15.00	20.60
H2505M-08	17.50	23.10
H2505M-09	20.00	25.60
H2505M-10	22.50	28.10
H2505M-11	25.00	30.60
H2505M-12	27.50	33.10
H2505M-13	30.00	35.60
H2505M-14	32.50	38.10
H2505M-15	35.00	40.60
H2505M-16	37.50	43.10

# Wafer Housing Terminal

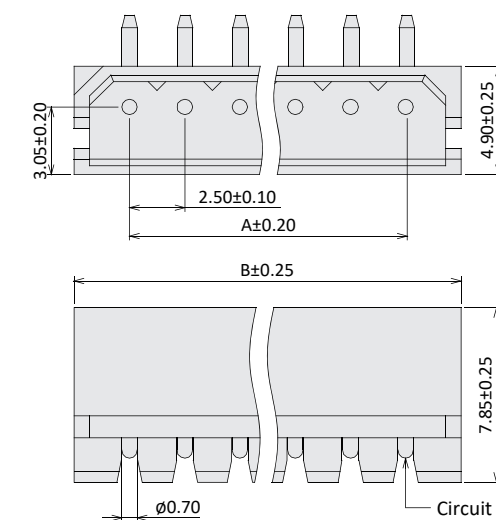
Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 1000V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C



## Terminal Housing Wafer 2506 Series 2.50mm Pitch



Part No.	Dimensions	
	A	B
W2506L-02	2.50	7.50
W2506L-03	5.00	10.00
W2506L-04	7.50	12.50
W2506L-05	10.00	15.00
W2506L-06	12.50	17.50
W2506L-07	15.00	20.00
W2506L-08	17.50	22.50
W2506L-09	20.00	25.00
W2506L-10	22.50	27.50
W2506L-11	25.00	30.00
W2506L-12	27.50	32.50
W2506L-13	30.00	35.00
W2506L-14	32.50	37.50
W2506L-15	35.00	40.00
W2506L-16	37.50	42.50

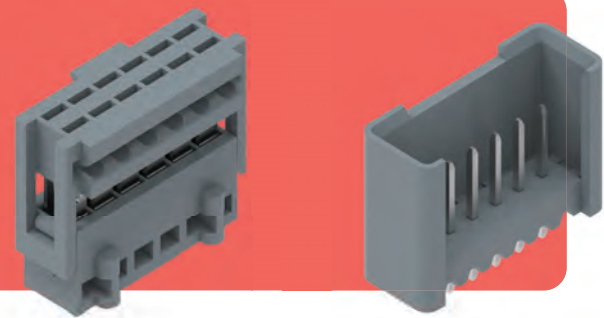


Part No.	Dimensions	
	A	B
W2506R-02	2.50	7.50
W2506R-03	5.00	10.00
W2506R-04	7.50	12.50
W2506R-05	10.00	15.00
W2506R-06	12.50	17.50
W2506R-07	15.00	20.00
W2506R-08	17.50	22.50
W2506R-09	20.00	25.00
W2506R-10	22.50	27.50
W2506R-11	25.00	30.00
W2506R-12	27.50	32.50
W2506R-13	30.00	35.00
W2506R-14	32.50	37.50
W2506R-15	35.00	40.00
W2506R-16	37.50	42.50

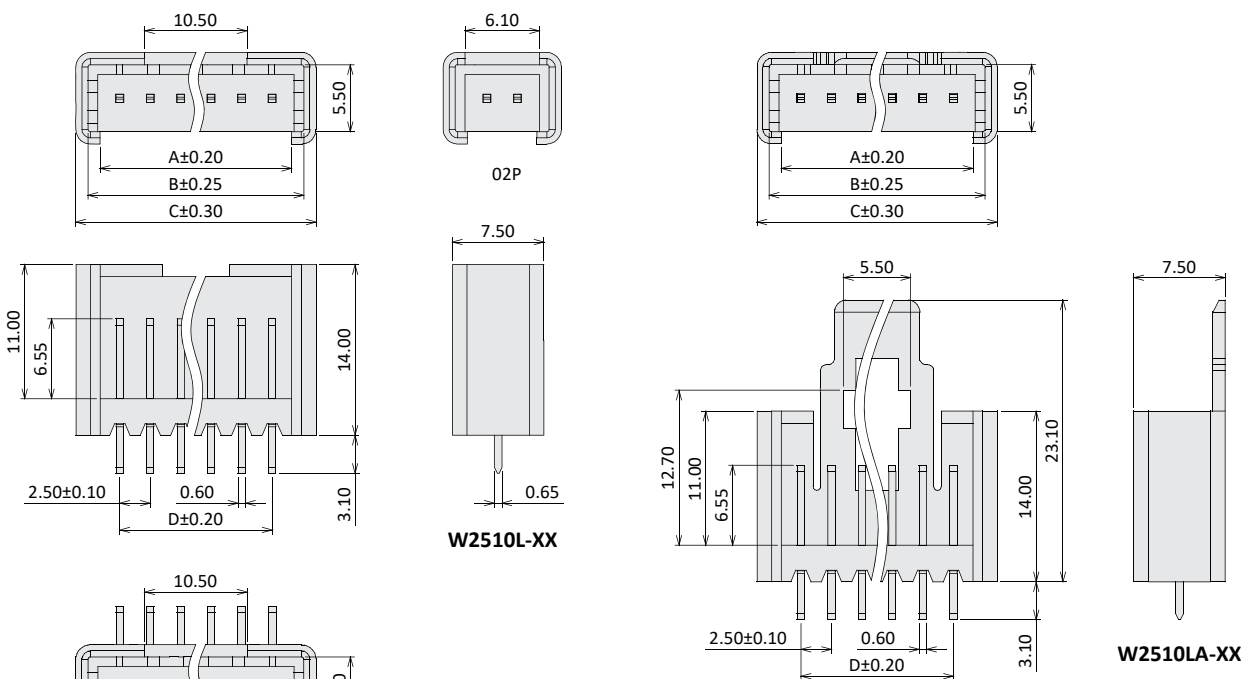
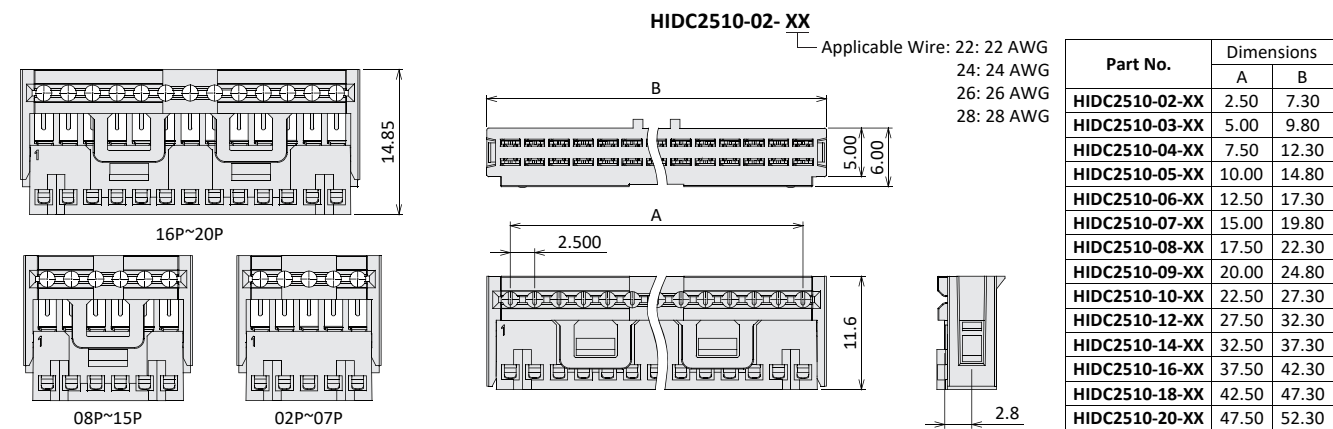


# Wafer Housing Terminal

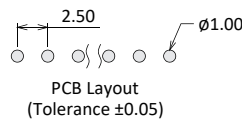
Current Rate: 5A / 125V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: PBT, UL94V-0  
 Operating Temperature: -40°C~+105°C



## IDC Type Housing Wafer 2510 Series 2.50mm Pitch



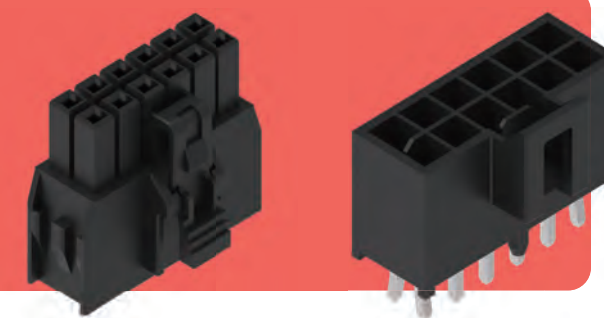
Part No.	Dimensions			
	A	B	C	D
W2510(LA/RA)-02	5.70	7.70	9.70	2.50
W2510(LA/RA)-03	8.20	10.20	12.20	5.00
W2510(LA/RA)-04	10.70	12.70	14.70	7.50
W2510(LA/RA)-05	13.20	15.20	17.20	10.00
W2510(LA/RA)-06	15.70	17.70	19.70	12.50
W2510(LA/RA)-07	18.20	20.20	22.20	15.00
W2510(LA/RA)-08	20.70	22.70	24.70	17.50
W2510(LA/RA)-09	23.20	25.20	27.20	20.00
W2510(LA/RA)-10	25.70	27.70	29.70	22.50
W2510(LA/RA)-12	30.70	32.70	34.70	27.50
W2510(LA/RA)-14	35.70	37.70	39.70	32.50
W2510(LA/RA)-16	40.70	42.70	44.70	37.50
W2510(LA/RA)-18	45.70	47.70	49.70	42.50
W2510(LA/RA)-20	50.70	52.70	54.70	47.50



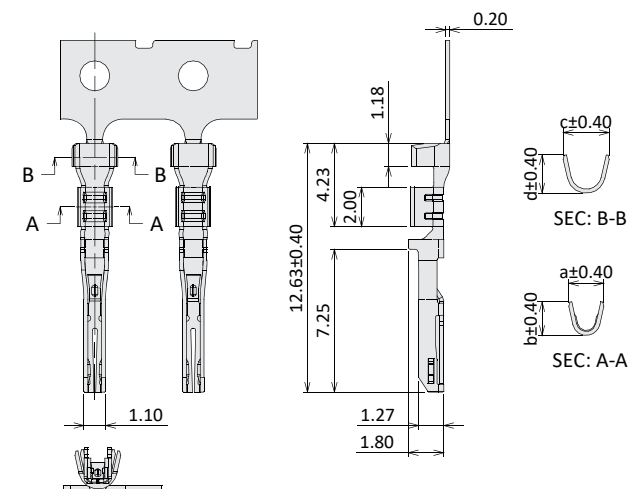
W2510RA-XX

# Wafer Housing Terminal

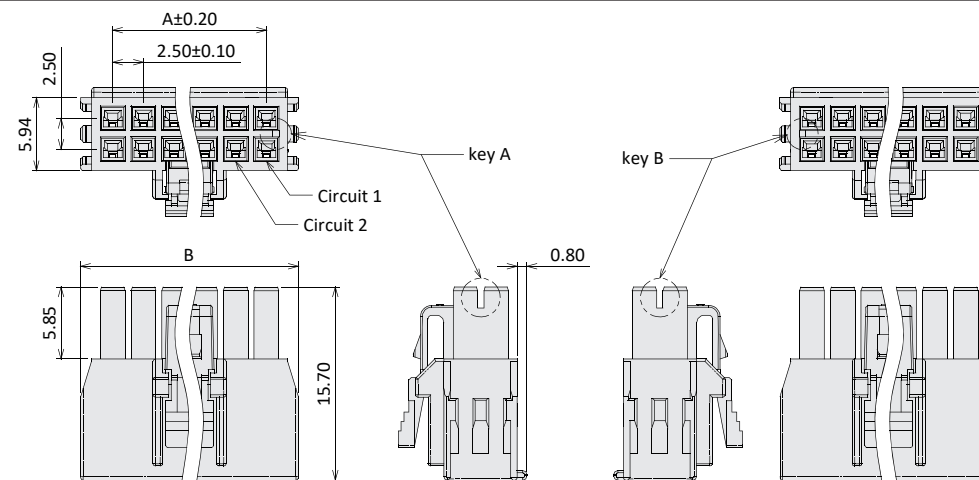
Current Rate: 4A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: NY4T or LCP, UL94V-0  
 Operating Temperature: -40°C~+105°C



## Terminal Housing Wafer 2511 Series 2.50mm Pitch



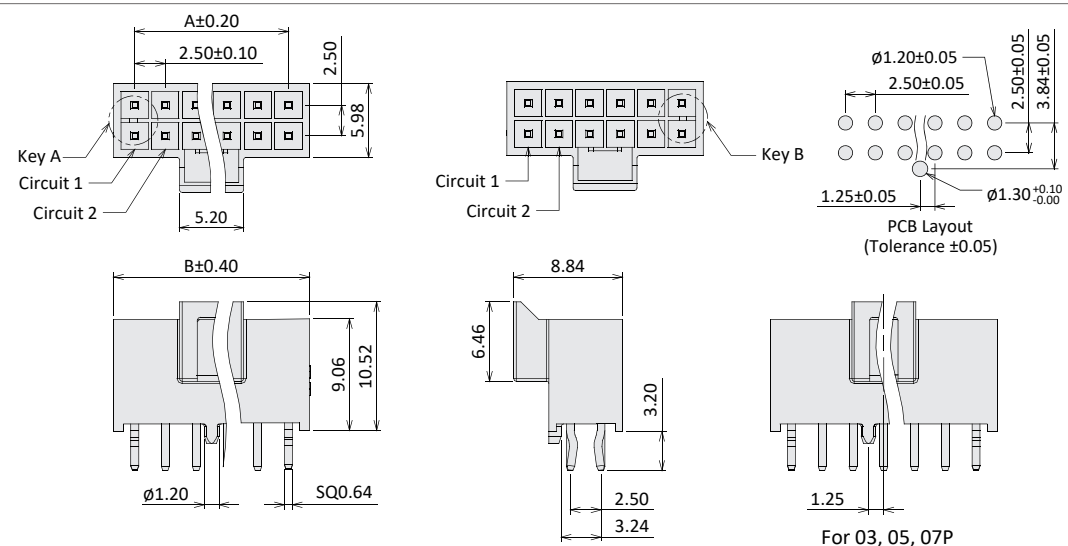
Part No.	Wire Range	Insulation O.D.	Material	Finish	Dim. a	Dim. b	Dim. c	Dim. d
T2511-TP	#24-#26	0.80mm(Max.)	Copper Alloy	Tin Plated	1.39	1.45	2.12	2.00
T2511-TPA	#24-#26	0.80mm(Max.)	Copper Alloy	Tin Plated	1.78	1.71	2.33	1.94



**H2511F - 2 XX X**

No. of Contacts  
 1: Key A  
 2: Key B

Part No.	Dimensions	
	A	B
H2511F-202X	2.50	7.70
H2511F-203X	5.00	10.20
H2511F-204X	7.50	12.70
H2511F-205X	10.00	15.20
H2511F-206X	12.50	17.70
H2511F-207X	15.00	20.20
H2511F-208X	17.50	22.70



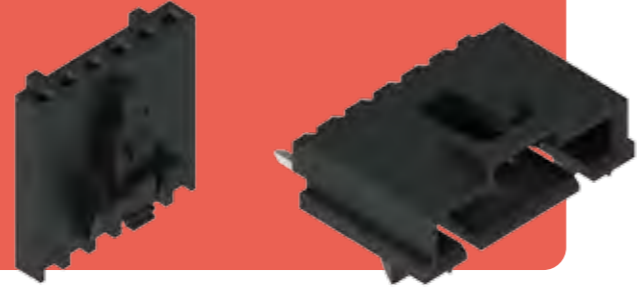
**W2511L - 2 XX X**

No. of Contacts  
 1: Key A  
 2: Key B

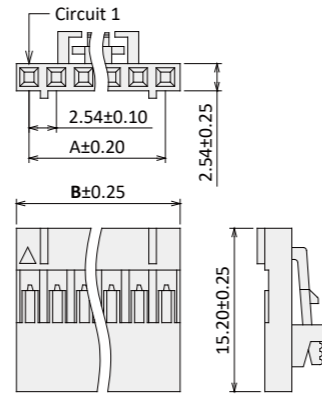
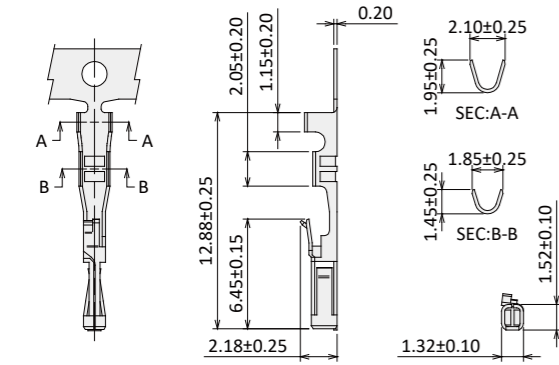
Part No.	Dimensions	
	A	B
W2511L-202X	2.50	5.94
W2511L-203X	5.00	8.44
W2511L-204X	7.50	10.94
W2511L-205X	10.00	13.44
W2511L-206X	12.50	15.94
W2511L-207X	15.00	18.44
W2511L-208X	17.50	20.94

# Wafer Housing Terminal

Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Gold Plated  
 Material Insulator: PBT or NY6T, UL94V-0  
 Operating Temperature: -25°C~+85°C

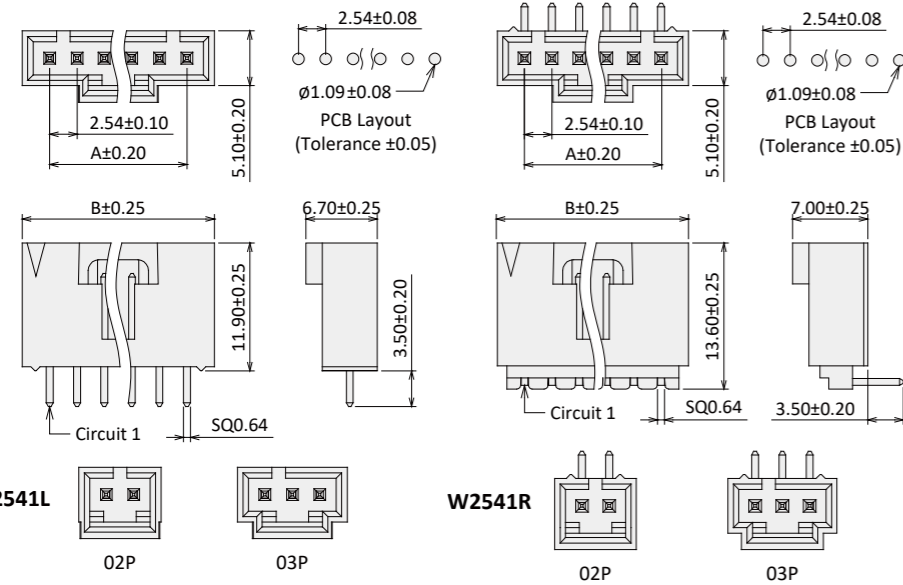


## Terminal Housing Wafer 2541 Series 2.54mm Pitch

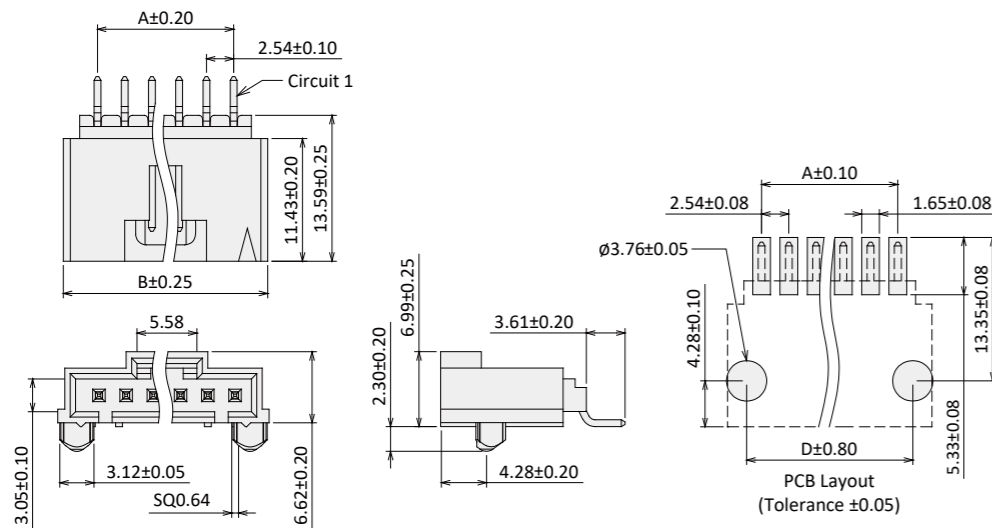


Part No.	Dimensions	
	A	B
H2541-02	2.54	5.08
H2541-03	5.08	7.62
H2541-04	7.62	10.16
H2541-05	10.16	12.70
H2541-06	12.70	15.24
H2541-07	15.24	17.78
H2541-08	17.78	20.32
H2541-09	20.32	22.86
H2541-10	22.86	25.40
H2541-11	25.40	27.94
H2541-12	27.94	30.48

Part No.	Wire Range	Insulation O.D.	Material	Finish
T2541F-TP	#22-#26	1.63mm(Max.)	Phosphor Bronze	Tin Plated



Part No.	Dimensions		
	A	B	B
W2541L(R)-02	2.54	7.63	7.59
W2541L(R)-03	5.08	10.17	10.13
W2541L(R)-04	7.62	12.71	12.67
W2541L(R)-05	10.16	15.25	15.21
W2541L(R)-06	12.70	17.79	17.75
W2541L(R)-07	15.24	20.33	20.29
W2541L(R)-08	17.78	22.87	22.83
W2541L(R)-09	20.32	25.41	25.37
W2541L(R)-10	22.86	27.95	27.91
W2541L(R)-11	25.40	30.49	30.45
W2541L(R)-12	27.94	33.03	32.99



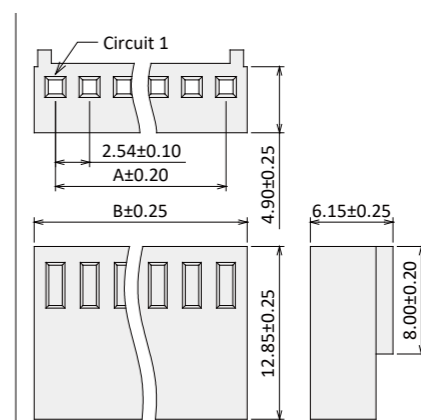
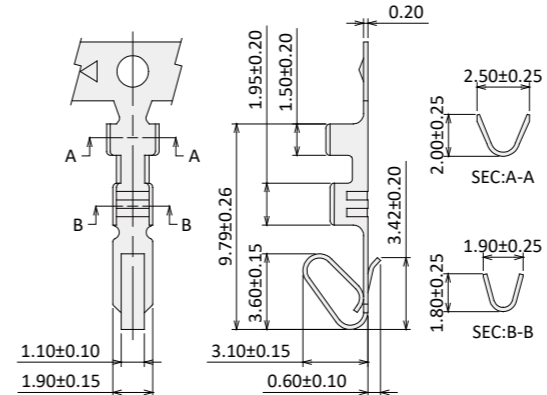
Part No.	Dimensions	
	A	B
W2541MR-02	2.54	8.89
W2541MR-03	5.08	11.43
W2541MR-04	7.62	13.97
W2541MR-05	10.16	16.51
W2541MR-06	12.70	19.05
W2541MR-07	15.24	21.59
W2541MR-08	17.78	24.13
W2541MR-09	20.32	26.67
W2541MR-10	22.86	29.21
W2541MR-11	25.40	31.75
W2541MR-12	27.94	34.29

# Wafer Housing Terminal

Current Rate: 4A / 250V AC,DC  
 Dielectric Voltage: 1000V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -25°C~+85°C

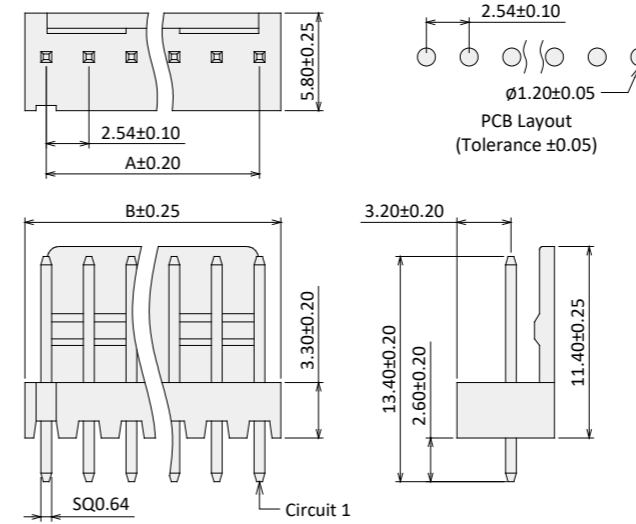


## Terminal Housing Wafer 2542 Series 2.54mm Pitch



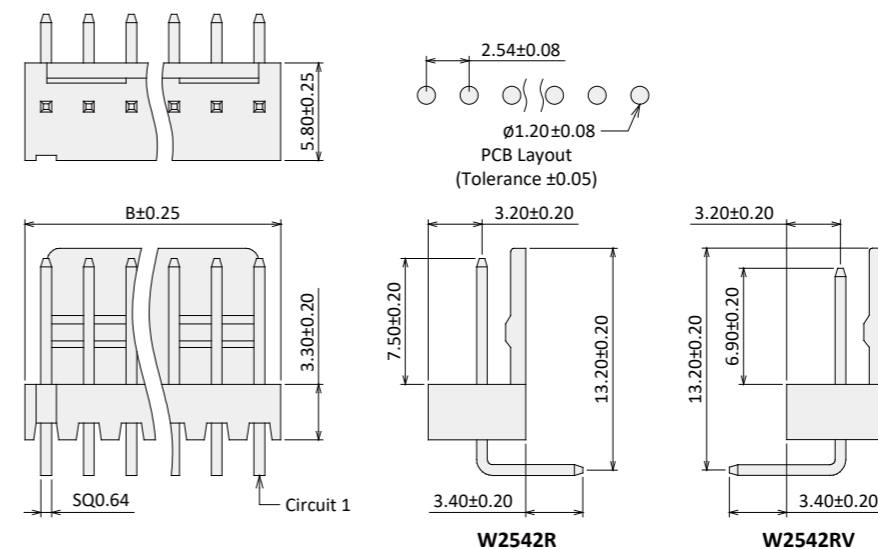
Part No.	Wire Range	Insulation O.D.	Material	Finish
T2542-TB	#24-#30	1.57mm(Max.)	Brass	Tin Plated
T2542-GB	#24-#30	1.57mm(Max.)	Brass	Gold Plated
T2542-TP	#24-#30	1.57mm(Max.)	Phosphor Bronze	Tin Plated

Part No.	Dimensions	
	A	B
H2542-02	2.54	5.68
H2542-03	5.08	8.22
H2542-04	7.62	10.76
H2542-05	10.16	13.30
H2542-06	12.70	15.84
H2542-07	15.24	18.38
H2542-08	17.78	20.92
H2542-09	20.32	23.46
H2542-10	22.86	26.00
H2542-11	25.40	28.54
H2542-12	27.94	31.08
H2542-13	30.48	33.62
H2542-14	33.02	36.16
H2542-15	35.56	38.70
H2542-16	38.10	41.24
H2542-17	40.64	43.78
H2542-18	43.18	46.32
H2542-19	45.72	48.86
H2542-20	48.26	51.40



Part No.	Dimensions	
	A	B
W2542L-02	2.54	5.08
W2542L-03	5.08	7.62
W2542L-04	7.62	10.16
W2542L-05	10.16	12.70
W2542L-06	12.70	15.24
W2542L-07	15.24	17.78
W2542L-08	17.78	20.32
W2542L-09	20.32	22.86
W2542L-10	22.86	25.40
W2542L-11	25.40	27.94

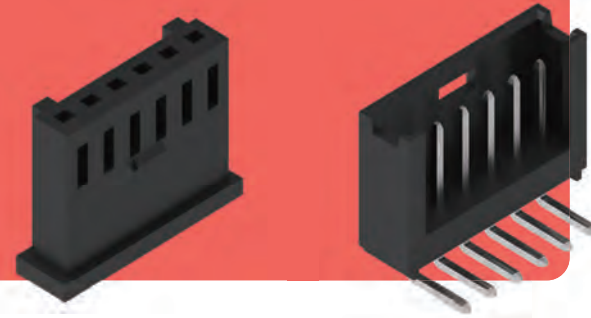
Part No.	Dimensions	
	A	B
W2542L-12	27.94	30.48
W2542L-13	30.48	33.02
W2542L-14	33.02	35.56
W2542L-15	35.56	38.10
W2542L-16	38.10	40.64
W2542L-17	40.64	43.18
W2542L-18	43.18	45.72
W2542L-19	45.72	48.26
W2542L-20	48.26	50.80



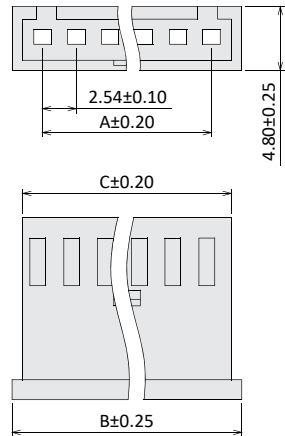
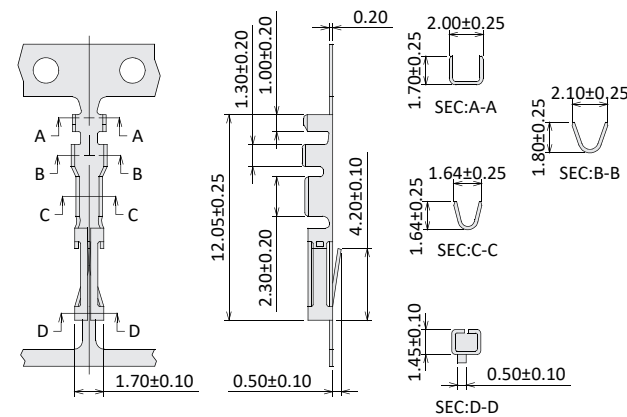
Part No.	Dimensions	
	A	B
W2542R(RV)-02	2.54	5.08
W2542R(RV)-03	5.08	7.62
W2542R(RV)-04	7.62	10.16
W2542R(RV)-05	10.16	12.70
W2542R(RV)-06	12.70	15.24
W2542R(RV)-07	15.24	17.78
W2542R(RV)-08	17.78	20.32
W2542R(RV)-09	20.32	22.86
W2542R(RV)-10	22.86	25.40
W2542R(RV)-11	25.40	27.94
W2542R(RV)-12	27.94	30.48
W2542R(RV)-13	30.48	33.02
W2542R(RV)-14	33.02	35.56
W2542R(RV)-15	35.56	38.10
W2542R(RV)-16	38.10	40.64
W2542R(RV)-17	40.64	43.18
W2542R(RV)-18	43.18	45.72
W2542R(RV)-19	45.72	48.26
W2542R(RV)-20	48.26	50.80

# Wafer Housing Terminal

Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 1000V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: PBT, UL94V-0  
 Operating Temperature: -25°C~+85°C

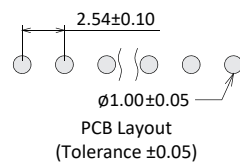
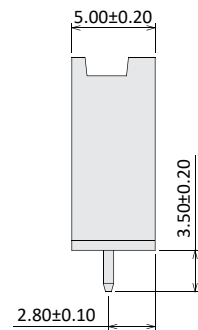
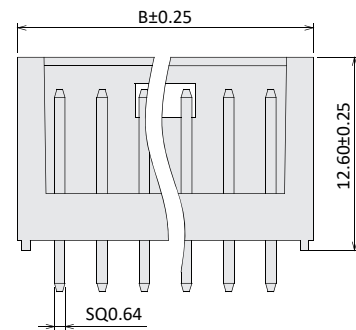
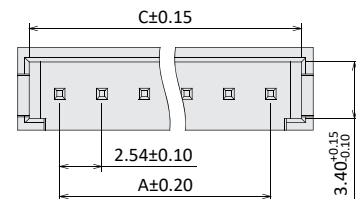


## Terminal Housing Wafer 2543 Series 2.54mm Pitch

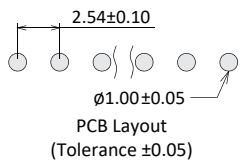
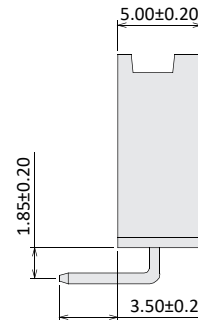
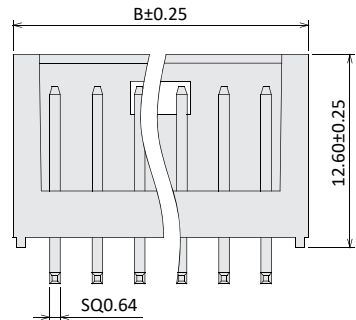
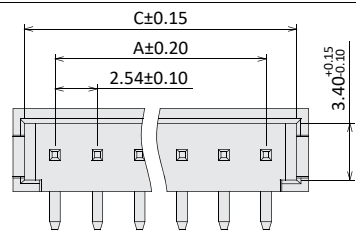


Part No.	Dimensions		
	A	B	C
H2543-02	2.54	7.10	5.60
H2543-04	7.62	12.20	10.60
H2543-06	12.70	17.30	15.70
H2543-08	17.78	22.30	20.80
H2543-10	22.86	27.40	25.90

Part No.	Wire Range	Insulation O.D.	Material	Finish
T2543-TP	#22-#26	1.55mm(Max.)	Phosphor Bronze	Tin Plated



Part No.	Dimensions		
	A	B	C
W2543L-02	2.54	7.62	6.22
W2543L-04	7.62	12.70	11.30
W2543L-06	12.70	17.78	16.38
W2543L-08	17.78	22.86	21.46
W2543L-10	22.86	27.94	26.54



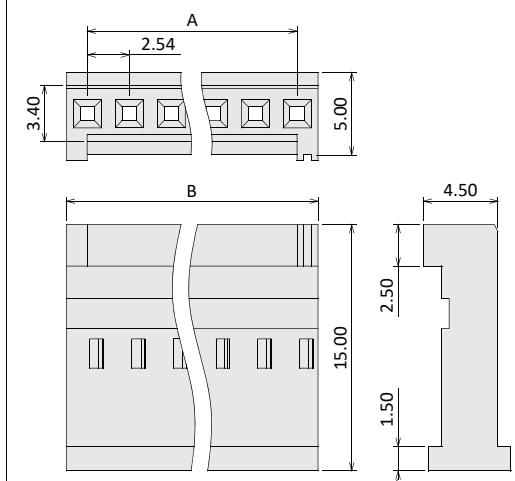
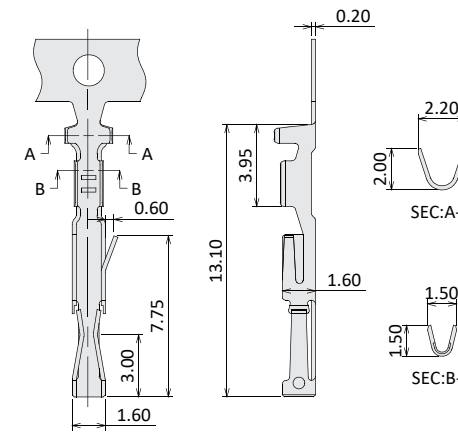
Part No.	Dimensions		
	A	B	C
W2543R-02	2.54	7.62	6.22
W2543R-04	7.62	12.70	11.30
W2543R-06	12.70	17.78	16.38
W2543R-08	17.78	22.86	21.46
W2543R-10	22.86	27.94	26.54

# Wafer Housing Terminal

Current Rate: 3A / 500V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: PBT/NY66/NY6T, UL94V-0  
 Operating Temperature: -40°C~+105°C

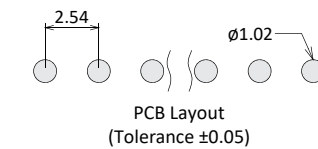
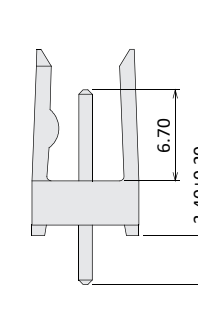
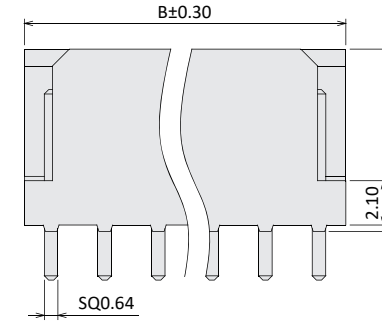
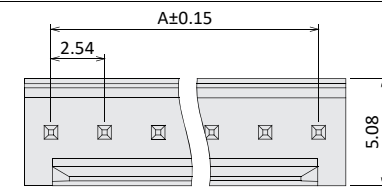


## Terminal Housing Wafer Single Row 2547 Series 2.54mm Pitch



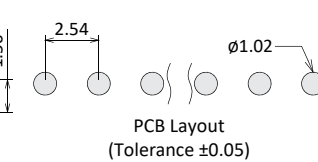
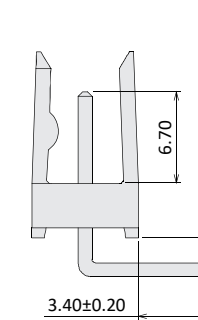
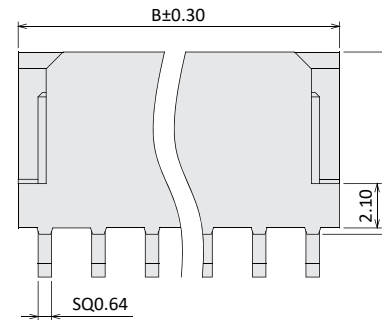
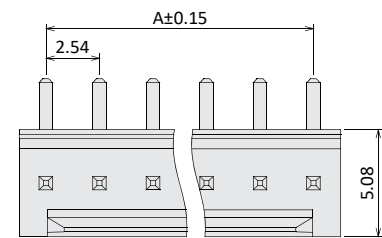
Part No.	Wire Range	Insulation O.D.	Material	Finish
T2547-TP	#22-#28	1.50mm(Max.)	Phosphor Bronze	Tin Plated

Part No.	Dimensions	
	A	B
H2547-102	2.54	5.08
H2547-103	5.08	7.62
H2547-104	7.62	10.16
H2547-105	10.16	12.70
H2547-106	12.70	15.24
H2547-107	15.24	17.78
H2547-108	17.78	20.32
H2547-109	20.32	22.86
H2547-110	22.86	25.40
H2547-111	25.40	27.94
H2547-112	27.94	30.48



**W2547L - 1 XX X X**  
 No. of Contacts  
 G: Gold Plating  
 T: Tin Plating  
 B: Black Insulator  
 U: Blue Insulator

Part No.	Dimensions	
	A	B
W2547L-102XX	2.54	4.98
W2547L-103XX	5.08	7.52
W2547L-104XX	7.62	10.06
W2547L-105XX	10.16	12.60
W2547L-106XX	12.70	15.14
W2547L-107XX	15.24	17.68
W2547L-108XX	17.78	20.22
W2547L-109XX	20.32	22.76
W2547L-110XX	22.86	25.30
W2547L-111XX	25.40	27.84
W2547L-112XX	27.94	30.38

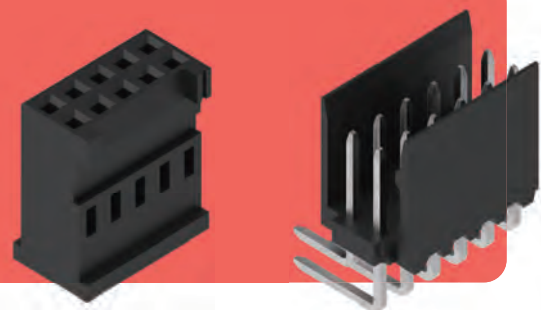


**W2547R - 1 XX X X**  
 No. of Contacts  
 G: Gold Plating  
 T: Tin Plating  
 B: Black Insulator  
 U: Blue Insulator

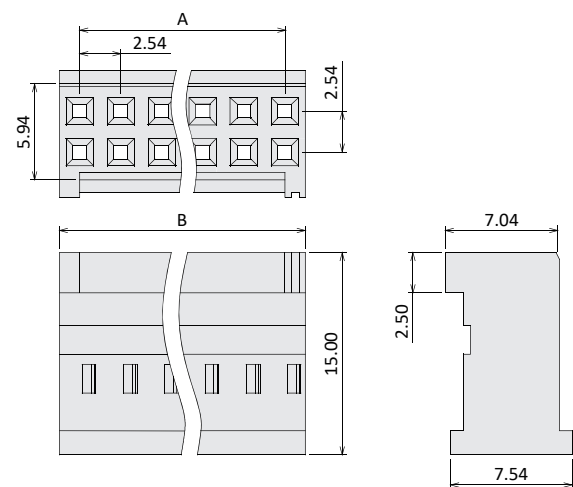
Part No.	Dimensions	
	A	B
W2547R-102XX	2.54	4.98
W2547R-103XX	5.08	7.52
W2547R-104XX	7.62	10.06
W2547R-105XX	10.16	12.60
W2547R-106XX	12.70	15.14
W2547R-107XX	15.24	17.68
W2547R-108XX	17.78	20.22
W2547R-109XX	20.32	22.76
W2547R-110XX	22.86	25.30
W2547R-111XX	25.40	27.84
W2547R-112XX	27.94	30.38

# Wafer Housing Terminal

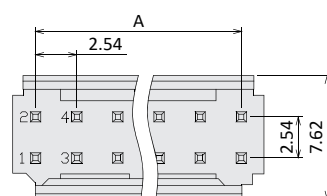
Current Rate: 3A / 500V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: PBT/NY66/NY6T, UL94V-0  
 Operating Temperature: -40°C~+105°C



## Housing Wafer Dual Row 2547 Series 2.54mm Pitch

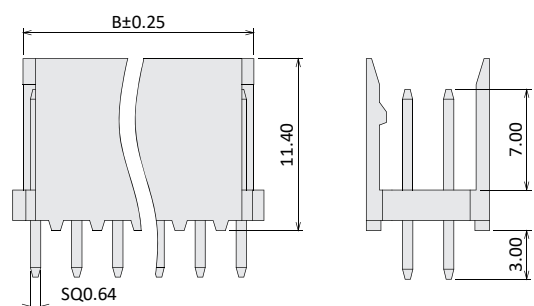


Part No.	Dimensions	
	A	B
H2547-202	2.54	5.08
H2547-203	5.08	7.62
H2547-204	7.62	10.16
H2547-205	10.16	12.70
H2547-206	12.70	15.24
H2547-207	15.24	17.78
H2547-208	17.78	20.32
H2547-209	20.32	22.86
H2547-210	22.86	25.40
H2547-211	25.40	27.94
H2547-212	27.94	30.48



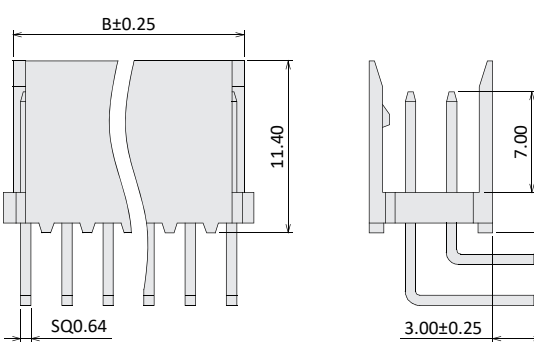
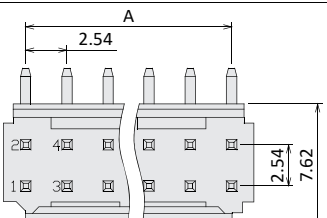
**W2547L - 2 XX X X**  
 No. of Contacts  
 G: Gold Plating  
 T: Tin Plating  
 B: Black Insulator  
 U: Blue Insulator

Part No.	Dimensions	
	A	B
W2547L-202XX	2.54	3.82
W2547L-203XX	5.08	6.36
W2547L-204XX	7.62	8.90
W2547L-205XX	10.16	11.44
W2547L-206XX	12.70	13.98
W2547L-207XX	15.24	16.52
W2547L-208XX	17.78	19.06
W2547L-209XX	20.32	21.60
W2547L-210XX	22.86	24.14
W2547L-211XX	25.40	26.68
W2547L-212XX	27.94	29.22



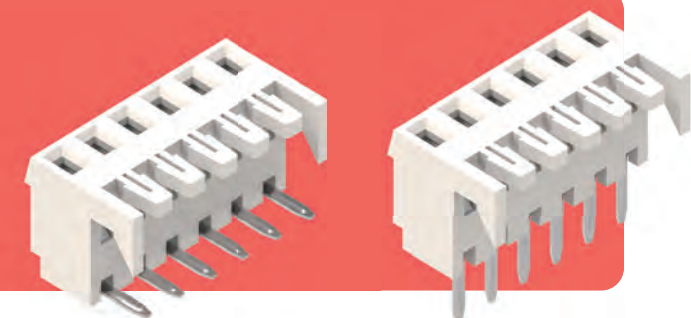
**W2547R - 2 XX X X**  
 No. of Contacts  
 G: Gold Plating  
 T: Tin Plating  
 B: Black Insulator  
 U: Blue Insulator

Part No.	Dimensions	
	A	B
W2547R-202XX	2.54	3.82
W2547R-203XX	5.08	6.36
W2547R-204XX	7.62	8.90
W2547R-205XX	10.16	11.44
W2547R-206XX	12.70	13.98
W2547R-207XX	15.24	16.52
W2547R-208XX	17.78	19.06
W2547R-209XX	20.32	21.60
W2547R-210XX	22.86	24.14
W2547R-211XX	25.40	26.68
W2547R-212XX	27.94	29.22

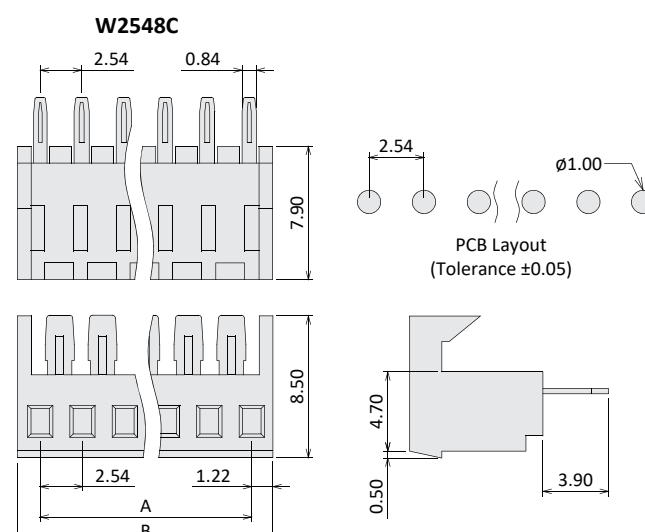
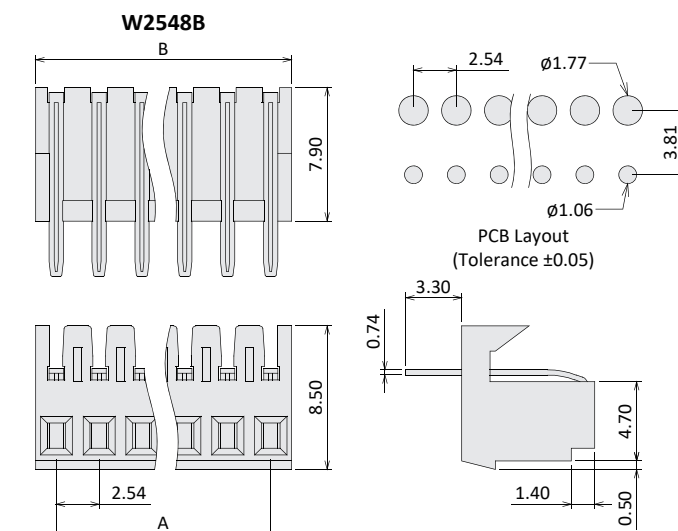
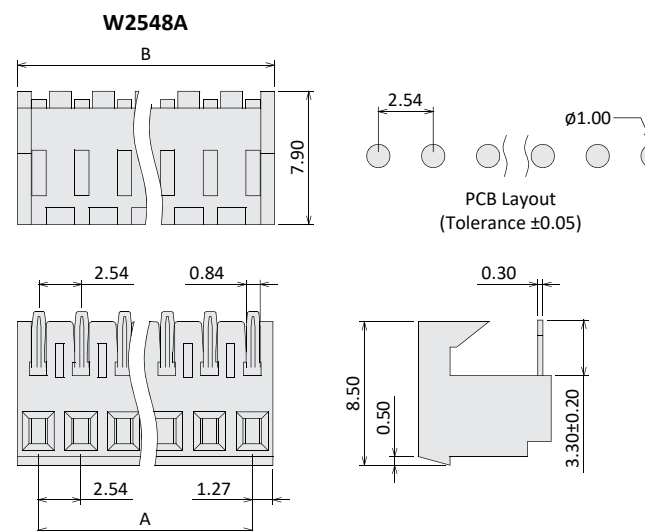


# Wafer Housing Terminal

Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 5000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -40°C~+105°C

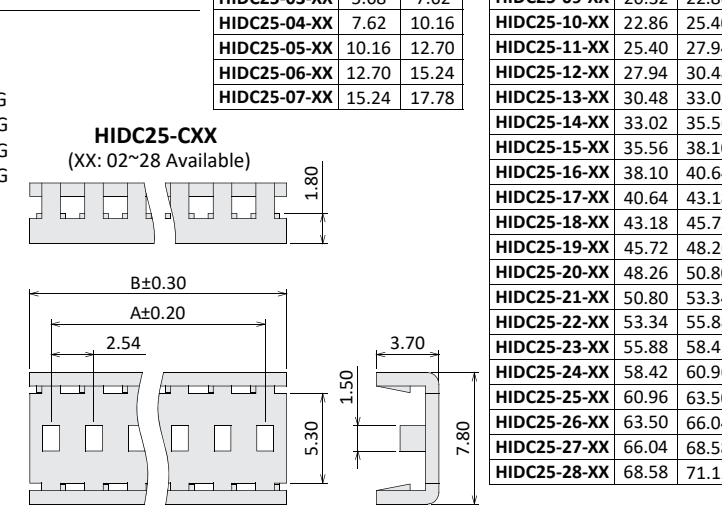
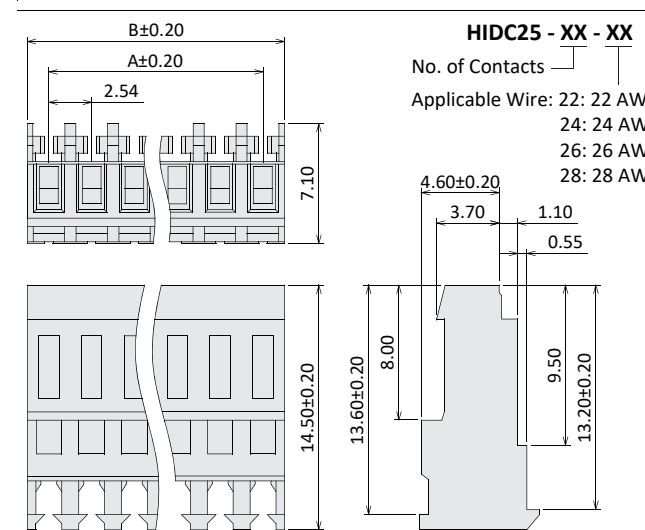


## Wafer 2548 & IDC25 Series 2.54mm Pitch



Part No.	Dimensions	
	A	B
W2548A(B)(C)-02	2.54	5.08
W2548A(B)(C)-03	5.08	7.62
W2548A(B)(C)-04	7.62	10.16
W2548A(B)(C)-05	10.16	12.70
W2548A(B)(C)-06	12.70	15.24
W2548A(B)(C)-07	15.24	17.78
W2548A(B)(C)-08	17.78	20.32
W2548A(B)(C)-09	20.32	22.86
W2548A(B)(C)-10	22.86	25.40
W2548A(B)(C)-11	25.40	27.94
W2548A(B)(C)-12	27.94	30.48
W2548A(B)(C)-13	30.48	33.02

Part No.	Dimensions	
	A	B
W2548A(B)(C)-14	33.02	35.56
W2548A(B)(C)-15	35.56	38.10
W2548A(B)(C)-16	38.10	40.64
W2548A(B)(C)-17	40.64	43.18
W2548A(B)(C)-18	43.18	45.72
W2548A(B)(C)-19	45.72	48.26
W2548A(B)(C)-20	48.26	50.80
W2548A(B)(C)-21	50.80	53.34
W2548A(B)(C)-22	53.34	55.88
W2548A(B)(C)-23	55.88	58.42
W2548A(B)(C)-24	58.42	60.96
W2548A(B)(C)-25	60.96	63.50

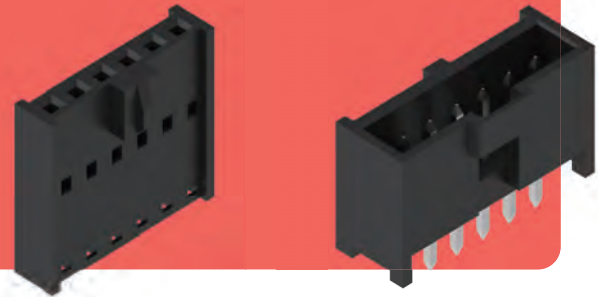


Part No.	Dimensions	
	A	B
HIDC25-02-XX	2.54	5.08
HIDC25-03-XX	5.08	7.62
HIDC25-04-XX	7.62	10.16
HIDC25-05-XX	10.16	12.70
HIDC25-06-XX	12.70	15.24
HIDC25-07-XX	15.24	17.78

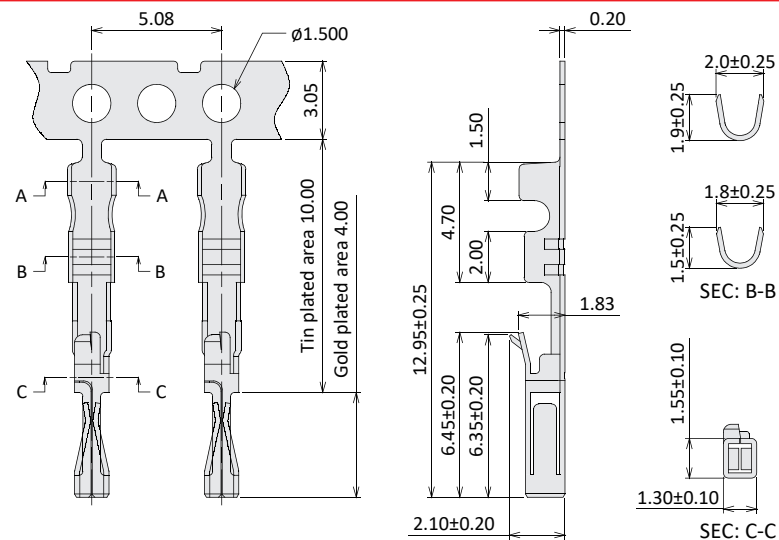
Part No.	Dimensions	
	A	B
HIDC25-08-XX	17.78	20.32
HIDC25-09-XX	20.32	22.86
HIDC25-10-XX	22.86	25.40
HIDC25-11-XX	25.40	27.94
HIDC25-12-XX	27.94	30.48
HIDC25-13-XX	30.48	33.02
HIDC25-14-XX	33.02	35.56
HIDC25-15-XX	35.56	38.10
HIDC25-16-XX	38.10	40.64
HIDC25-17-XX	40.64	43.18
HIDC25-18-XX	43.18	45.72
HIDC25-19-XX	45.72	48.26
HIDC25-20-XX	48.26	50.80
HIDC25-21-XX	50.80	53.34
HIDC25-22-XX	53.34	55.88
HIDC25-23-XX	55.88	58.42
HIDC25-24-XX	58.42	60.96
HIDC25-25-XX	60.96	63.50
HIDC25-26-XX	63.50	66.04
HIDC25-27-XX	66.04	68.58
HIDC25-28-XX	68.58	71.12

# Wafer Housing Terminal

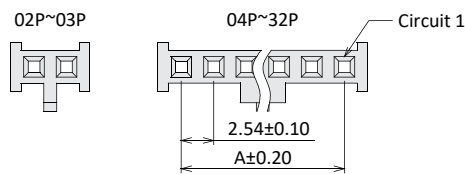
Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: PBT, UL94V-2 / V0  
 Operating Temperature: -40°C~+105°C



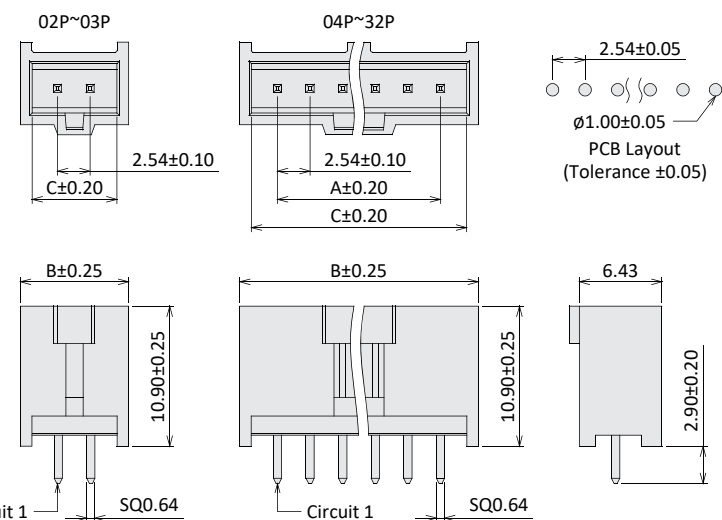
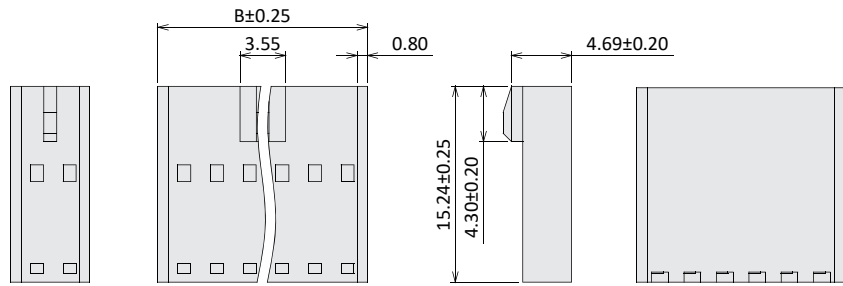
## Terminal Housing Wafer 2549 Series 2.54mm Pitch



Part No.	Wire Range	Material	Finish
T2549-TP	#22-#24	Phosphor Bronze	Tin Plated
T2549-GP	#22-#24	Phosphor Bronze	Gold Plated
T2549-G1P	#22-#24	Phosphor Bronze	Gold 2u"



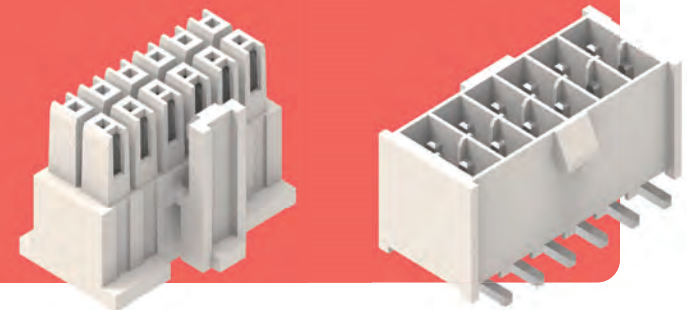
Part No.	Dimensions		Part No.	Dimensions	
	A	B		A	B
H2549-02	2.54	6.14	H2549-18	43.18	46.78
H2549-03	5.08	8.68	H2549-19	45.72	49.32
H2549-04	7.62	11.22	H2549-20	48.26	51.86
H2549-05	10.16	13.76	H2549-21	50.80	54.40
H2549-06	12.70	16.30	H2549-22	53.34	56.94
H2549-07	15.24	18.84	H2549-23	55.88	59.48
H2549-08	17.78	21.38	H2549-24	58.42	62.02
H2549-09	20.32	23.92	H2549-25	60.96	64.56
H2549-10	22.86	26.46	H2549-26	63.50	67.10
H2549-11	25.40	29.00	H2549-27	66.04	69.64
H2549-12	27.94	31.54	H2549-28	68.58	72.18
H2549-13	30.48	34.08	H2549-29	71.12	74.72
H2549-14	33.02	36.62	H2549-30	73.66	77.26
H2549-15	35.56	39.16	H2549-31	76.20	79.80
H2549-16	38.10	41.70	H2549-32	78.74	82.34
H2549-17	40.64	44.24			



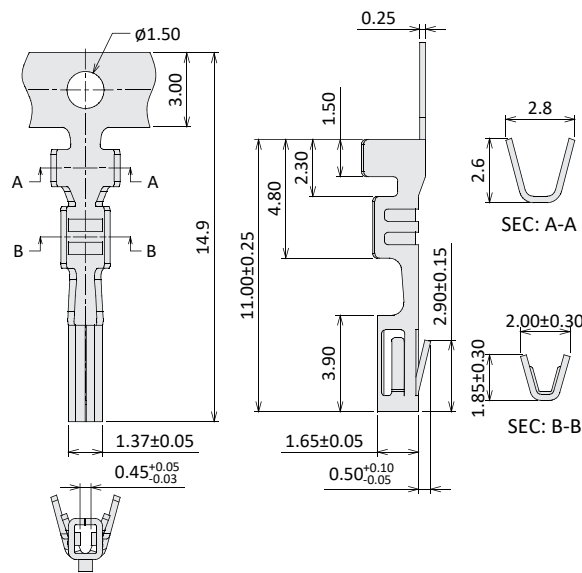
Part No.	Dimensions			Part No.	Dimensions		
	A	B	C		A	B	C
W2549L-02	2.54	8.43	6.60	W2549L-18	43.18	49.07	47.24
W2549L-03	5.08	10.97	9.14	W2549L-19	45.72	51.61	49.78
W2549L-04	7.62	13.51	11.68	W2549L-20	48.26	54.15	52.32
W2549L-05	10.16	16.05	14.22	W2549L-21	50.80	56.69	54.86
W2549L-06	12.70	18.59	16.76	W2549L-22	53.34	59.23	57.40
W2549L-07	15.24	21.13	19.30	W2549L-23	55.88	61.77	59.94
W2549L-08	17.78	23.67	21.84	W2549L-24	58.42	64.31	62.48
W2549L-09	20.32	26.21	24.38	W2549L-25	60.96	66.85	65.02
W2549L-10	22.86	28.75	26.92	W2549L-26	63.50	69.39	67.56
W2549L-11	25.40	31.29	29.46	W2549L-27	66.04	71.93	70.10
W2549L-12	27.94	33.83	32.00	W2549L-28	68.58	74.47	72.64
W2549L-13	30.48	36.37	34.54	W2549L-29	71.12	77.01	75.18
W2549L-14	33.02	38.91	37.08	W2549L-30	73.66	79.55	77.72
W2549L-15	35.56	41.45	39.62	W2549L-31	76.20	82.09	80.26
W2549L-16	38.10	43.99	42.16	W2549L-32	78.74	84.63	82.80
W2549L-17	40.64	46.53	44.70				

# Wafer Housing Terminal

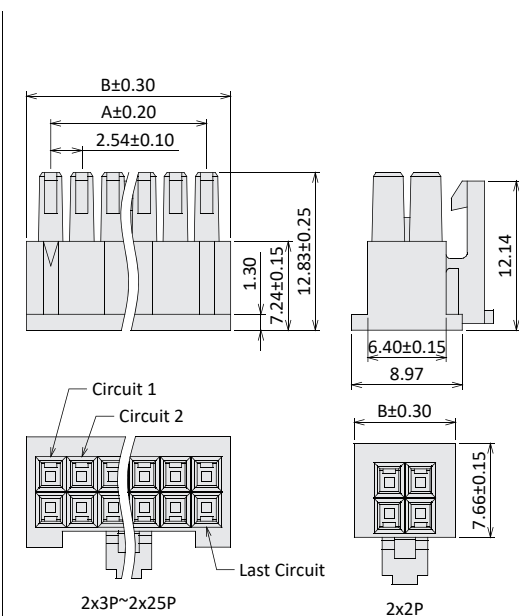
Current Rate: 3A / 250V AC,DC  
 Dielectric Voltage: 1000V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: NY 66 / LCP, UL94V-0  
 Operating Temperature: -55°C~+125°C



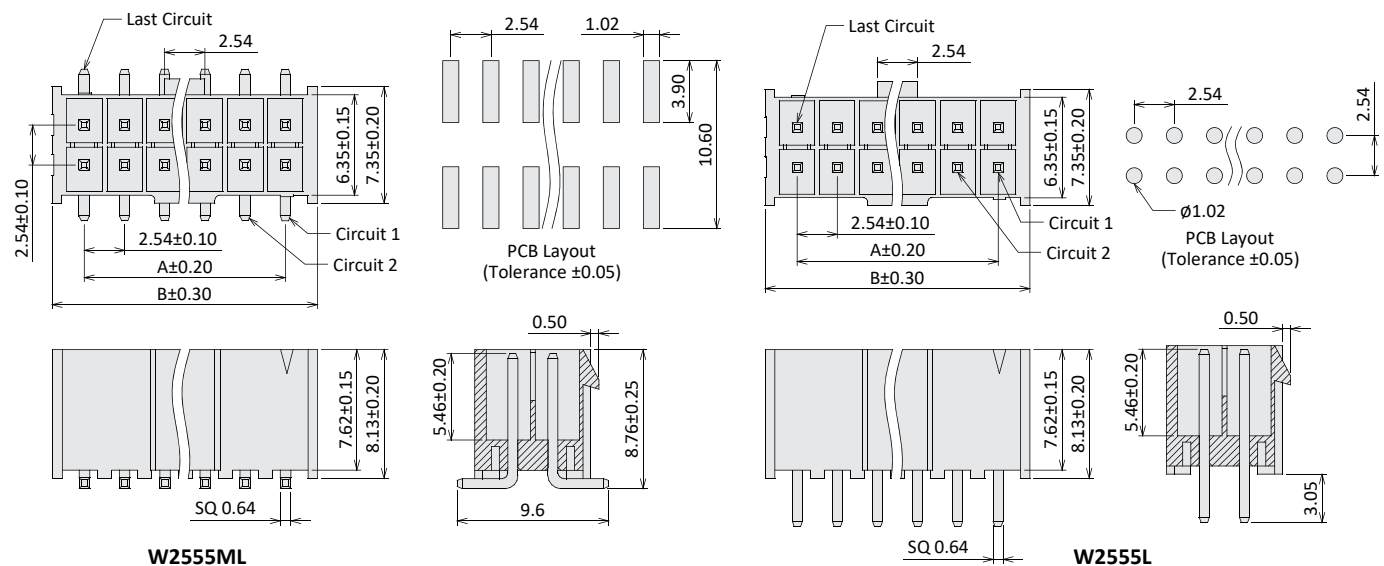
## Terminal Housing Wafer 2555 Series 2.54mm Pitch



Part No.	Wire Range	Insulation O.D.	Material	Finish
T2555-TP	#20-#24	1.55mm(Max.)	Phosphor Bronze	Tin Plated
T2555-GP	#20-#24	1.55mm(Max.)	Phosphor Bronze	Gold Plated



Part No.	Dimensions	
	A	B
H2555-202	2.54	8.26
H2555-203	5.08	9.02
H2555-204	7.62	11.56
H2555-205	10.16	14.10
H2555-206	12.70	16.64
H2555-207	15.24	19.18
H2555-208	17.78	21.72
H2555-209	20.32	24.26
H2555-210	22.86	26.80
H2555-211	25.40	29.34
H2555-212	27.94	31.88
H2555-213	30.48	34.42
H2555-214	33.02	36.96
H2555-215	35.56	39.50
H2555-216	38.10	42.04
H2555-217	40.64	44.58
H2555-218	43.18	47.12
H2555-219	45.72	49.66
H2555-220	48.26	52.20
H2555-221	50.80	54.74
H2555-222	53.34	57.28
H2555-223	55.88	59.82
H2555-224	58.42	62.36
H2555-225	60.96	64.90



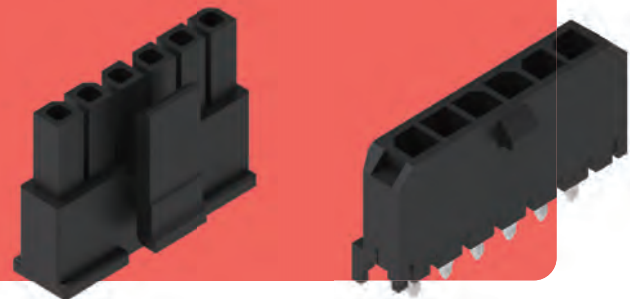
W2555ML

W2555L

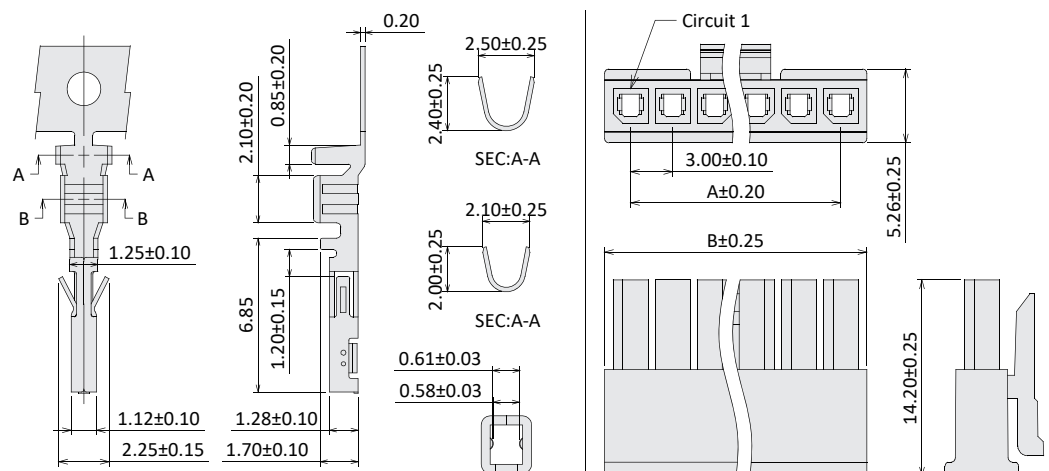
Part No.	Dimensions		Part No.	Dimensions	
	A	B		A	B
W2555ML(L)-202	2.54	6.60	W2555ML(L)-214	33.02	37.08
W2555ML(L)-203	5.08	9.14	W2555ML(L)-215	35.56	39.62
W2555ML(L)-204	7.62	11.68	W2555ML(L)-216	38.10	42.16
W2555ML(L)-205	10.16	14.22	W2555ML(L)-217	40.64	44.70
W2555ML(L)-206	12.70	16.76	W2555ML(L)-218	43.18	47.24
W2555ML(L)-207	15.24	19.30	W2555ML(L)-219	45.72	49.78
W2555ML(L)-208	17.78	21.84	W2555ML(L)-220	48.26	52.32
W2555ML(L)-209	20.32	24.38	W2555ML(L)-221	50.80	54.86
W2555ML(L)-210	22.86	26.92	W2555ML(L)-222	53.34	57.40
W2555ML(L)-211	25.40	29.46	W2555ML(L)-223	55.88	59.94
W2555ML(L)-212	27.94	32.00	W2555ML(L)-224	58.42	62.48
W2555ML(L)-213	30.48	34.54	W2555ML(L)-225	60.96	65.02

# Wafer Housing Terminal

Current Rate: 5A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: N66 / PBT, UL94V-2 / V-0  
 Operating Temperature: -25°C~+85°C

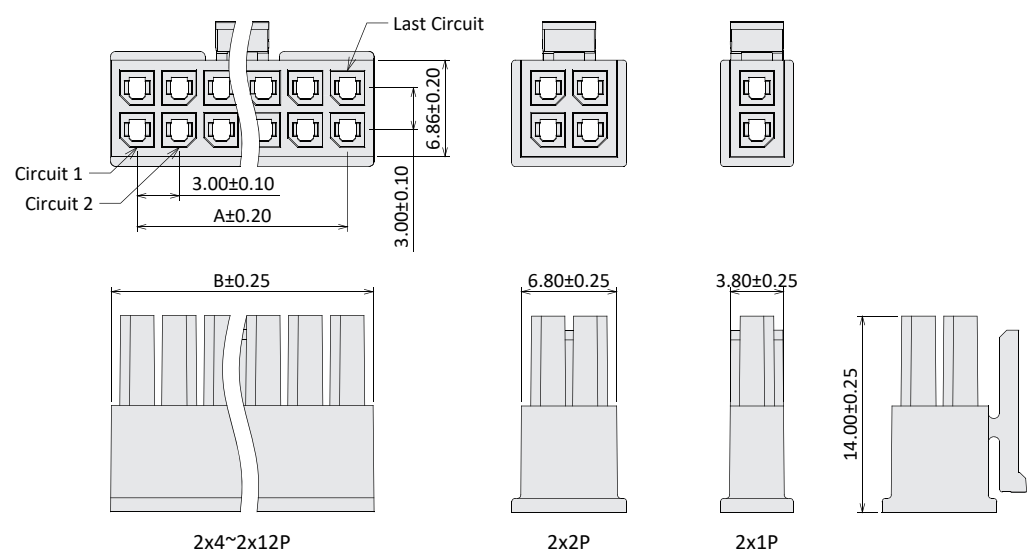


## Terminal Housing Wafer 3030 Series 3.00mm Pitch

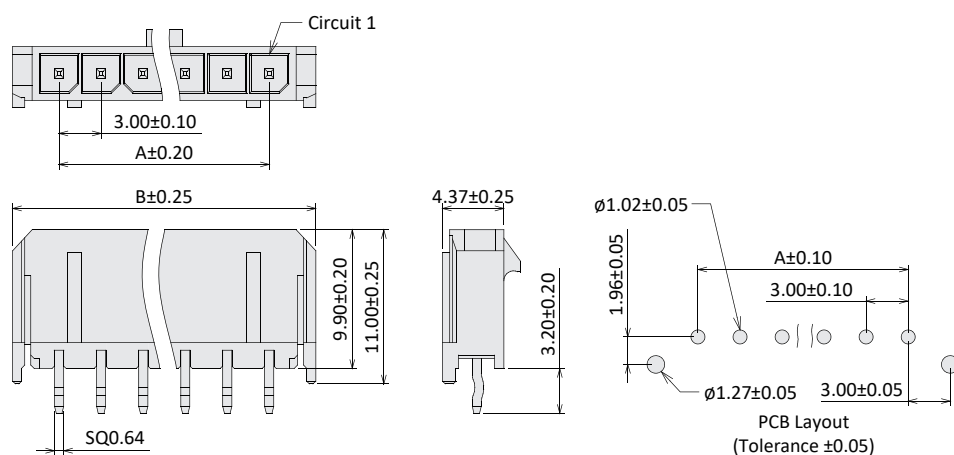


Part No.	Wire Range	Insulation O.D.	Material	Finish
T3030F-TP	#20-#24	1.85mm(Max.)	Phosphor Bronze	Tin Plated

Part No.	Dimensions	
	A	B
H3030F-102	3.00	7.00
H3030F-103	6.00	10.00
H3030F-104	9.00	13.00
H3030F-105	12.00	16.00
H3030F-106	15.00	19.00
H3030F-107	18.00	22.00
H3030F-108	21.00	25.00
H3030F-109	24.00	28.00
H3030F-110	27.00	31.00
H3030F-111	30.00	34.00
H3030F-112	33.00	37.00



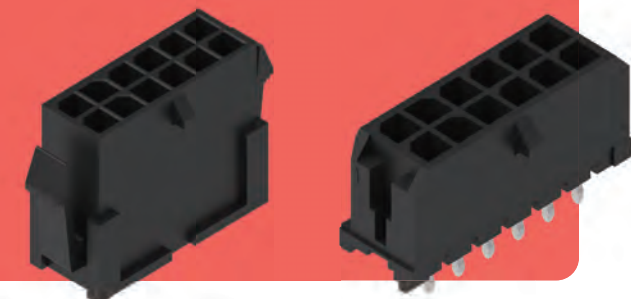
Part No.	Dimensions	
	A	B
H3030F-201	---	3.80
H3030F-202	3.00	6.80
H3030F-203	6.00	9.80
H3030F-204	9.00	12.80
H3030F-205	12.00	15.80
H3030F-206	15.00	18.80
H3030F-207	18.00	21.80
H3030F-208	21.00	24.80
H3030F-209	24.00	27.80
H3030F-210	27.00	30.80
H3030F-211	30.00	33.80
H3030F-212	33.00	36.80



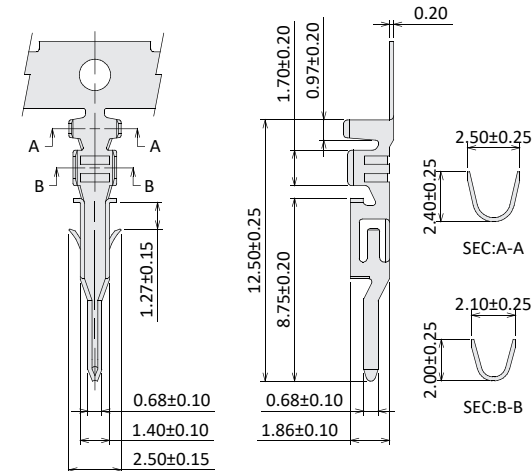
Part No.	Dimensions	
	A	B
W3030L-102	3.00	9.65
W3030L-103	6.00	12.65
W3030L-104	9.00	15.65
W3030L-105	12.00	18.65
W3030L-106	15.00	21.65
W3030L-107	18.00	24.65
W3030L-108	21.00	27.65
W3030L-109	24.00	30.65
W3030L-110	27.00	33.65
W3030L-111	30.00	36.65
W3030L-112	33.00	39.65

# Wafer Housing Terminal

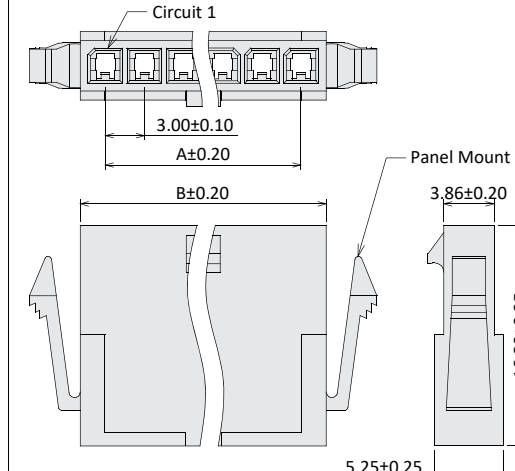
Current Rate: 5A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: N66 / PBT, UL94V-2 / V-0  
 Operating Temperature: -25°C~+85°C



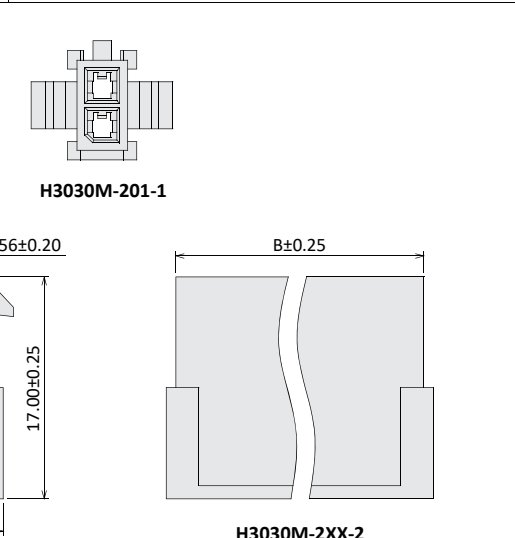
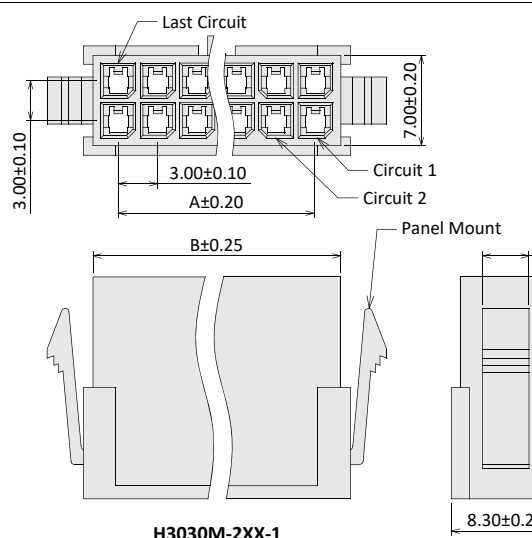
## Terminal Housing Wafer 3030 Series 3.00mm Pitch



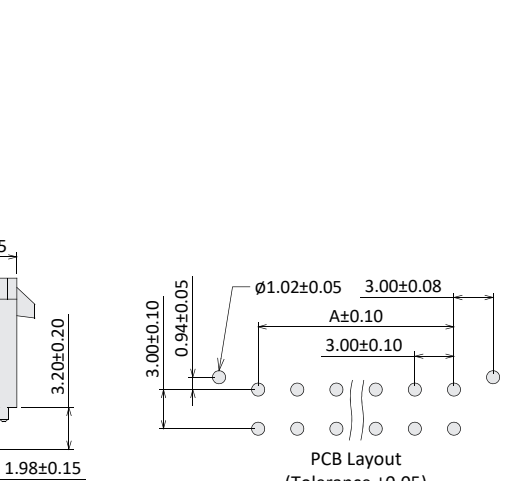
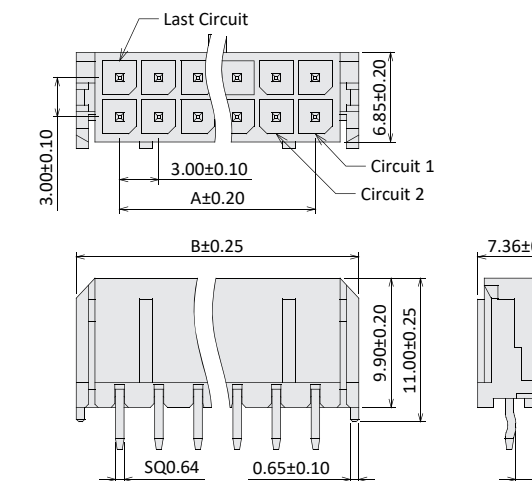
Part No.	Wire Range	Insulation O.D.	Material	Finish
T3030M-TP	#20-#24	1.85mm(Max.)	Phosphor Bronze	Tin Plated



Part No.	Dimensions	
	A	B
H3030M-102-X	3.00	6.85
H3030M-103-X	6.00	9.85
H3030M-104-X	9.00	12.85
H3030M-105-X	12.00	15.85
H3030M-106-X	15.00	18.85
H3030M-107-X	18.00	21.85
H3030M-108-X	21.00	24.85
H3030M-109-X	24.00	27.85
H3030M-110-X	27.00	30.85
H3030M-111-X	30.00	33.85
H3030M-112-X	33.00	36.85



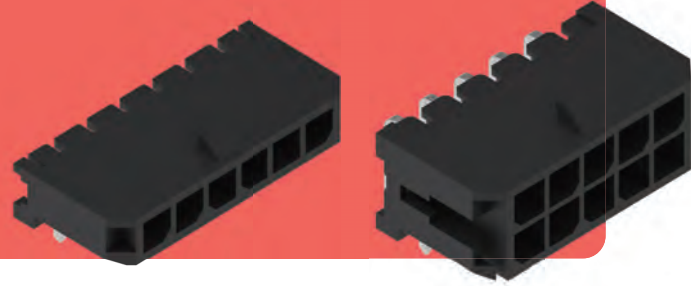
Part No.	Dimensions	
	A	B
H3030M-201-X	---	4.00
H3030M-202-X	3.00	7.00
H3030M-203-X	6.00	10.00
H3030M-204-X	9.00	13.00
H3030M-205-X	12.00	16.00
H3030M-206-X	15.00	19.00
H3030M-207-X	18.00	22.00
H3030M-208-X	21.00	25.00
H3030M-209-X	24.00	28.00
H3030M-210-X	27.00	31.00
H3030M-211-X	30.00	34.00
H3030M-212-X	33.00	37.00



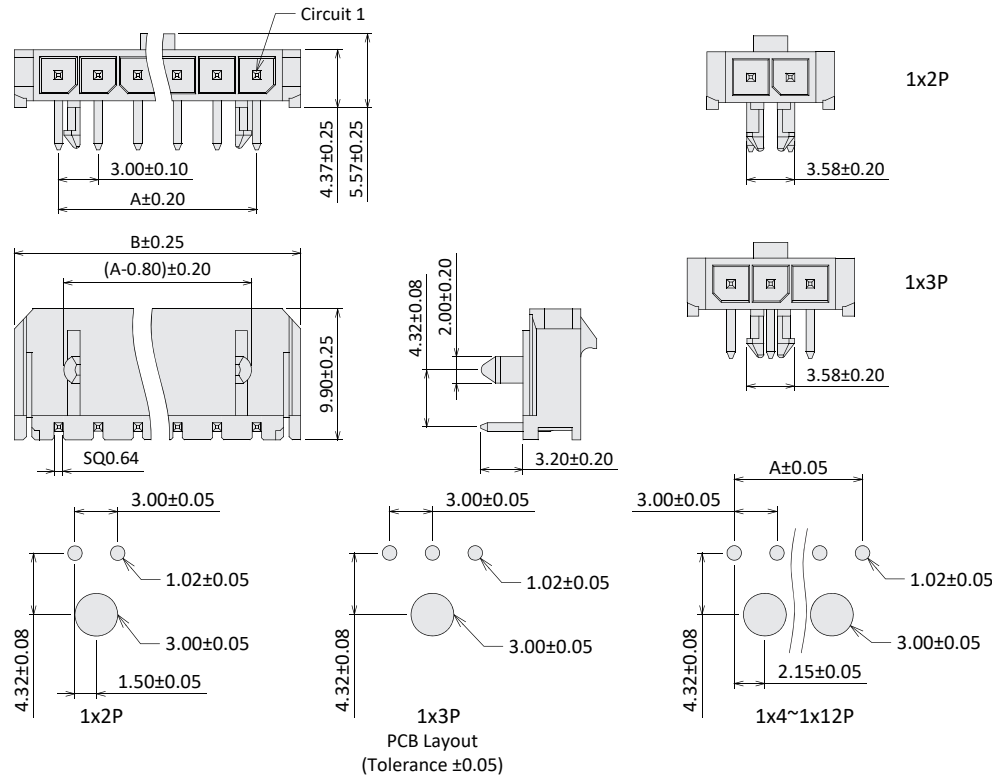
Part No.	Dimensions	
	A	B
W3030L-201	---	6.65
W3030L-202	3.00	9.65
W3030L-203	6.00	12.65
W3030L-204	9.00	15.65
W3030L-205	12.00	18.65
W3030L-206	15.00	21.65
W3030L-207	18.00	24.65
W3030L-208	21.00	27.65
W3030L-209	24.00	30.65
W3030L-210	27.00	33.65
W3030L-211	30.00	36.65
W3030L-212	33.00	39.65

# Wafer Housing Terminal

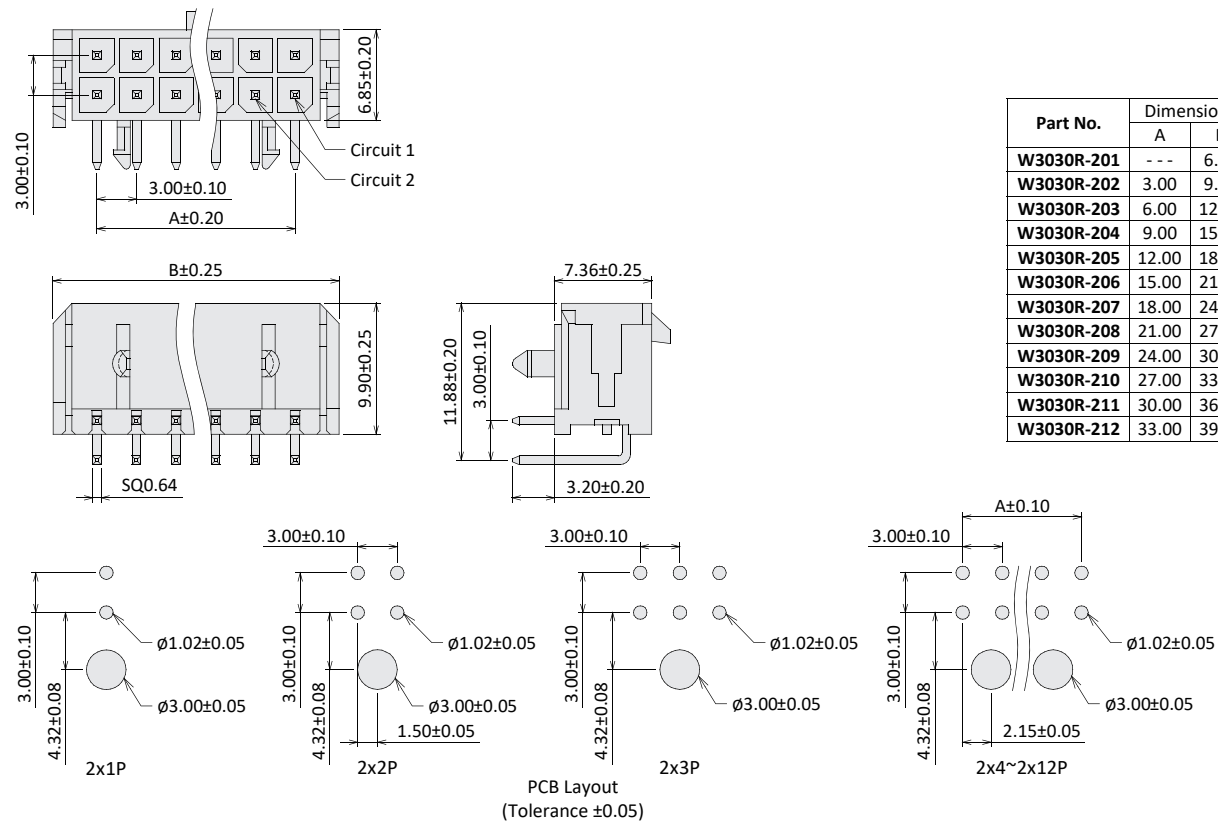
Current Rate: 5A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: PBT, UL94VV-0  
 Operating Temperature: -25°C~+85°C



## Wafer 3030 Series 3.00mm Pitch



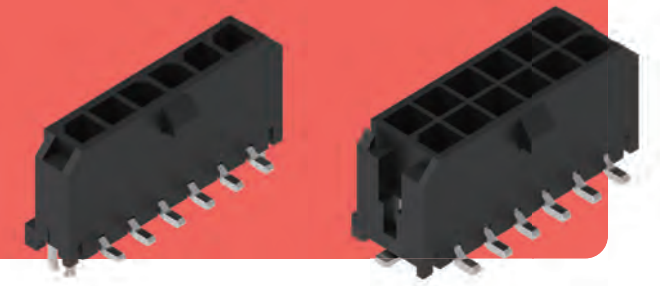
Part No.	Dimensions	
	A	B
W3030R-102	3.00	9.65
W3030R-103	6.00	12.65
W3030R-104	9.00	15.65
W3030R-105	12.00	18.65
W3030R-106	15.00	21.65
W3030R-107	18.00	24.65
W3030R-108	21.00	27.65
W3030R-109	24.00	30.65
W3030R-110	27.00	33.65
W3030R-111	30.00	36.65
W3030R-112	33.00	39.65



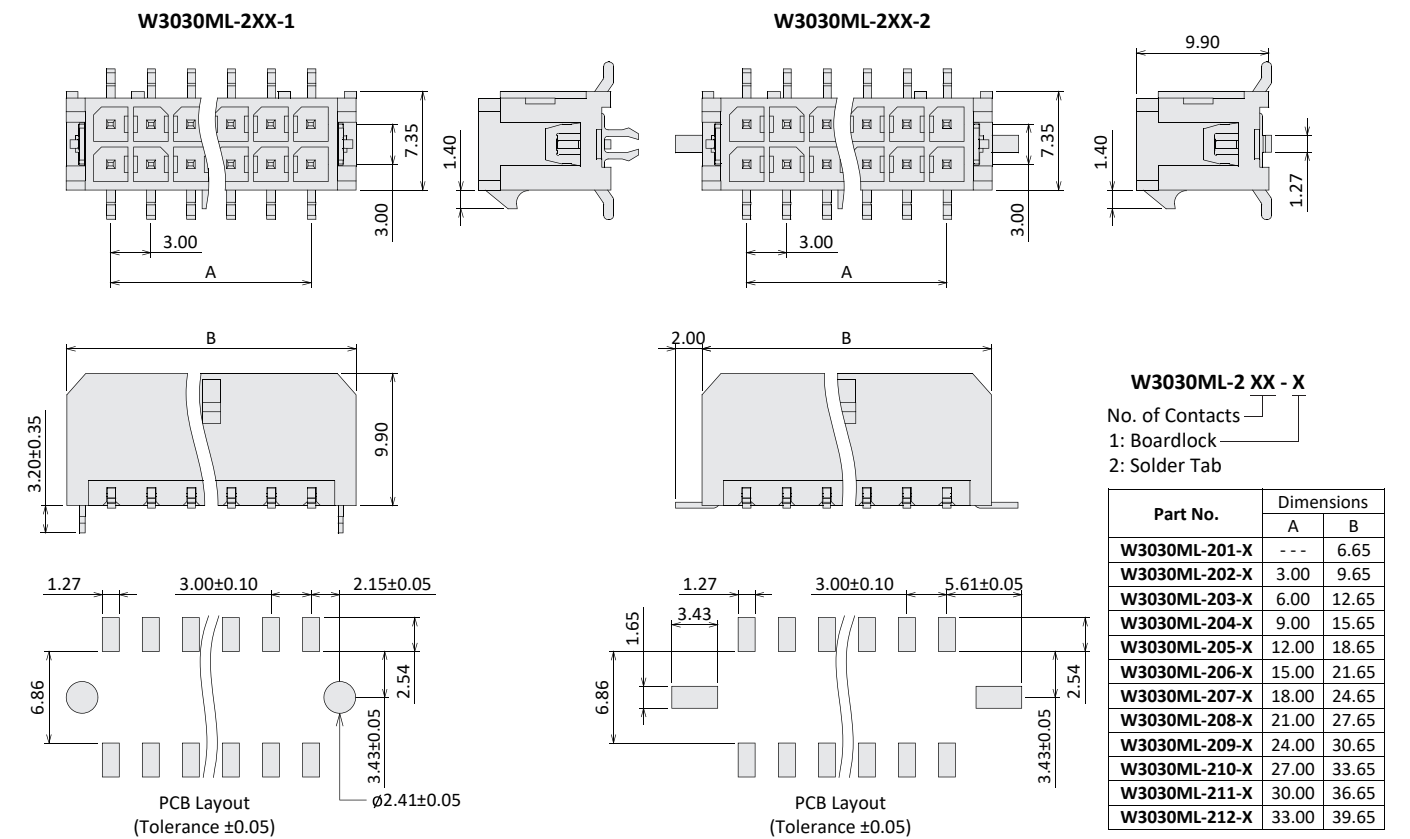
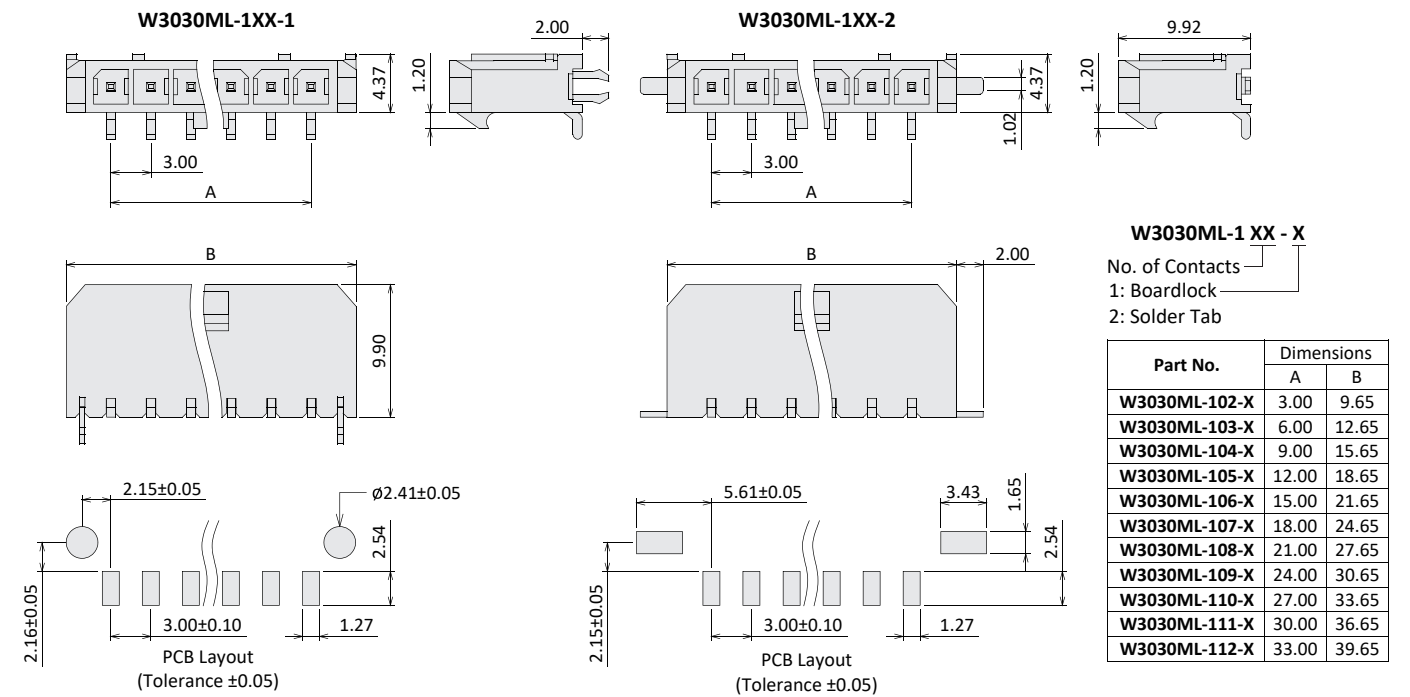
Part No.	Dimensions	
	A	B
W3030R-201	---	6.65
W3030R-202	3.00	9.65
W3030R-203	6.00	12.65
W3030R-204	9.00	15.65
W3030R-205	12.00	18.65
W3030R-206	15.00	21.65
W3030R-207	18.00	24.65
W3030R-208	21.00	27.65
W3030R-209	24.00	30.65
W3030R-210	27.00	33.65
W3030R-211	30.00	36.65
W3030R-212	33.00	39.65

# Wafer Housing Terminal

Current Rate: 5A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: LCP, UL94VV-0  
 Operating Temperature: -25°C~+85°C



## Wafer 3030 Series 3.00mm Pitch



# Wafer Housing Terminal

Current Rate: 5A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: LCP, UL94VV-0  
 Operating Temperature: -25°C~+85°C



## Wafer 3030 Series 3.00mm Pitch

**W3030MR-1XX-1** **W3030MR-1XX-2**

**W3030MR-1 XX - X**  
 No. of Contacts  
 1: Boardlock  
 2: Solder Tab

Part No.	Dimensions	
	A	B
W3030MR-102-X	3.00	9.65
W3030MR-103-X	6.00	12.65
W3030MR-104-X	9.00	15.65
W3030MR-105-X	12.00	18.65
W3030MR-106-X	15.00	21.65
W3030MR-107-X	18.00	24.65
W3030MR-108-X	21.00	27.65
W3030MR-109-X	24.00	30.65
W3030MR-110-X	27.00	33.65
W3030MR-111-X	30.00	36.65
W3030MR-112-X	33.00	39.65

PCB Layout (Tolerance ±0.05)  $\phi 2.41 \pm 0.05$

**W3030MR-2XX-1** **W3030MR-2XX-2**

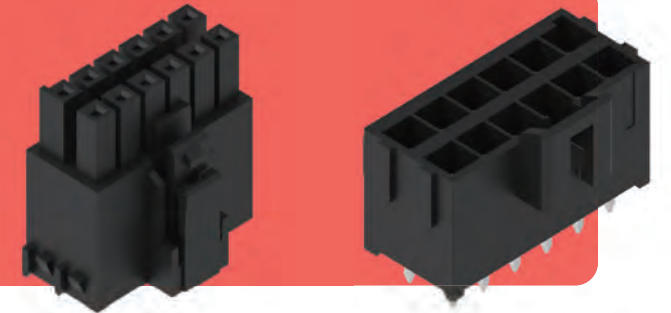
**W3030MR-2 XX - X**  
 No. of Contacts  
 1: Boardlock  
 2: Solder Tab

Part No.	Dimensions	
	A	B
W3030MR-201-X	---	6.65
W3030MR-202-X	3.00	9.65
W3030MR-203-X	6.00	12.65
W3030MR-204-X	9.00	15.65
W3030MR-205-X	12.00	18.65
W3030MR-206-X	15.00	21.65
W3030MR-207-X	18.00	24.65
W3030MR-208-X	21.00	27.65
W3030MR-209-X	24.00	30.65
W3030MR-210-X	27.00	33.65
W3030MR-211-X	30.00	36.65
W3030MR-212-X	33.00	39.65

PCB Layout (Tolerance ±0.05)  $\phi 2.41 \pm 0.05$

# Wafer Housing Terminal

Current Rate: 8A / 400V AC,DC  
 Dielectric Voltage: 1800V AC for one minute  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: NY 66 / LCP, UL94V-0  
 Operating Temperature: -40°C~+105°C



## Terminal Housing Wafer 3522 Series 3.50mm Pitch

**H3522F - 2 XX X X**  
 No. of Contacts  
 A: Key A  
 B: Key B  
 A: W/O Hook  
 B: With Hook

Part No.	Wire Range	Material	Dim. a	Dim. b	Dim. c	Dim. d	Finish
T3522F-TB1	#16-#18	2.8	2.7	2.9	2.63	Tin Plated	
T3522F-SB	#20-#22	High Conductivity Copper Alloy	2.18	2.18	2.33	2.08	Gold / Nickel
T3522F-SB1	#16-#18		2.8	2.7	2.9	2.63	Gold / Nickel
T3522F-GB	#20-#22	High Conductivity Copper Alloy	2.18	2.18	2.33	2.08	Gold Plated
T3522F-GB1	#16-#18		2.8	2.7	2.9	2.63	Gold Plated

W/O Hook  
 Circuit 1  
 With Hook

**W3522L - 2 XX X**  
 No. of Contacts  
 A: Key A  
 B: Key B

Part No.	Dimensions	
	A	B
W3522L-202X	3.50	8.00
W3522L-203X	7.00	11.50
W3522L-204X	10.50	15.00
W3522L-205X	14.00	18.50
W3522L-206X	17.50	22.00
W3522L-207X	21.00	25.50
W3522L-208X	24.50	29.00

PCB Layout (Tolerance ±0.05)  $\phi 1.02 \pm 0.04$   $\phi 1.60 \pm 0.04$

**W3522R - 2 XX X**  
 No. of Contacts  
 A: Key A  
 B: Key B

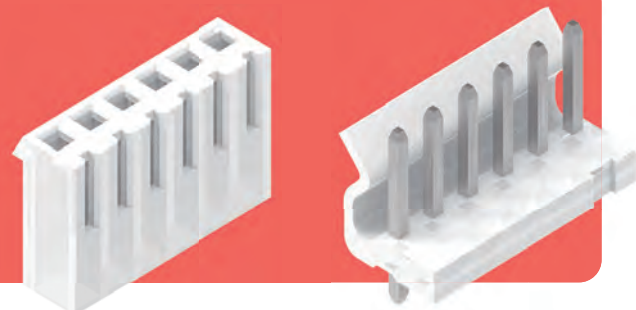
Part No.	Dimensions		
	A	B	C
W3522R-202X	3.50	8.00	---
W3522R-203X	7.00	11.50	---
W3522R-204X	10.50	15.00	7.00
W3522R-205X	14.00	18.50	10.50
W3522R-206X	17.50	22.00	14.00
W3522R-207X	21.00	25.50	17.50
W3522R-208X	24.50	29.00	21.00

PCB Layout (Tolerance ±0.05)  $\phi 1.02 \pm 0.04$   $\phi 3.05 \pm 0.04$   
 Circuit 1 Mark (Not showing on 2x2P & 2x3P)

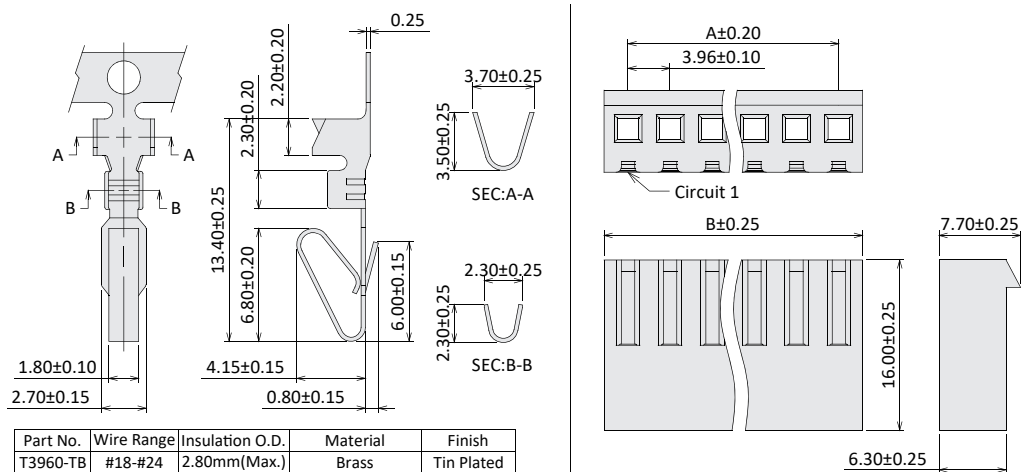


# Wafer Housing Terminal

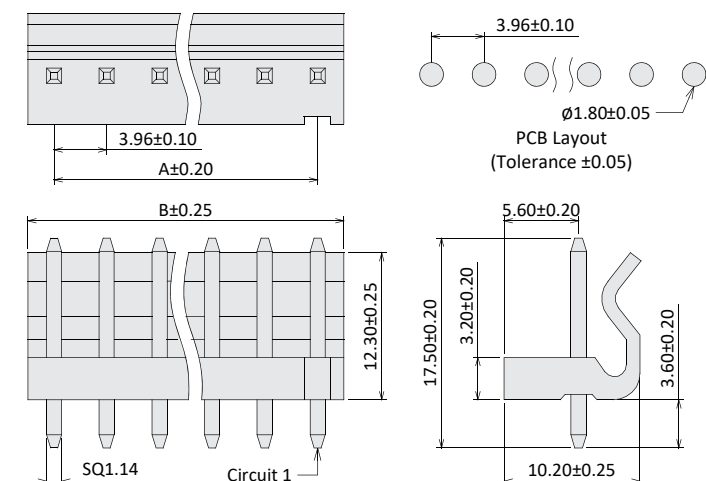
Current Rate: 7A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -25°C~+85°C



## Terminal Housing Wafer 3960 Series 3.96mm Pitch

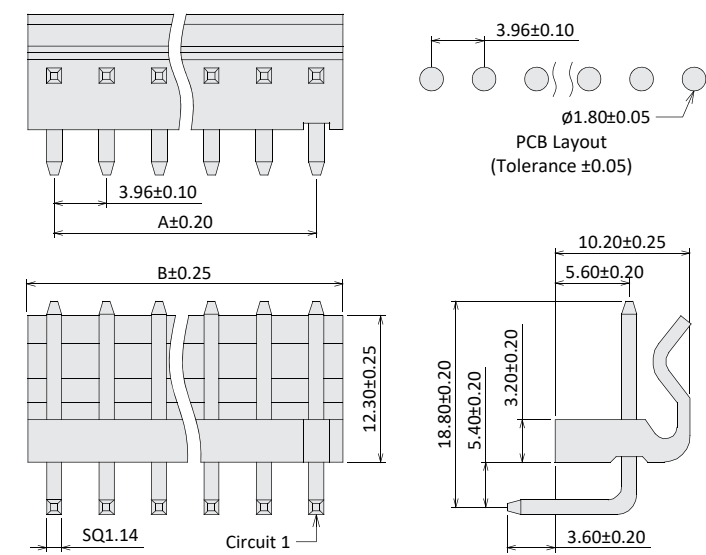


Part No.	Dimensions	
	A	B
H3960-02	3.96	8.43
H3960-03	7.92	12.39
H3960-04	11.88	16.35
H3960-05	15.84	20.31
H3960-06	19.80	24.27
H3960-07	23.76	28.23
H3960-08	27.72	32.19
H3960-09	31.68	36.15
H3960-10	35.64	40.11
H3960-11	39.60	44.07
H3960-12	43.56	48.03
H3960-13	47.52	51.99
H3960-14	51.48	55.95
H3960-15	55.44	59.91
H3960-16	59.40	63.87
H3960-17	63.36	67.83
H3960-18	67.32	71.79
H3960-19	71.28	75.75
H3960-20	75.24	79.71



Part No.	Dimensions	
	A	B
W3960L-02	3.96	7.92
W3960L-03	7.92	11.88
W3960L-04	11.88	15.84
W3960L-05	15.84	19.80
W3960L-06	19.80	23.76
W3960L-07	23.76	27.72
W3960L-08	27.72	31.68
W3960L-09	31.68	35.64
W3960L-10	35.64	39.60
W3960L-11	39.60	43.56

Part No.	Dimensions	
	A	B
W3960L-12	43.56	47.52
W3960L-13	47.52	51.48
W3960L-14	51.48	55.44
W3960L-15	55.44	59.40
W3960L-16	59.40	63.36
W3960L-17	63.36	67.32
W3960L-18	67.32	71.28
W3960L-19	71.28	75.24
W3960L-20	75.24	79.20

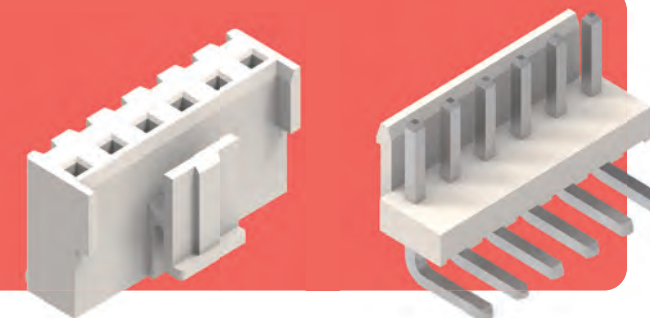


Part No.	Dimensions	
	A	B
W3960R-02	3.96	7.92
W3960R-03	7.92	11.88
W3960R-04	11.88	15.84
W3960R-05	15.84	19.80
W3960R-06	19.80	23.76
W3960R-07	23.76	27.72
W3960R-08	27.72	31.68
W3960R-09	31.68	35.64
W3960R-10	35.64	39.60
W3960R-11	39.60	43.56

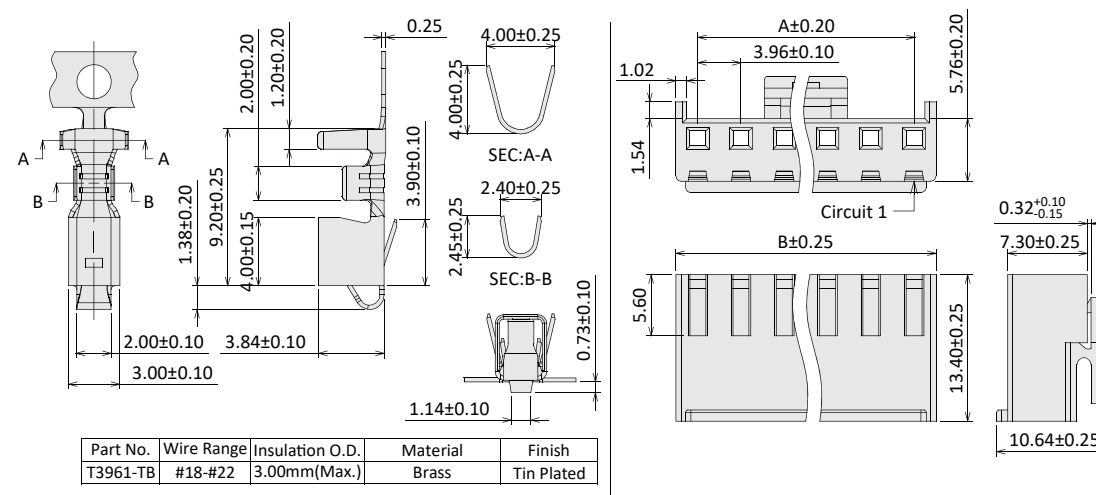
Part No.	Dimensions	
	A	B
W3960R-12	43.56	47.52
W3960R-13	47.52	51.48
W3960R-14	51.48	55.44
W3960R-15	55.44	59.40
W3960R-16	59.40	63.36
W3960R-17	63.36	67.32
W3960R-18	67.32	71.28
W3960R-19	71.28	75.24
W3960R-20	75.24	79.20

# Wafer Housing Terminal

Current Rate: 7A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C

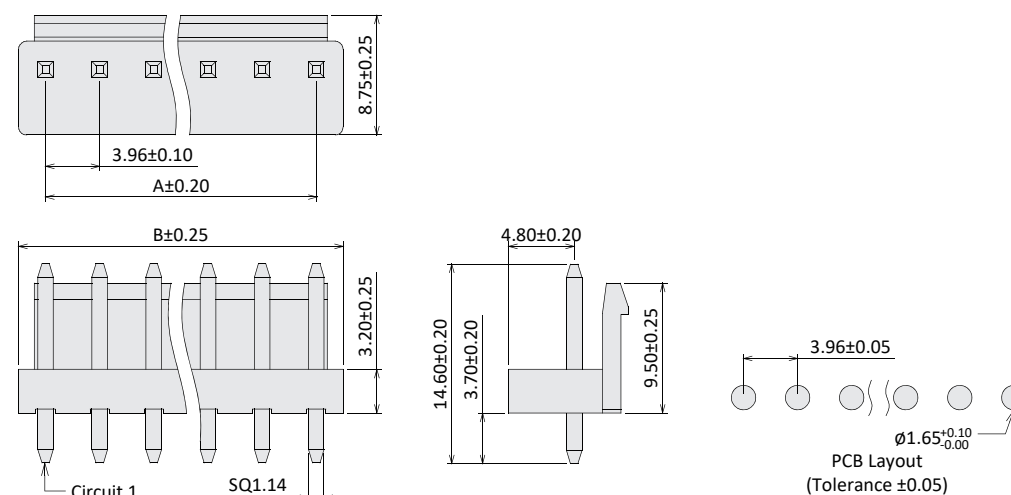


## Terminal Housing Wafer 3961 Series 3.96mm Pitch

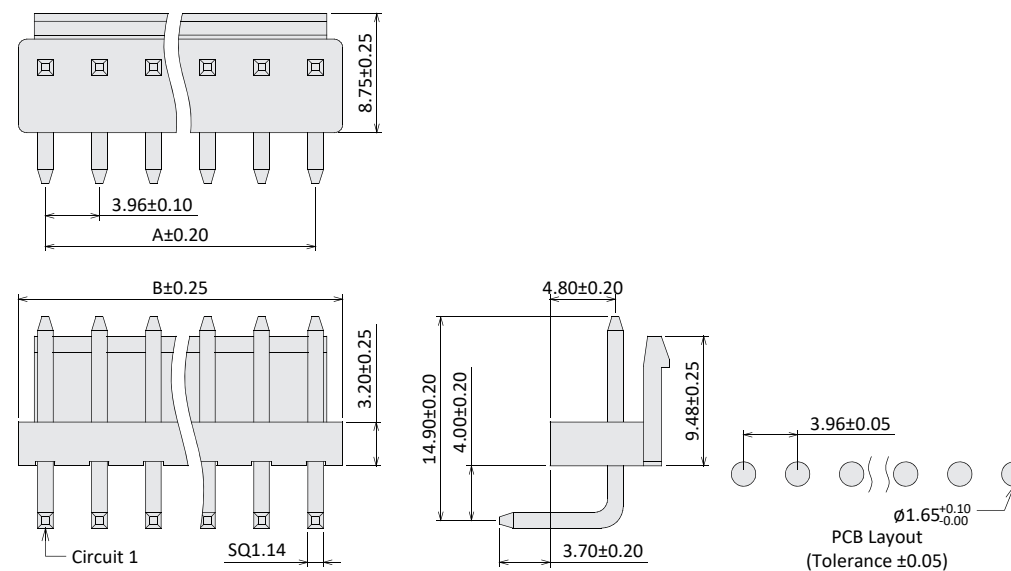


Part No.	Wire Range	Insulation O.D.	Material	Finish
T3961-TB	#18-#22	3.00mm(Max.)	Brass	Tin Plated

Part No.	Dimensions	
	A	B
H3961-02	3.96	8.02
H3961-03	7.92	11.98
H3961-04	11.88	15.94
H3961-05	15.84	19.90
H3961-06	19.80	23.86
H3961-07	23.76	27.82
H3961-08	27.72	31.78
H3961-09	31.68	35.74
H3961-10	35.64	39.70
H3961-11	39.60	43.66
H3961-12	43.56	47.62
H3961-13	47.52	51.58
H3961-14	51.48	55.54
H3961-15	55.44	59.50



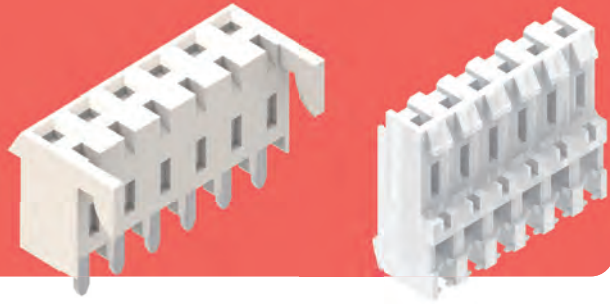
Part No.	Dimensions	
	A	B
W3961L-02	3.96	7.92
W3961L-03	7.92	11.88
W3961L-04	11.88	15.84
W3961L-05	15.84	19.80
W3961L-06	19.80	23.76
W3961L-07	23.76	27.72
W3961L-08	27.72	31.68
W3961L-09	31.68	35.64
W3961L-10	35.64	39.60
W3961L-11	39.60	43.56
W3961L-12	43.56	47.52
W3961L-13	47.52	51.48
W3961L-14	51.48	55.44
W3961L-15	55.44	59.40



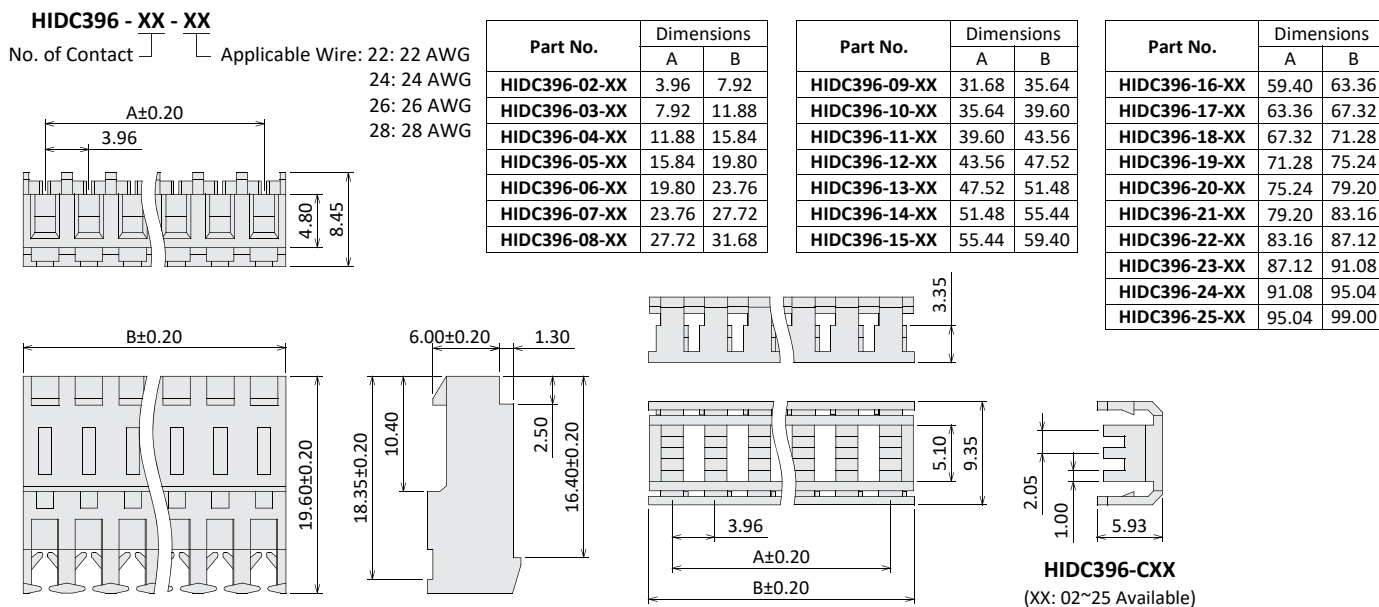
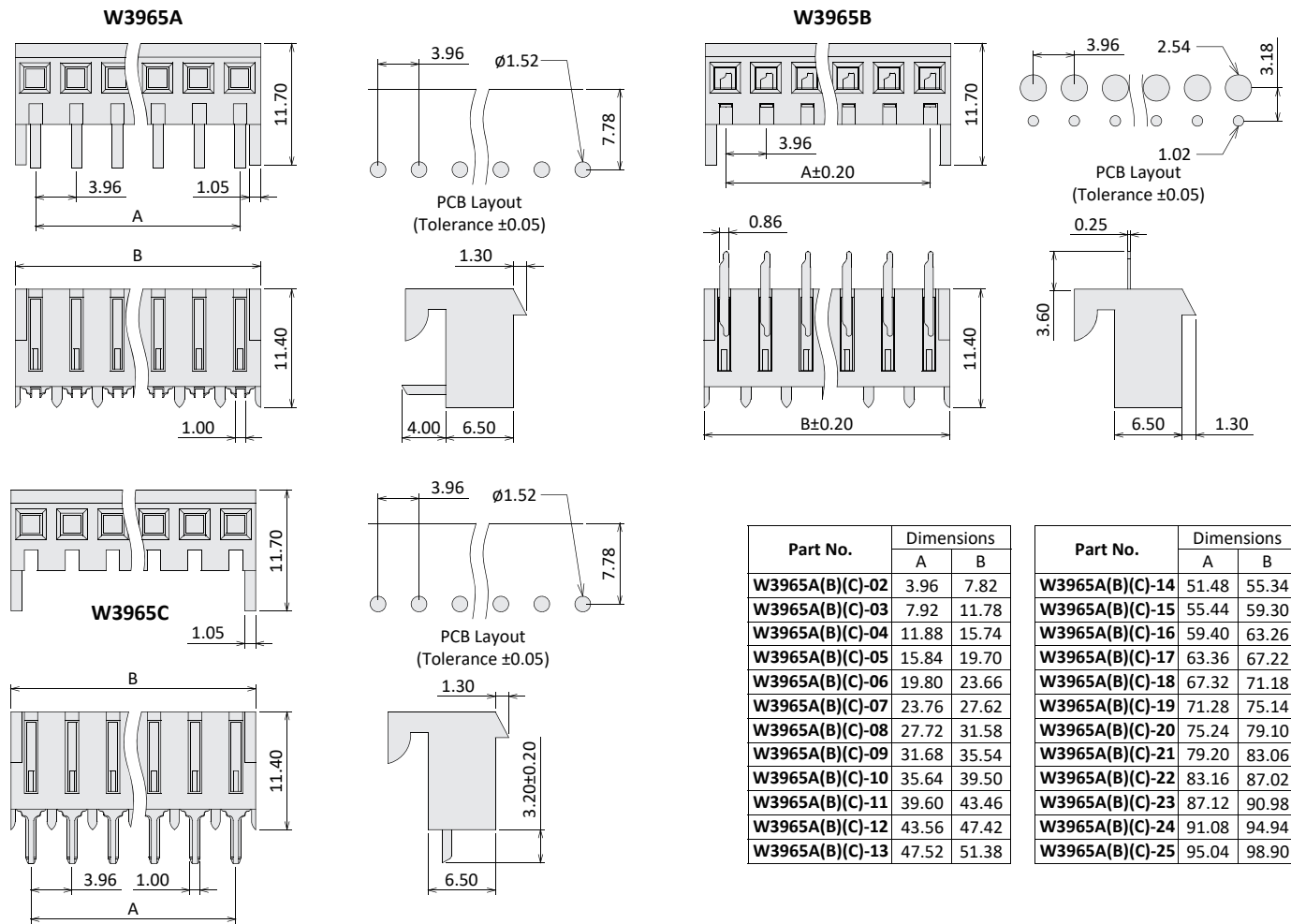
Part No.	Dimensions	
	A	B
W3961R-02	3.96	7.92
W3961R-03	7.92	11.88
W3961R-04	11.88	15.84
W3961R-05	15.84	19.80
W3961R-06	19.80	23.76
W3961R-07	23.76	27.72
W3961R-08	27.72	31.68
W3961R-09	31.68	35.64
W3961R-10	35.64	39.60
W3961R-11	39.60	43.56
W3961R-12	43.56	47.52
W3961R-13	47.52	51.48
W3961R-14	51.48	55.44
W3961R-15	55.44	59.40

# Wafer Housing Terminal

Current Rate: 7A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 5000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0/V-2  
 Operating Temperature: -40°C~+105°C

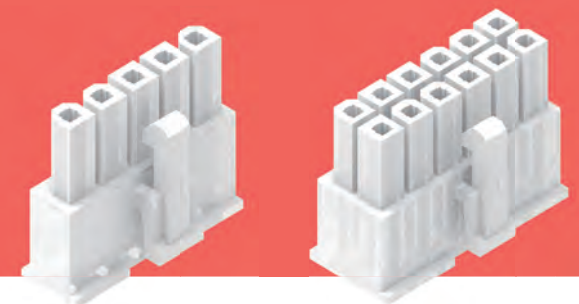


## Wafer 3965 & IDC396 Series 3.96mm Pitch

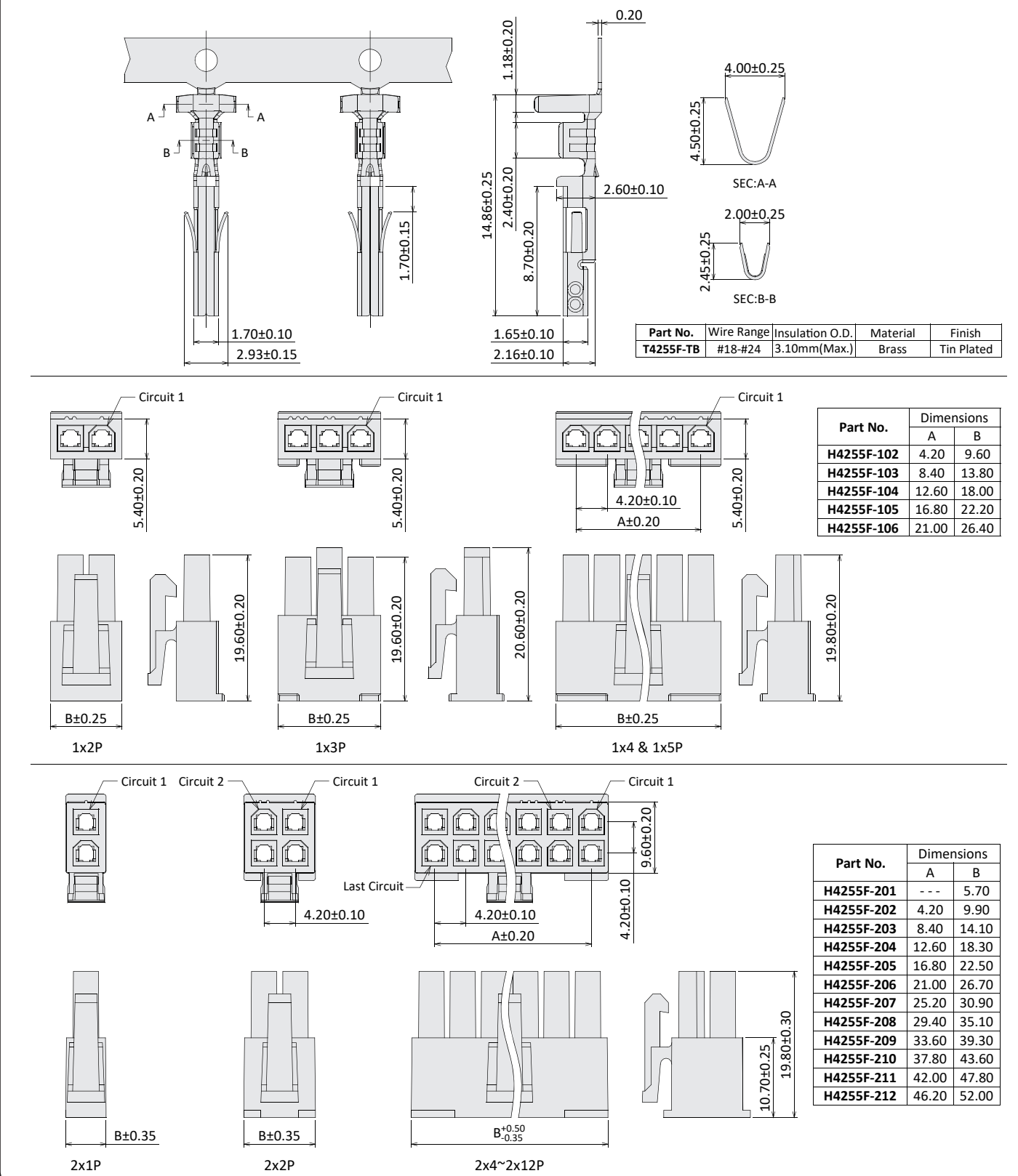


# Wafer Housing Terminal

Current Rate: 9A / 600V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-0  
 Operating Temperature: -25°C~+85°C

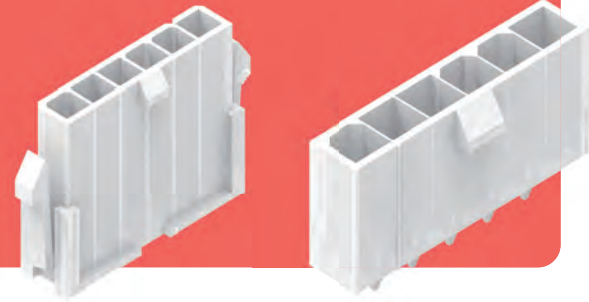


## Terminal Housing Wafer 4255 Series 4.20mm Pitch

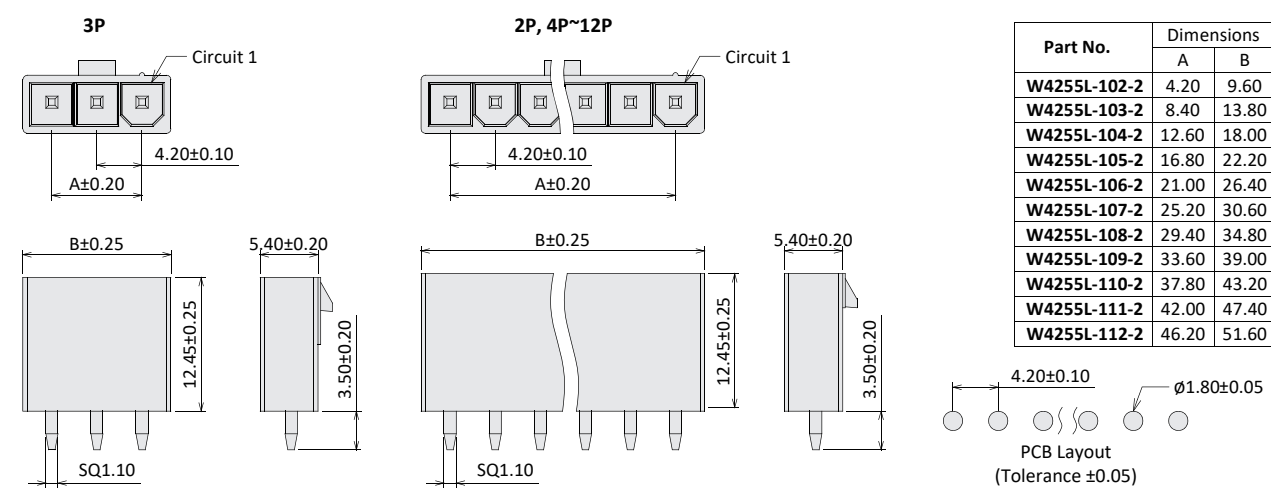
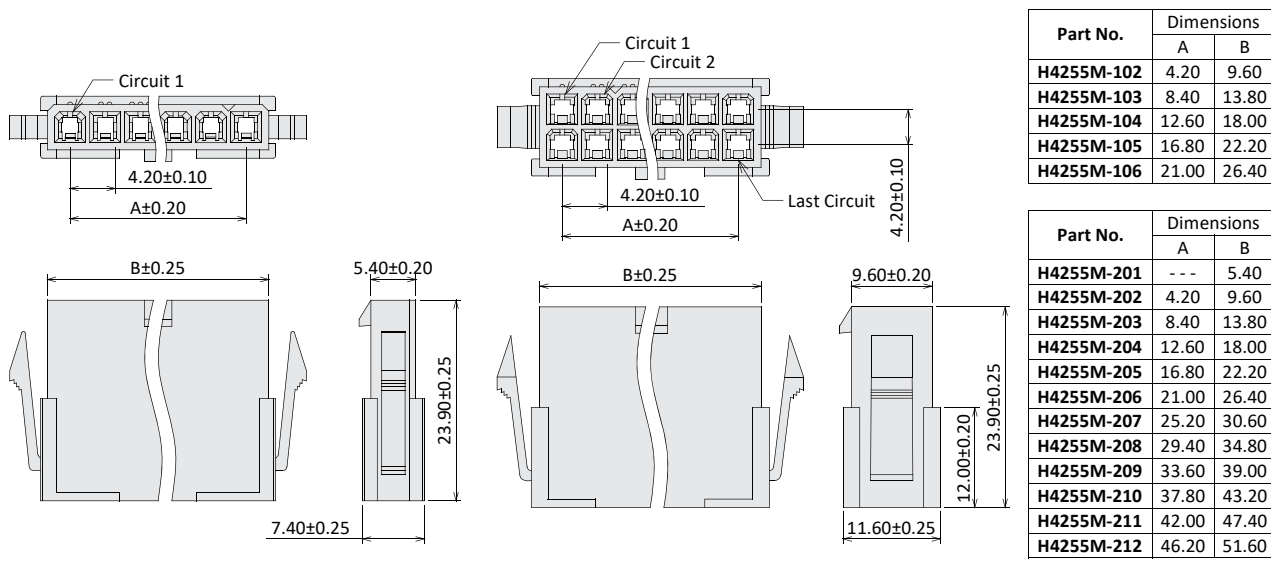
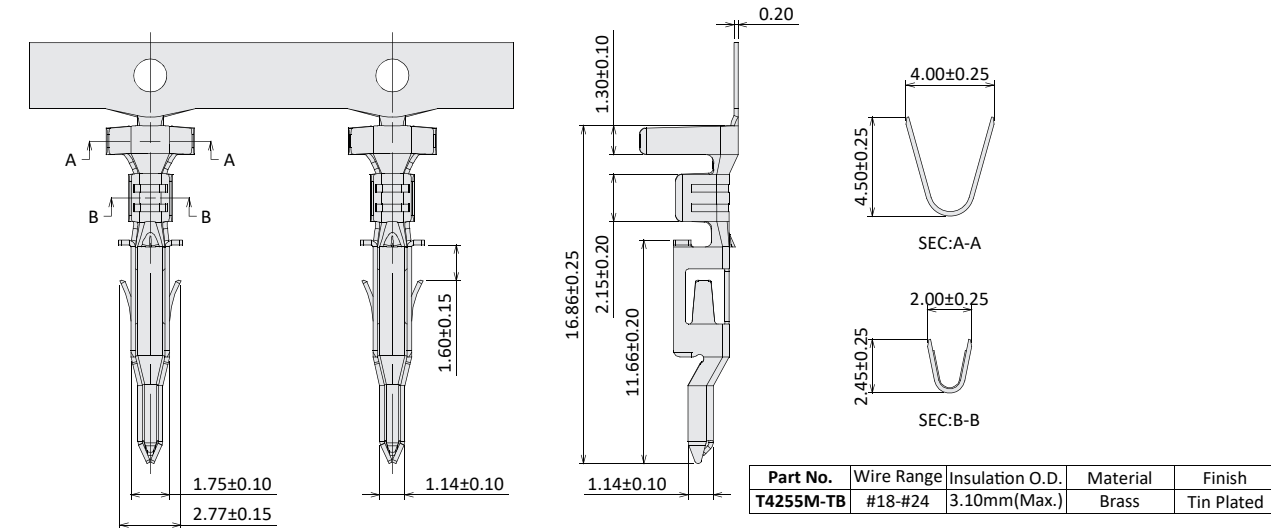


# Wafer Housing Terminal

Current Rate: 9A / 600V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -25°C~+85°C

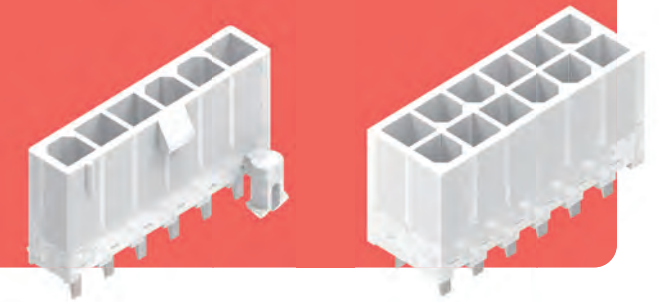


## Terminal Housing Wafer 4255 Series 4.20mm Pitch

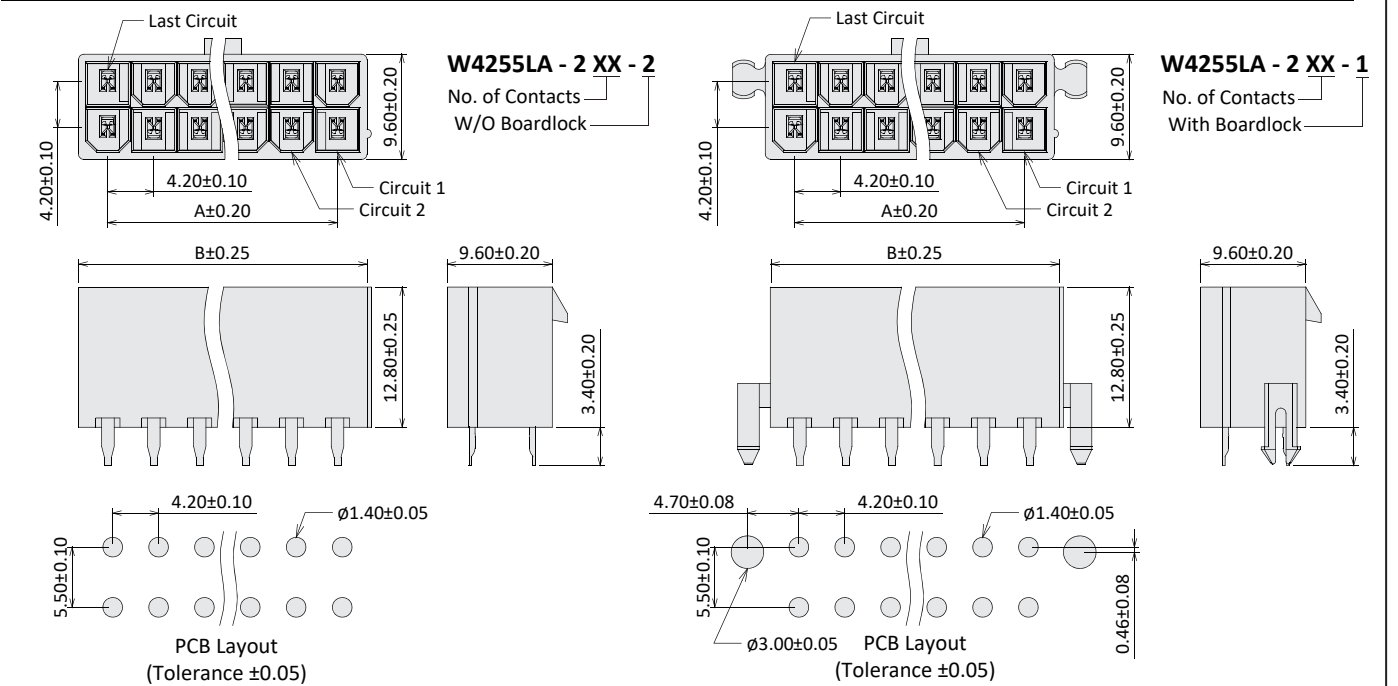
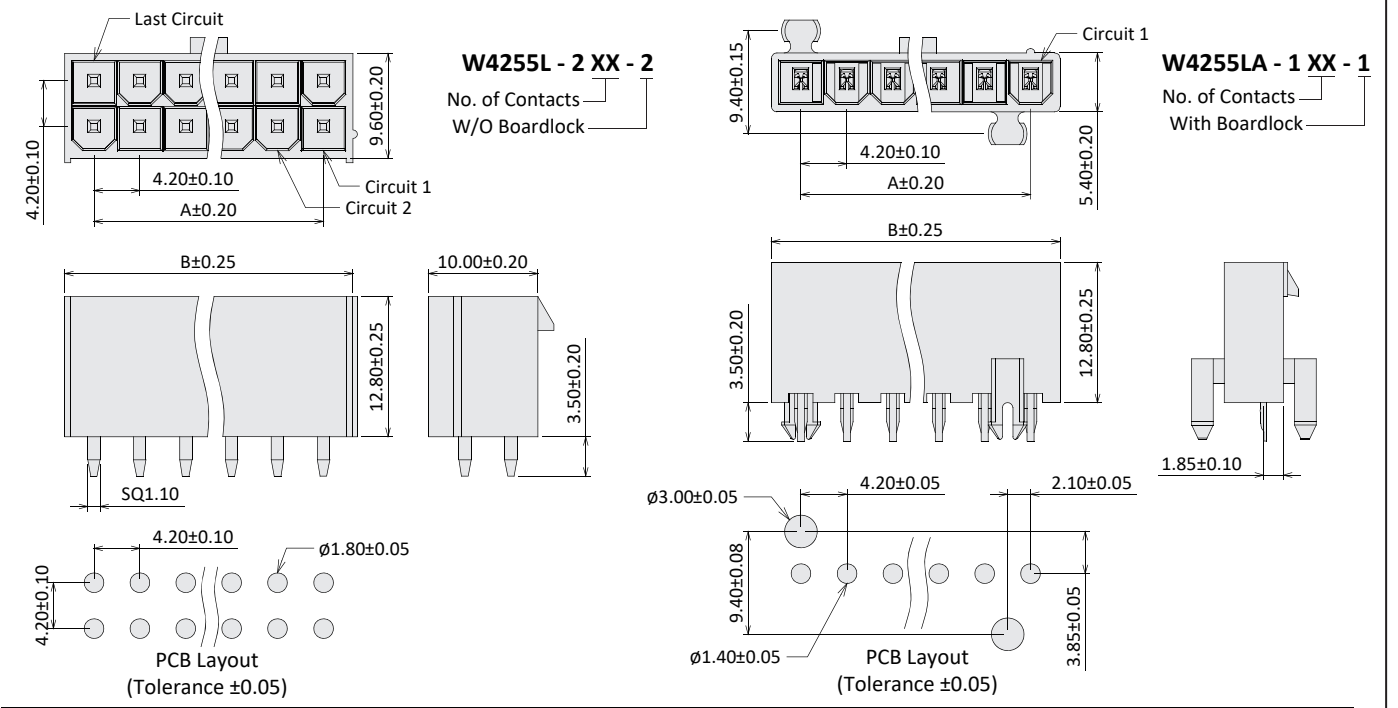


# Wafer Housing Terminal

Current Rate: 9A / 600V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -25°C~+85°C



## Wafer 4255 Series 4.20mm Pitch



Part No.	Dimensions	
	A	B
W4255L(LA)-X02-X	4.20	9.60
W4255L(LA)-X03-X	8.40	13.80
W4255L(LA)-X04-X	12.60	18.00
W4255L(LA)-X05-X	16.80	22.20
W4255L(LA)-X06-X	21.00	26.40
W4255L(LA)-X07-X	25.20	30.60

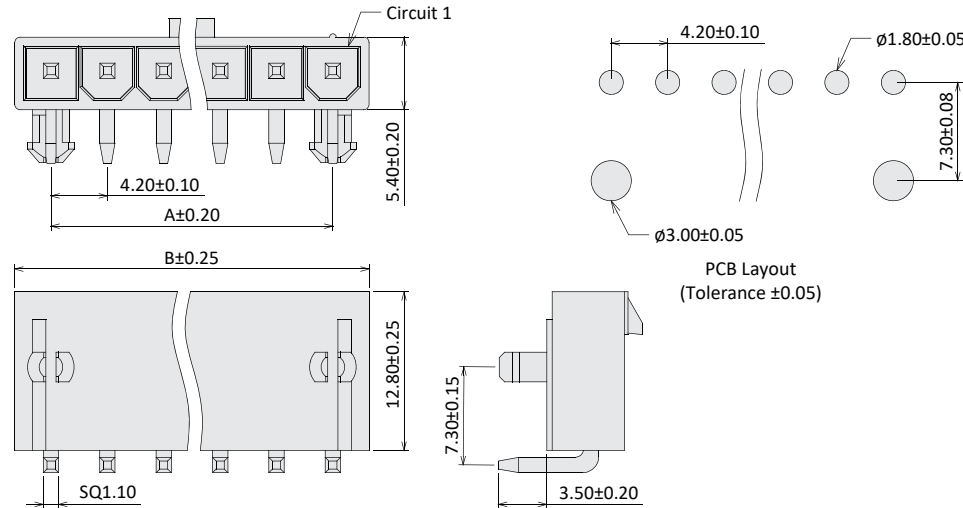
Part No.	Dimensions	
	A	B
W4255L(LA)-X08-X	29.40	34.80
W4255L(LA)-X09-X	33.60	39.00
W4255L(LA)-X10-X	37.80	43.20
W4255L(LA)-X11-X	42.00	47.40
W4255L(LA)-X12-X	46.20	51.60

# Wafer Housing Terminal

Current Rate: 9A / 600V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -25°C~+85°C

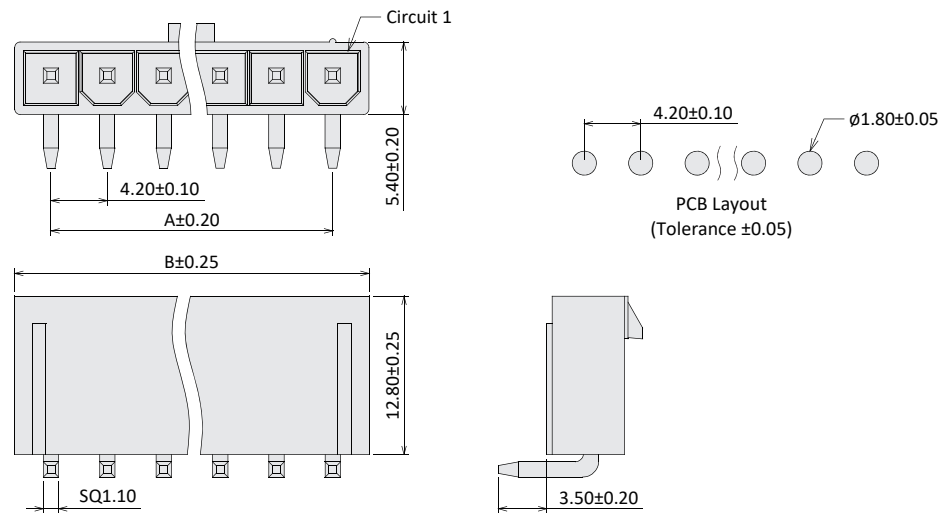


## Wafer 4255 Series 4.20mm Pitch



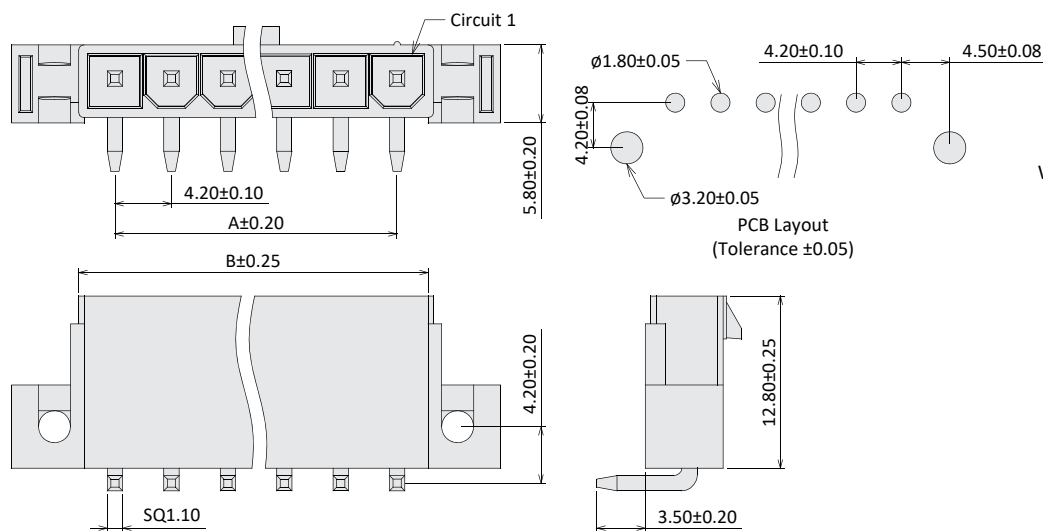
**W4255R - 1 XX - 1**  
 No. of Contacts  
 With Boardlock

Part No.	Dimensions	
	A	B
W4255R-102-1	4.20	9.60
W4255R-103-1	8.40	13.80
W4255R-104-1	12.60	18.00
W4255R-105-1	16.80	22.20
W4255R-106-1	21.00	26.40
W4255R-107-1	25.20	30.60
W4255R-108-1	29.40	34.80
W4255R-109-1	33.60	39.00
W4255R-110-1	37.80	43.20
W4255R-111-1	42.00	47.40
W4255R-112-1	46.20	51.60



**W4255R - 1 XX - 2**  
 No. of Contacts  
 W/O Boardlock

Part No.	Dimensions	
	A	B
W4255R-102-2	4.20	9.60
W4255R-103-2	8.40	13.80
W4255R-104-2	12.60	18.00
W4255R-105-2	16.80	22.20
W4255R-106-2	21.00	26.40
W4255R-107-2	25.20	30.60
W4255R-108-2	29.40	34.80
W4255R-109-2	33.60	39.00
W4255R-110-2	37.80	43.20
W4255R-111-2	42.00	47.40
W4255R-112-2	46.20	51.60

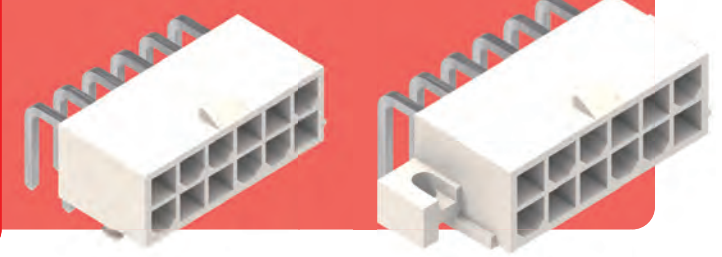


**W4255R - 1 XX - 3**  
 No. of Contacts  
 With Mounting Flange

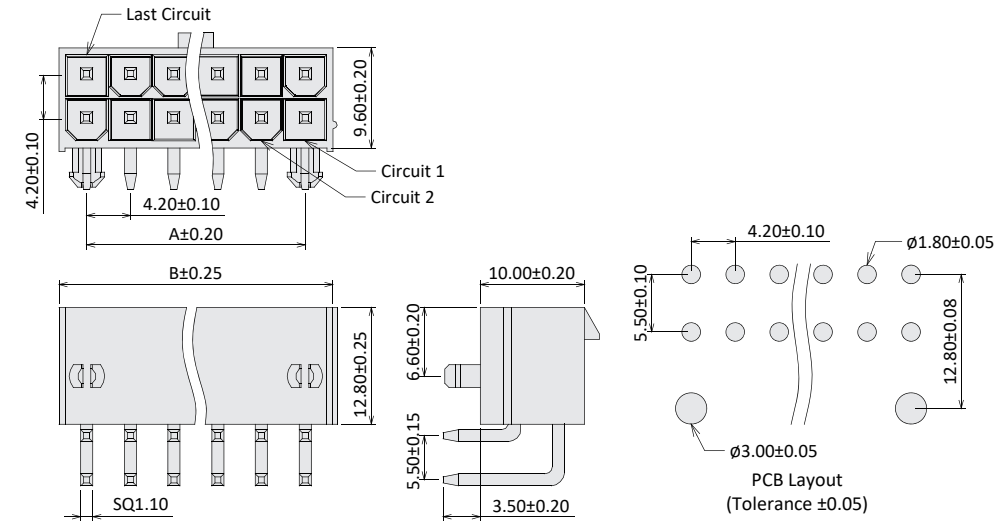
Part No.	Dimensions	
	A	B
W4255R-102-3	4.20	9.60
W4255R-103-3	8.40	13.80
W4255R-104-3	12.60	18.00
W4255R-105-3	16.80	22.20
W4255R-106-3	21.00	26.40
W4255R-107-3	25.20	30.60
W4255R-108-3	29.40	34.80
W4255R-109-3	33.60	39.00
W4255R-110-3	37.80	43.20
W4255R-111-3	42.00	47.40
W4255R-112-3	46.20	51.60

# Wafer Housing Terminal

Current Rate: 9A / 600V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -25°C~+85°C

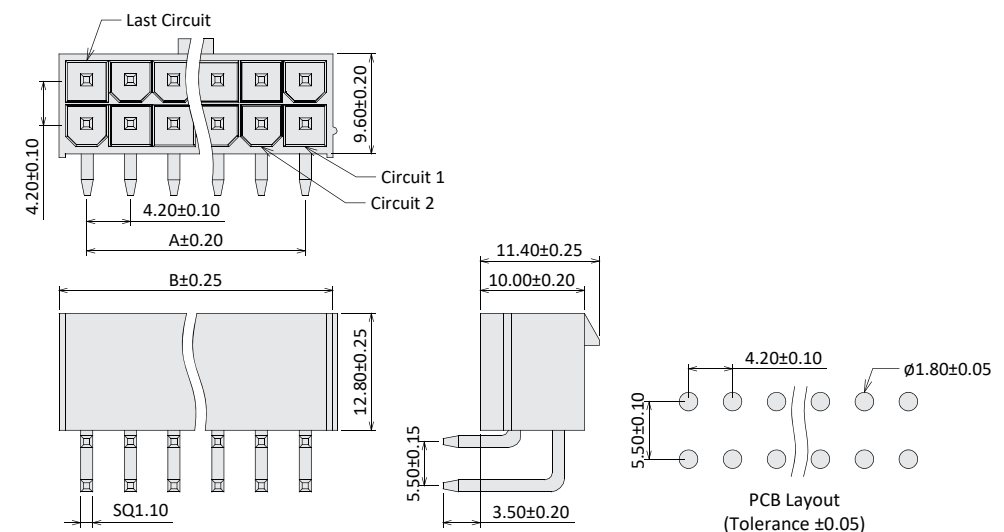


## Wafer 4255 Series 4.20mm Pitch



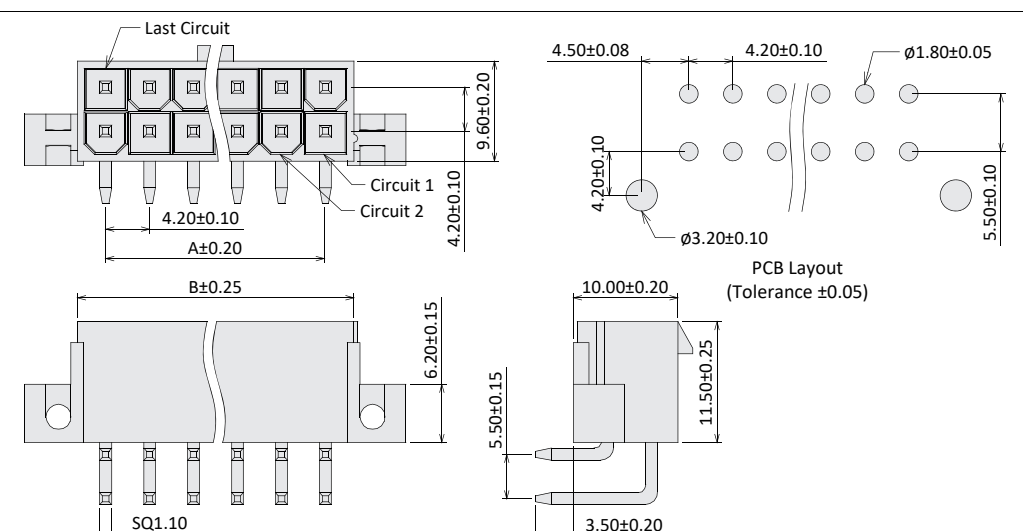
**W4255R - 2 XX - 1**  
 No. of Contacts  
 With Boardlock

Part No.	Dimensions	
	A	B
W4255R-201-1	---	5.40
W4255R-202-1	4.20	9.60
W4255R-203-1	8.40	13.80
W4255R-204-1	12.60	18.00
W4255R-205-1	16.80	22.20
W4255R-206-1	21.00	26.40
W4255R-207-1	25.20	30.60
W4255R-208-1	29.40	34.80
W4255R-209-1	33.60	39.00
W4255R-210-1	37.80	43.20
W4255R-211-1	42.00	47.40
W4255R-212-1	46.20	51.60



**W4255R - 2 XX - 2**  
 No. of Contacts  
 W/O Boardlock

Part No.	Dimensions	
	A	B
W4255R-201-2	---	5.40
W4255R-202-2	4.20	9.60
W4255R-203-2	8.40	13.80
W4255R-204-2	12.60	18.00
W4255R-205-2	16.80	22.20
W4255R-206-2	21.00	26.40
W4255R-207-2	25.20	30.60
W4255R-208-2	29.40	34.80
W4255R-209-2	33.60	39.00
W4255R-210-2	37.80	43.20
W4255R-211-2	42.00	47.40
W4255R-212-2	46.20	51.60

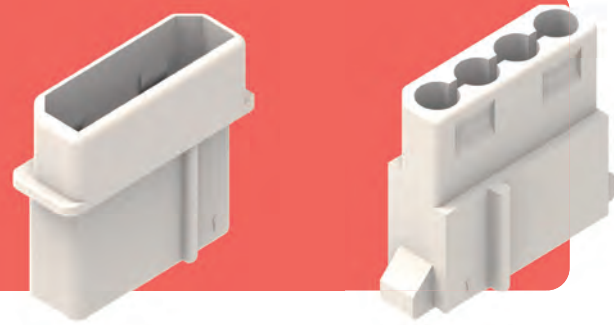


**W4255R - 2 XX - 3**  
 No. of Contacts  
 With Mounting Flange

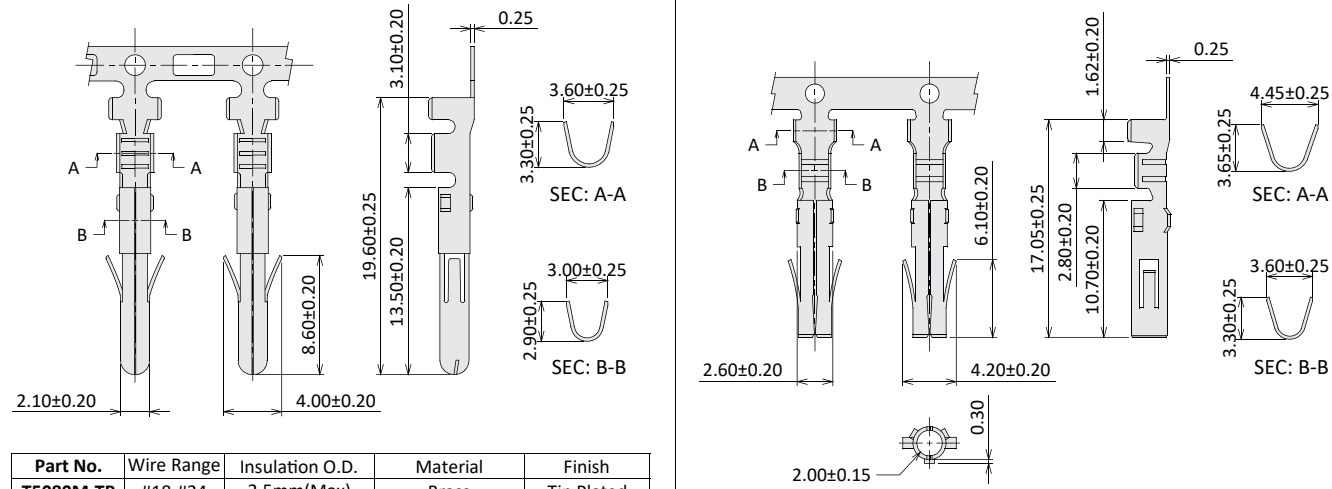
Part No.	Dimensions	
	A	B
W4255R-201-3	---	5.40
W4255R-202-3	4.20	9.60
W4255R-203-3	8.40	13.80
W4255R-204-3	12.60	18.00
W4255R-205-3	16.80	22.20
W4255R-206-3	21.00	26.40
W4255R-207-3	25.20	30.60
W4255R-208-3	29.40	34.80
W4255R-209-3	33.60	39.00
W4255R-210-3	37.80	43.20
W4255R-211-3	42.00	47.40
W4255R-212-3	46.20	51.60

# Wafer Housing Terminal

Current Rate: 7A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -40°C~+105°C

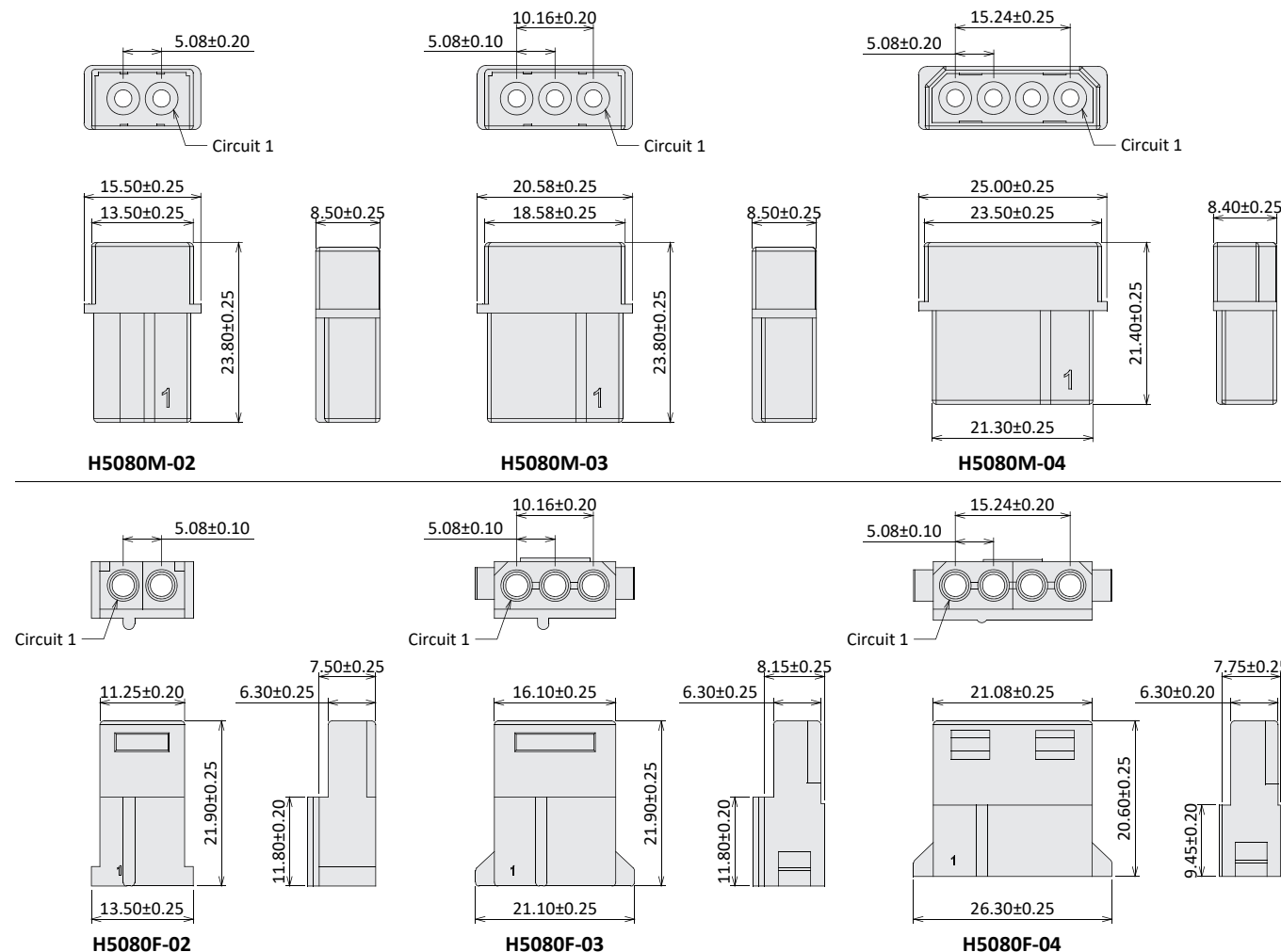


## Terminal Housing 5080 Series 5.08mm Pitch



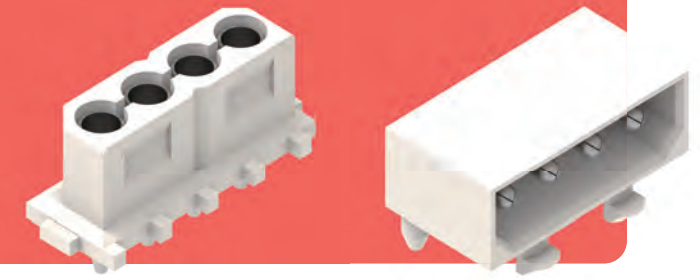
Part No.	Wire Range	Insulation O.D.	Material	Finish
T5080M-TB	#18-#24	2.5mm(Max)	Brass	Tin Plated
T5080M-TP	#18-#24	2.5mm(Max)	Phosphor Bronze	Tin Plated
T5080M-GB	#18-#24	2.5mm(Max)	Brass	Gold Plated
T5080M-GP	#18-#24	2.5mm(Max)	Phosphor Bronze	Gold Plated

Part No.	Wire Range	Insulation O.D.	Material	Finish
T5080F-TB	#18-#24	3.3mm(Max)	Brass	Tin Plated
T5080F-TP	#18-#24	3.3mm(Max)	Phosphor Bronze	Tin Plated

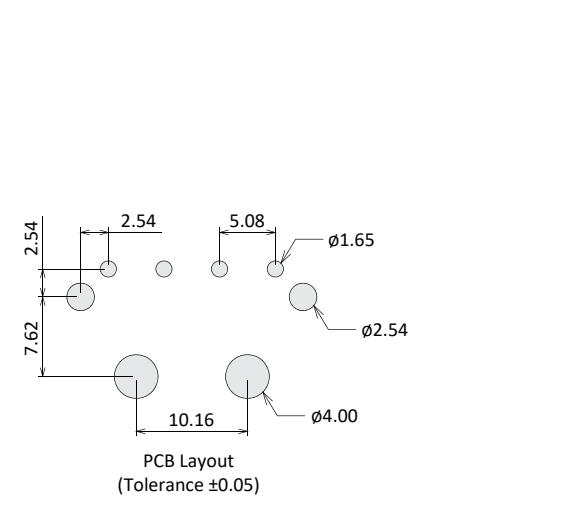
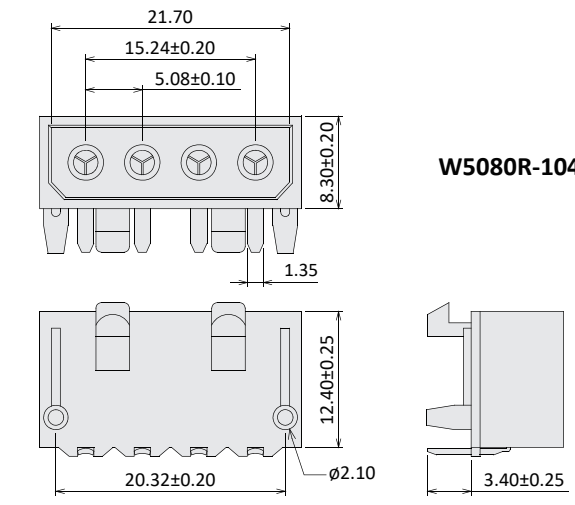
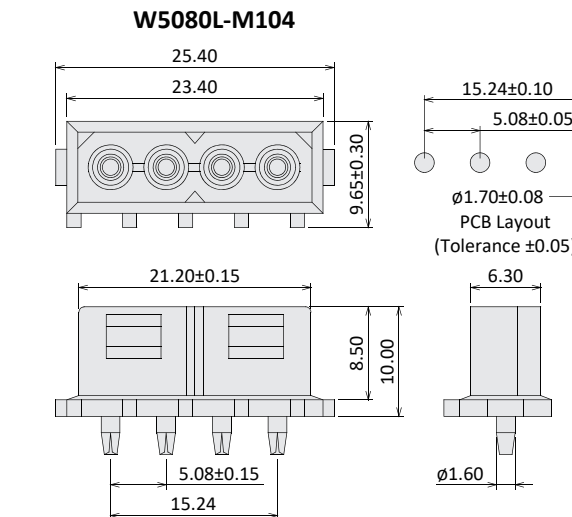
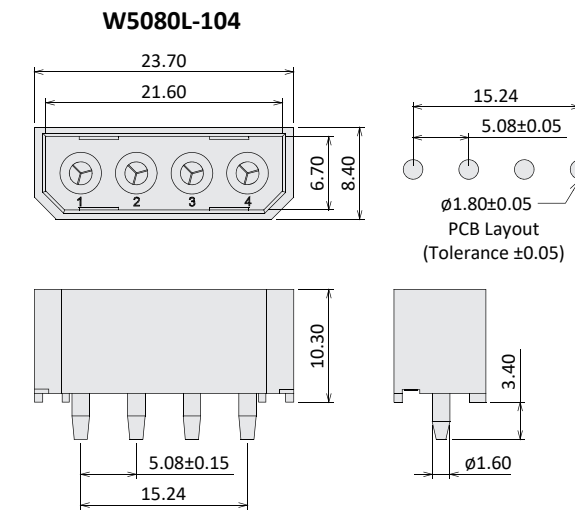
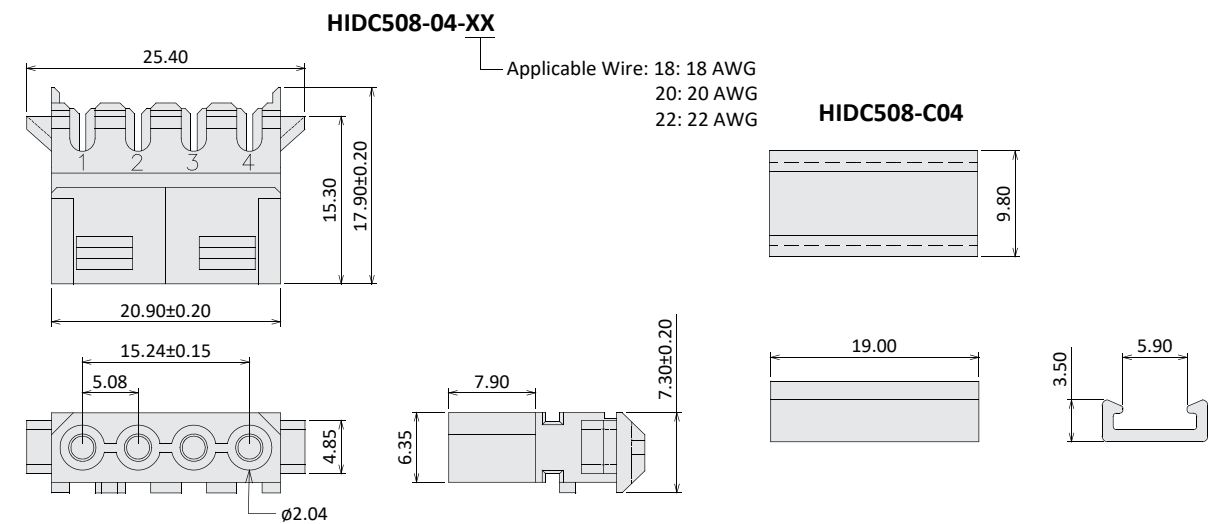


# Wafer Housing Terminal

Current Rate: 7A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -25°C~+85°C

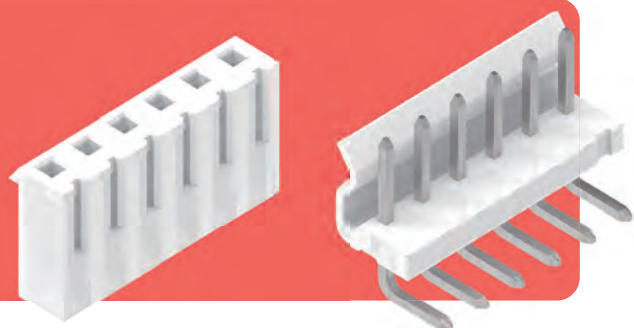


## Wafer 5081 & IDC508 Series 5.08mm Pitch

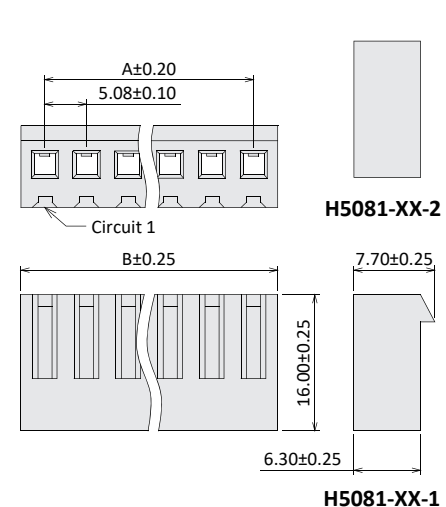
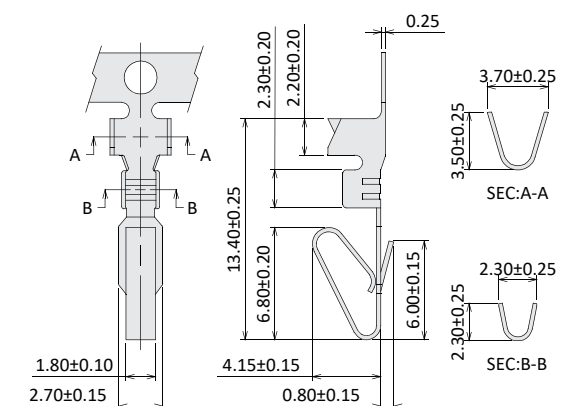


# Wafer Housing Terminal

Current Rate: 7A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -25°C~+85°C

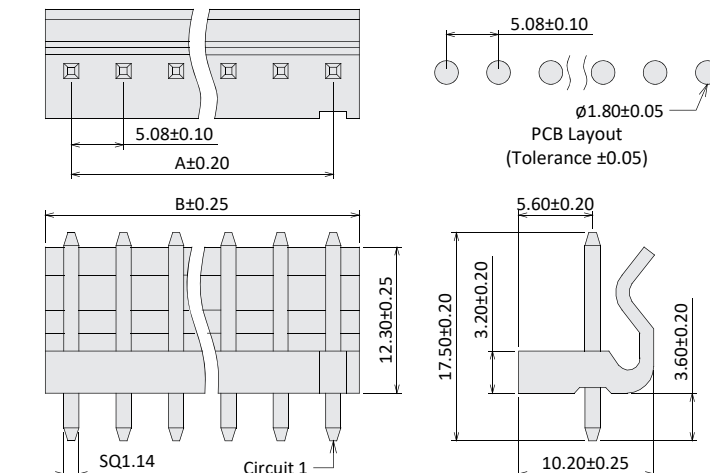


## Terminal Housing Wafer 5081 Series 5.08mm Pitch



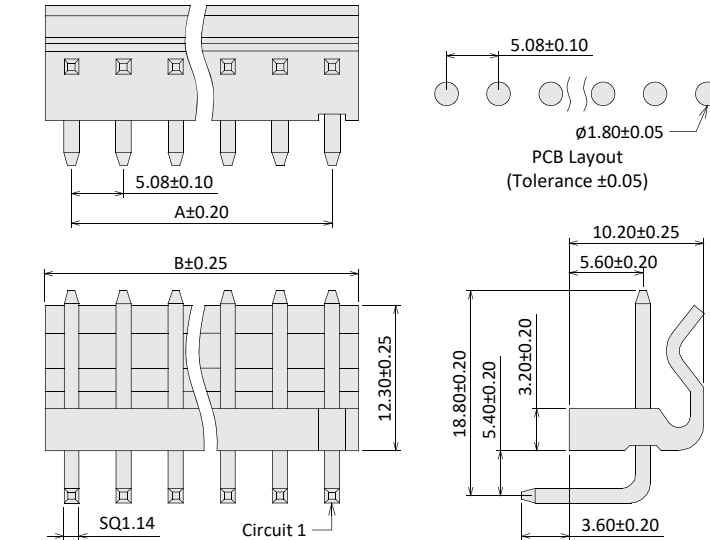
Part No.	Dimensions	
	A	B
H5081-02	5.08	10.08
H5081-03	10.16	15.16
H5081-04	15.24	20.24
H5081-05	20.32	25.32
H5081-06	25.40	30.40
H5081-07	30.48	35.48
H5081-08	35.56	40.56
H5081-09	40.64	45.64
H5081-10	45.72	50.72
H5081-11	50.80	55.80
H5081-12	55.88	60.88
H5081-13	60.96	65.96
H5081-14	66.04	71.04
H5081-15	71.12	76.12
H5081-16	76.20	81.20
H5081-17	81.28	86.28
H5081-18	86.36	91.36
H5081-19	91.44	96.44
H5081-20	96.52	101.52

Part No.	Wire Range	Insulation O.D.	Material	Finish
T3960-TP	#18-#24	2.80mm(Max.)	Brass	Tin Plated



Part No.	Dimensions	
	A	B
W5081L-02	5.08	10.16
W5081L-03	10.16	15.24
W5081L-04	15.24	20.32
W5081L-05	20.32	25.40
W5081L-06	25.40	30.48
W5081L-07	30.48	35.56
W5081L-08	35.56	40.64
W5081L-09	40.64	45.72
W5081L-10	45.72	50.80
W5081L-11	50.80	55.88

Part No.	Dimensions	
	A	B
W5081L-12	55.88	60.96
W5081L-13	60.96	66.04
W5081L-14	66.04	71.12
W5081L-15	71.12	76.20
W5081L-16	76.20	81.28
W5081L-17	81.28	86.36
W5081L-18	86.36	91.44
W5081L-19	91.44	96.52
W5081L-20	96.52	101.60

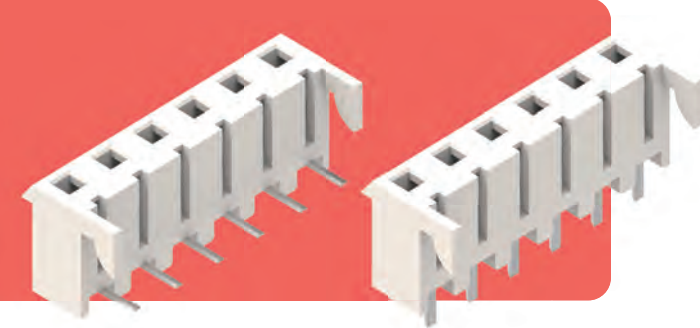


Part No.	Dimensions	
	A	B
W5081R-02	5.08	10.16
W5081R-03	10.16	15.24
W5081R-04	15.24	20.32
W5081R-05	20.32	25.40
W5081R-06	25.40	30.48
W5081R-07	30.48	35.56
W5081R-08	35.56	40.64
W5081R-09	40.64	45.72
W5081R-10	45.72	50.80
W5081R-11	50.80	55.88

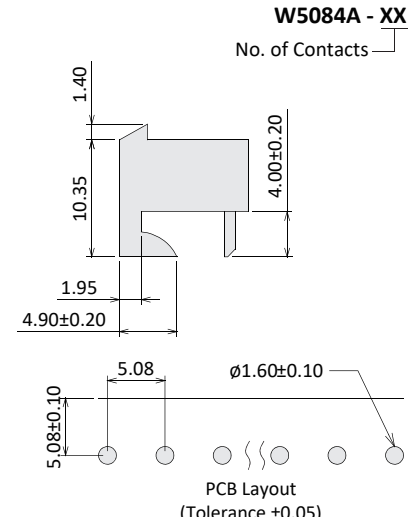
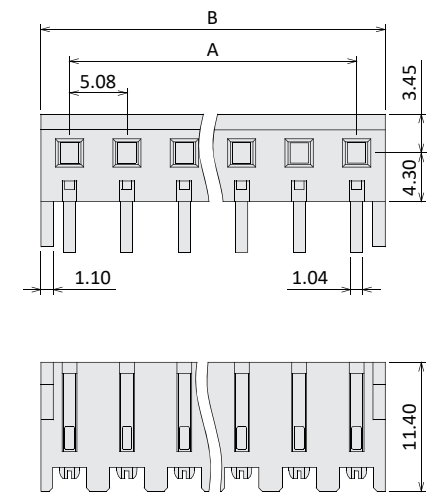
Part No.	Dimensions	
	A	B
W5081R-12	55.88	60.96
W5081R-13	60.96	66.04
W5081R-14	66.04	71.12
W5081R-15	71.12	76.20
W5081R-16	76.20	81.28
W5081R-17	81.28	86.36
W5081R-18	86.36	91.44
W5081R-19	91.44	96.52
W5081R-20	96.52	101.60

# Wafer Housing Terminal

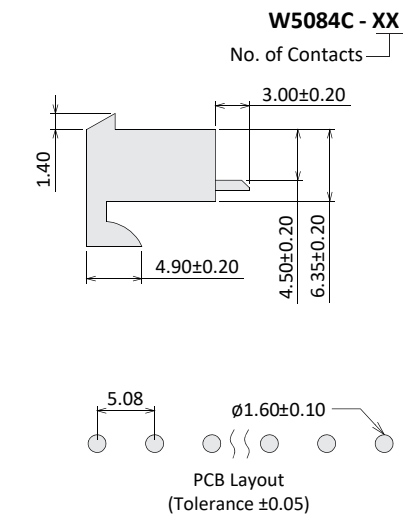
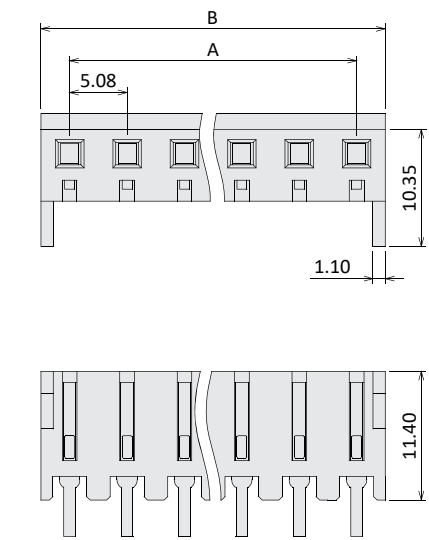
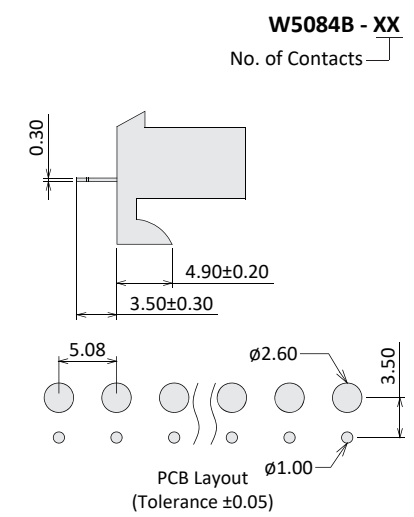
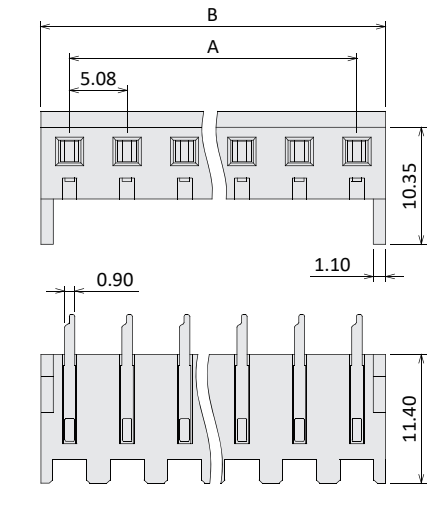
Current Rate: 7A / 250V AC,DC  
 Dielectric Voltage: 1500V AC for one minute  
 Insulation Resistance: 5000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2  
 Operating Temperature: -40°C~+105°C



## Wafer 5084 Series 5.08mm Pitch

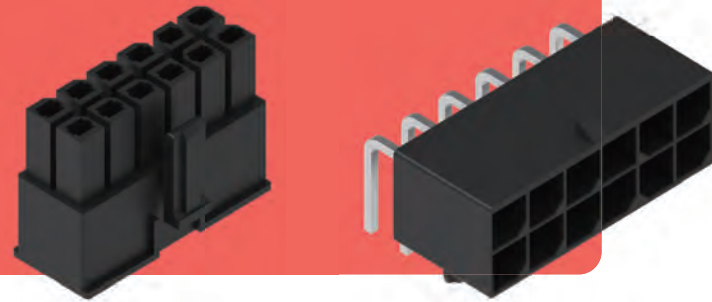


Part No.	Dimensions	
	A	B
W5084A(B)(C)-02	5.08	10.16
W5084A(B)(C)-03	10.16	15.24
W5084A(B)(C)-04	15.24	20.32
W5084A(B)(C)-05	20.32	25.40
W5084A(B)(C)-06	25.40	30.48
W5084A(B)(C)-07	30.48	35.56
W5084A(B)(C)-08	35.56	40.64
W5084A(B)(C)-09	40.64	45.72
W5084A(B)(C)-10	45.72	50.80
W5084A(B)(C)-11	50.80	55.88
W5084A(B)(C)-12	55.88	60.96
W5084A(B)(C)-13	60.96	66.04
W5084A(B)(C)-14	66.04	71.12
W5084A(B)(C)-15	71.12	76.20
W5084A(B)(C)-16	76.20	81.28
W5084A(B)(C)-17	81.28	86.36
W5084A(B)(C)-18	86.36	91.44
W5084A(B)(C)-19	91.44	96.52
W5084A(B)(C)-20	96.52	101.60

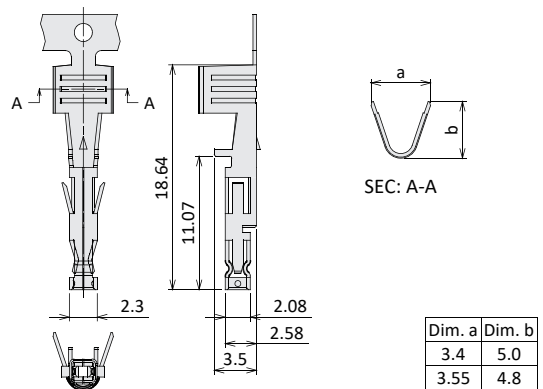


# Wafer Housing Terminal

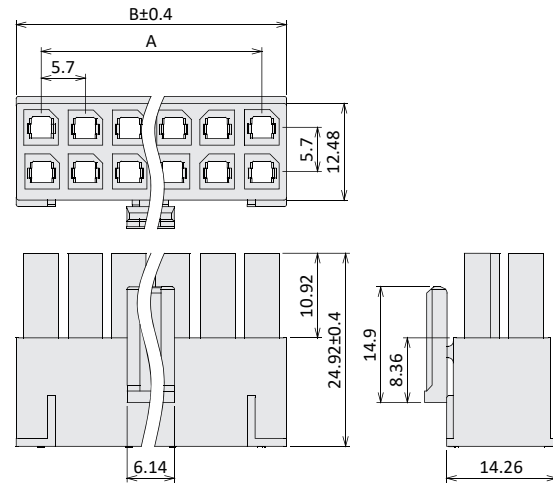
Current Rate: 20A / 600V AC,DC  
 Dielectric Voltage: 2200V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 10mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: NY66 / LCP, UL94V-2/V0  
 Operating Temperature: -40°C~+105°C



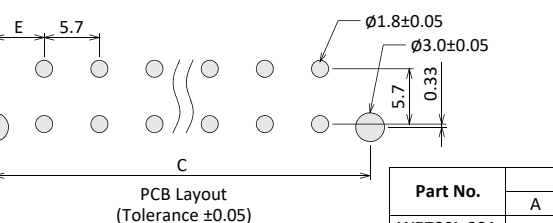
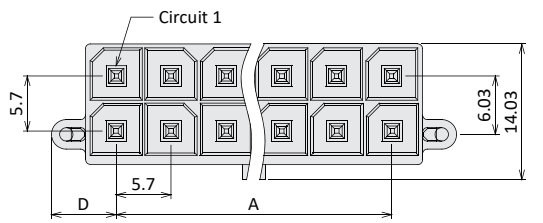
## Terminal Housing Wafer 5700 Series 5.70mm Pitch



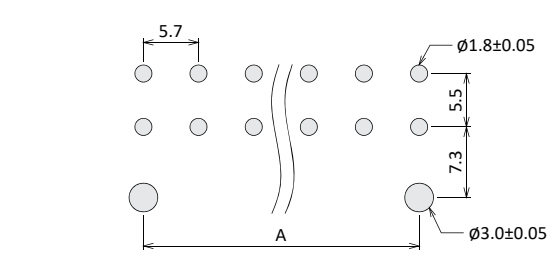
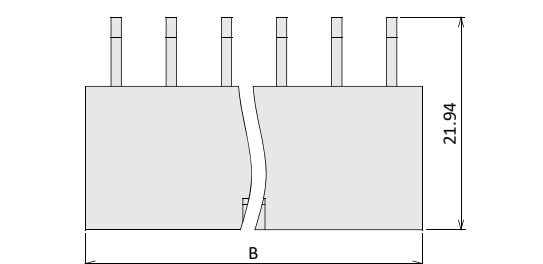
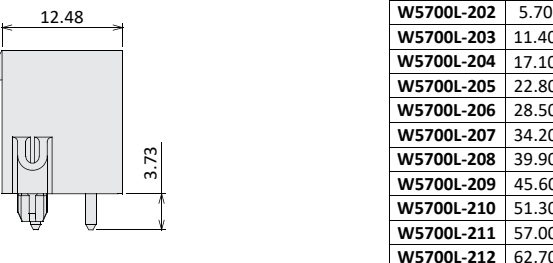
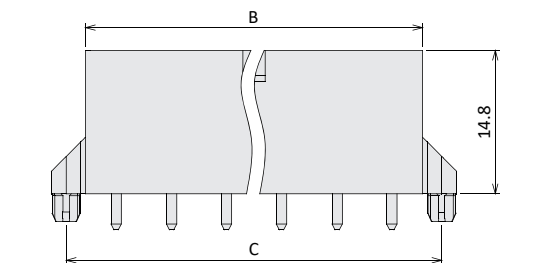
Part No.	Wire Range	Insulation O.D.	Material	Finish
T5700-TB	#14-#16	3.75mm(Max.)	High Conductivity Copper Alloy	Tin Plated
T5700-TBA	#12	4.10mm(Max.)	Copper Alloy	Tin Plated



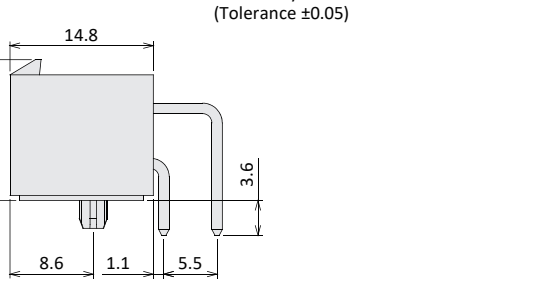
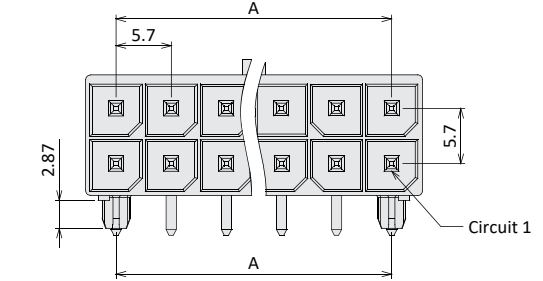
Part No.	Dimensions	
	A	B
H5700F-201	---	8.35
H5700F-202	5.70	12.05
H5700F-203	11.40	17.75
H5700F-204	17.10	23.45
H5700F-205	22.80	29.15
H5700F-206	28.50	34.85
H5700F-207	34.20	40.55
H5700F-208	39.90	46.25
H5700F-209	45.60	51.95
H5700F-210	51.30	57.65
H5700F-211	57.00	63.35
H5700F-212	62.70	69.05



Part No.	Dimensions				
	A	B	C	D	E
W5700L-201	---	8.35	12.34	7.70	6.17
W5700L-202	5.70	12.05	16.04		
W5700L-203	11.40	17.75	21.74		
W5700L-204	17.10	23.45	27.44		
W5700L-205	22.80	29.15	33.14		
W5700L-206	28.50	34.85	38.84		
W5700L-207	34.20	40.55	44.54	6.70	5.17
W5700L-208	39.90	46.25	50.24		
W5700L-209	45.60	51.95	55.94		
W5700L-210	51.30	57.65	61.64		
W5700L-211	57.00	63.35	67.34		
W5700L-212	62.70	69.05	73.04		

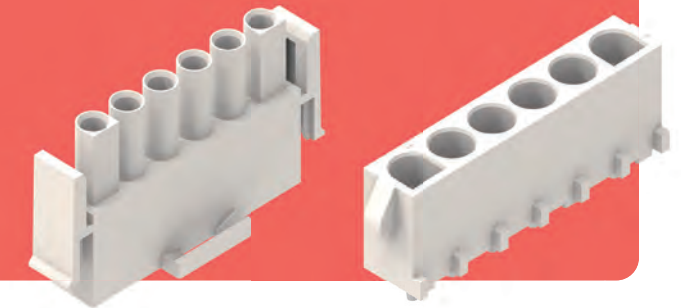


Part No.	Dimensions	
	A	B
W5700R-201	---	8.35
W5700R-202	5.70	12.05
W5700R-203	11.40	17.75
W5700R-204	17.10	23.45
W5700R-205	22.80	29.15
W5700R-206	28.50	34.85
W5700R-207	34.20	40.55
W5700R-208	39.90	46.25
W5700R-209	45.60	51.95
W5700R-210	51.30	57.65
W5700R-211	57.00	63.35
W5700R-212	62.70	69.05

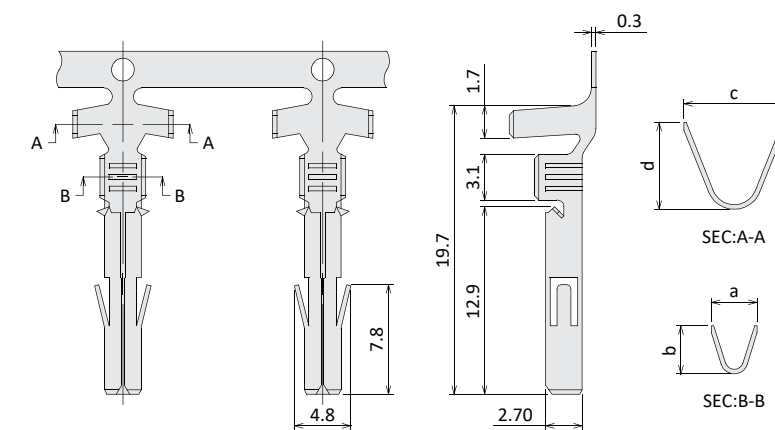


# Wafer Housing Terminal

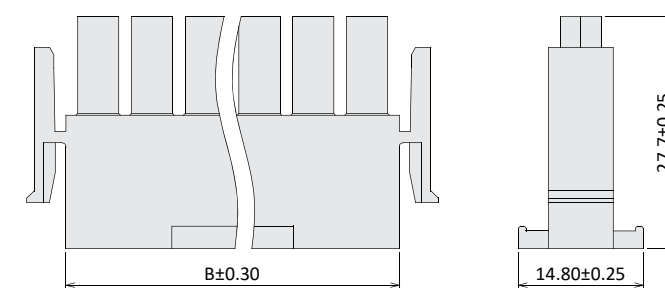
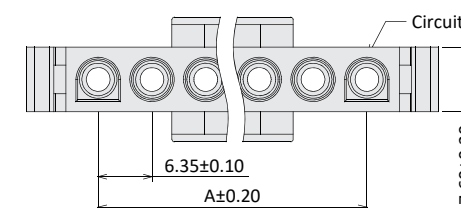
Current Rate: 11~15A / 600V AC,DC  
 Dielectric Voltage: 5000V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2/V-0  
 Operating Temperature: -55°C~+105°C



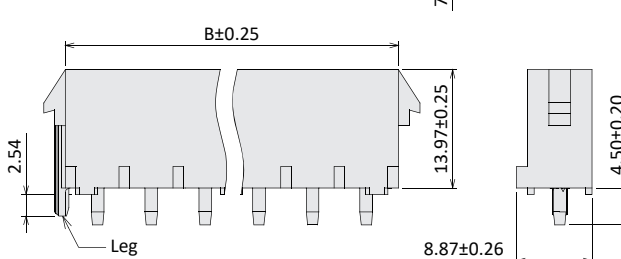
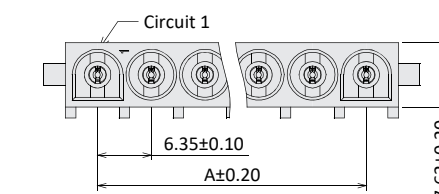
## Terminal Housing Wafer 6350 Series 6.35mm Pitch



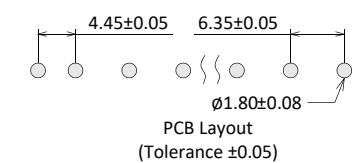
Part No.	Wire Range	Material	Finish	a	b	c	d
T6350F-TB	#16-#20	Brass	Tin Plated	2.9	3.5	4.5±0.4	4.5±0.4
T6350F-TBA	#18-#22	Brass	Tin Plated	2.4	2.4	3.4	3.4



Part No.	Dimensions	
	A	B
H6350F-102	6.35	14.25
H6350F-103	12.70	20.32
H6350F-104	19.05	26.67
H6350F-105	25.40	33.02
H6350F-106	31.75	39.37
H6350F-107	38.10	45.72
H6350F-108	44.45	52.07
H6350F-109	50.80	58.42
H6350F-110	57.15	64.77

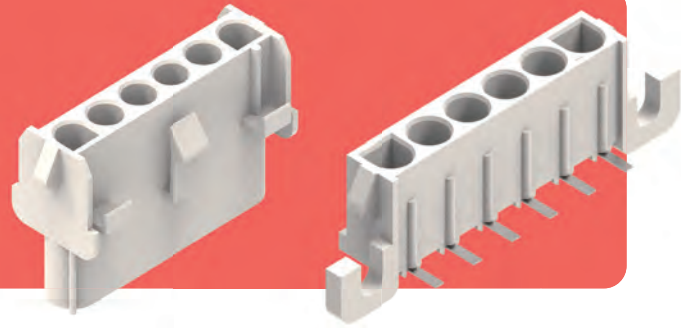


Part No.	Dimensions	
	A	B
W6350LM-102-1	6.35	13.97
W6350LM-103-1	12.70	20.32
W6350LM-104-1	19.05	26.67
W6350LM-105-1	25.40	33.02
W6350LM-106-1	31.75	39.37
W6350LM-107-1	38.10	45.72
W6350LM-108-1	44.45	52.07
W6350LM-109-1	50.80	58.42
W6350LM-110-1	57.15	64.77



# Wafer Housing Terminal

Current Rate: 11~15A / 600V AC,DC  
 Dielectric Voltage: 5000V AC for one minute  
 Insulation Resistance: 1000MΩ Min.  
 Contact Resistance: 20mΩ Max.  
 Material Contact: Copper Alloy, Tin Plated  
 Material Insulator: Nylon 66, UL94V-2/V-0  
 Operating Temperature: -55°C~+105°C



## Terminal Housing Wafer 6350 Series 6.35mm Pitch

